MB90340E Series

F²MC-16LX 16-bit Microcontroller Datasheet

The MB90340E series with up to 2 FULL-CAN interfaces is especially designed for automotive and other industrial applications. Its main feature are the on-board CAN Interfaces, which conform to V2.0 Part A and Part B, while supporting a very flexible message buffer scheme and so offering more functions than a normal full CAN approach.

The power to the MCU core (3 V) is supplied by a built-in regulator circuit, giving these microcontrollers superior performance in terms of power consumption and tolerance to EMI.

Features

CPU

- Instruction system best suited to controller
  - Wide choice of data types (bit, byte, word, and long word)
  - Wide choice of addressing modes (23 types)
  - Enhanced functionality with signed multiply and divide instructions and the RETI instruction
  - Enhanced high-precision computing with 32-bit accumulator
- Instruction system compatible with high-level language (C language) and multitask
  - Employing system stack pointer
  - Various enhanced pointer indirect instructions
  - Barrel shift instructions
- Increased processing speed
  - 4-byte instruction queue

Serial interface

- LIN-UART : 4 channels
  - Equipped with full-duplex double buffer
  - Clock-asynchronous or clock-synchronous serial transmission is available
- I²C interface : 2 channels (only for devices with a C suffix in the part number)
  - Up to 400 kbps transfer rate

Interrupt controller

- Powerful 8-level, 34-condition interrupt feature
- Up to 16 external interrupts are supported
- Automatic data transfer function independent of CPU
  - Expanded intelligent I/O service function (EI²OS) : up to 16 channels

I/O ports

- General-purpose input/output port (CMOS output)
  - 80 ports (for devices without an S suffix in the part number - i.e. devices that support the sub clock)
  - 82 ports (for devices with an S suffix in the part number - i.e. devices that do not support the sub clock)

8/10-bit A/D converter

- 16 channels (only for devices without a C suffix in the part number)
- 24 channels (only for devices with a C suffix in the part number)
- Resolution is selectable between 8-bit and 10-bit.
- Activation by external trigger input is allowed.
- Conversion time : 3 µs (at 24 MHz machine clock, including sampling time)

Address match detection (program patch) function

- Detects address matches against 6 address pointers

Timer

- Time-base timer, watch timer, watchdog timer : 1 channel
- 8/16-bit PPG timer : 8-bit × 16 channels, or 16-bit × 8 channels
- 16-bit reload timer : 4 channels
- 16-bit input/output timer
  - 16-bit free-run timer : 2 channels
    (FRT0 : ICU 0/1/2/3, OCU 0/1/2/3, FRT1 : ICU 4/5/6/7, OCU 4/5/6/7)
  - 16-bit input capture: (ICU): 8 channels
  - 16-bit output compare: (OCU): 8 channels

Full-CAN controller

- Up to 2 channels
- Compliant with Ver2.0A and Ver2.0B CAN specifications
- 16 built-in message buffers
- CAN wake-up function

Low power consumption (standby) mode

- Sleep mode (a mode that halts CPU operating clock)
- Timebase timer mode (a mode where only the oscillation clock, sub clock, timebase timer and watch timer operate)
- Watch mode (a mode that operates sub clock and watch timer only)
- Stop mode (a mode that stops oscillation clock and sub clock)
- CPU intermittent operation mode

Clock modulation circuit

Technology

- CMOS technology

Contents

1. Product Lineup

Part Number / Parameter	MB90V340E-101, MB90V340E-102	MB90F342E(S), MB90F342CE(S), MB90F345E(S), MB90F345CE(S), MB90F346E(S), MB90F346CE(S), MB90F347E(S), MB90F347CE(S), MB90F349E(S), MB90F349CE(S)	MB90341E(S), MB90341CE(S), MB90342E(S), MB90342CE(S), MB90346E(S), MB90346CE(S), MB90347E(S), MB90347CE(S), MB90348E(S), MB90348CE(S), MB90349E(S), MB90349CE(S)
Type	Evaluation products	Flash memory products	MASK ROM products
CPU	F^2MC-16LX CPU		
System clock	On-chip PLL clock multiplier (×1, ×2, ×3, ×4, ×6, 1/2 when PLL stops) Minimum instruction execution time : 42 ns (4 MHz osc. PLL × 6)		
ROM	External	512 Kbytes : MB90F345E(S), MB90F345CE(S) 256 Kbytes : MB90F342E(S), MB90F342CE(S), MB90F349E(S), MB90F349CE(S) 128 Kbytes : MB90F347E(S), MB90F347CE(S) 64 Kbytes : MB90F346E(S), MB90F346CE(S)	256 Kbytes : MB90342E(S), MB90342CE(S), MB90349E(S), MB90349CE(S) 128 Kbytes : MB90341E(S), MB90341CE(S), MB90347E(S), MB90347CE(S), MB90348E(S), MB90348CE(S) 64 Kbytes : MB90346E(S), MB90346CE(S)
RAM	30 Kbytes	20 Kbytes : MB90F345E(S), MB90F345CE(S) 16 Kbytes : MB90F342E(S), MB90F342CE(S), MB90F349E(S), MB90F349CE(S) 6 Kbytes : MB90F347E(S), MB90F347CE(S) 2 Kbytes : MB90F346E(S), MB90F346CE(S)	16 Kbytes : MB90341E(S), MB90341CE(S), MB90342E(S), MB90342CE(S), MB90348E(S), MB90348CE(S), MB90349E(S), MB90349CE(S) 6 Kbytes : MB90347E(S), MB90347CE(S) 2 Kbytes : MB90346E(S), MB90346CE(S)
Emulator-specific power supply*	Yes	——	
Technology	0.35 μm CMOS with regulator for built-in power supply	0.35 μm CMOS with built-in power supply regulator + Flash memory with Charge pump for programming voltage	
Operating voltage range	5 V ± 10%	3.5 V to 5.5 V : When normal operating (not using A/D converter) 4.0 V to 5.5 V : When using the A/D converter/Flash programming 4.5 V to 5.5 V : When using the external bus	
Temperature range	——	−40°C to +105°C	
Package	PGA-299	QFP-100, LQFP-100	
LIN-UART	5 channels	4 channels	
	Wide range of baud rate settings using a dedicated baud rate generator (reload timer) Special synchronous options for adapting to different synchronous serial protocols LIN functionality working either as master or slave LIN device		
I^2C (400 kbps)	2 channels	Devices with a C suffix in the part number : 2 channels Devices without a C suffix in the part number : ——	

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Part Number / Parameter	MB90V340E-101, MB90V340E-102	MB90F342E(S), MB90F342CE(S), MB90F345E(S), MB90F345CE(S), MB90F346E(S), MB90F346CE(S), MB90F347E(S), MB90F347CE(S), MB90F349E(S), MB90F349CE(S)	MB90341E(S), MB90341CE(S), MB90342E(S), MB90342CE(S), MB90346E(S), MB90346CE(S), MB90347E(S), MB90347CE(S), MB90348E(S), MB90348CE(S), MB90349E(S), MB90349CE(S)
A/D Converter	24 input channels	Devices with a C suffix in the part number : 24 channels Devices without a C suffix in the part number : 16 channels	
	10-bit or 8-bit resolution Conversion time : Min 3 μs include sample time (per one channel)		
16-bit Reload Timer (4 channels)	Operation clock frequency : fsys/2^1, fsys/2^3, fsys/2^5 (fsys = Machine clock frequency) Supports External Event Count function		
16-bit Free-run Timer (2 channels)	Generates an interrupt signal on overflow Supports Timer Clear when the output compare finds a match Operation clock freq. : fsys, fsys/2^1, fsys/2^2, fsys/2^3, fsys/2^4, fsys/2^5, fsys/2^6, fsys/2^7 (fsys = Machine clock freq.) Free-run Timer 0 (clock input FRCK0) corresponds to ICU 0/1/2/3, OCU 0/1/2/3 Free-run Timer 1 (clock input FRCK1) corresponds to ICU 4/5/6/7, OCU 4/5/6/7		
16-bit Output Compare (8 channels)	Generates an interrupt signal when one of the 16-bit free-run timer matches the output compare register A pair of compare registers can be used to generate an output signal.		
16-bit Input Capture (8 channels)	Captures the value of the 16-bit free-run timer and generates an interrupt when triggered by a pin input (rising edge, falling edge, or both rising and falling edges).		
8/16-bit Programmable Pulse Generator	8 channels (16-bit) /16 channels (8-bit) Sixteen 8-bit reload counters Sixteen 8-bit reload registers for L pulse width Sixteen 8-bit reload registers for H pulse width		
	Supports 8-bit and 16-bit operation modes A pair of 8-bit reload counters can be configured as one 16-bit reload counter or as 8-bit prescaler plus 8-bit reload counter Operating clock freq. : fsys, fsys/2^1, fsys/2^2, fsys/2^3, fsys/2^4 or 128 μs@fosc = 4 MHz (fsys = Machine clock frequency, fosc = Oscillation clock frequency)		
CAN Interface	3 channels	2 channels : MB90F342E(S), MB90F342CE(S), MB90F345E(S), MB90F345CE(S) 1 channel : MB90F346E(S), MB90F346CE(S), MB90F347E(S), MB90F347CE(S), MB90F349E(S), MB90F349CE(S)	2 channels : MB90341E(S), MB90341CE(S), MB90342E(S), MB90342CE(S) 1 channel : MB90346E(S), MB90346CE(S), MB90347E(S), MB90347CE(S), MB90348E(S), MB90348CE(S), MB90349E(S), MB90349CE(S)
	Conforms to CAN Specification Version 2.0 Part A and B Automatic re-transmission in case of error Automatic transmission in response to Remote Frames Prioritized 16 message buffers for data and ID's Supports multiple messages Flexible configuration of acceptance filtering : Full bit compare/Full bit mask/Two partial bit masks Supports up to 1 Mbps		

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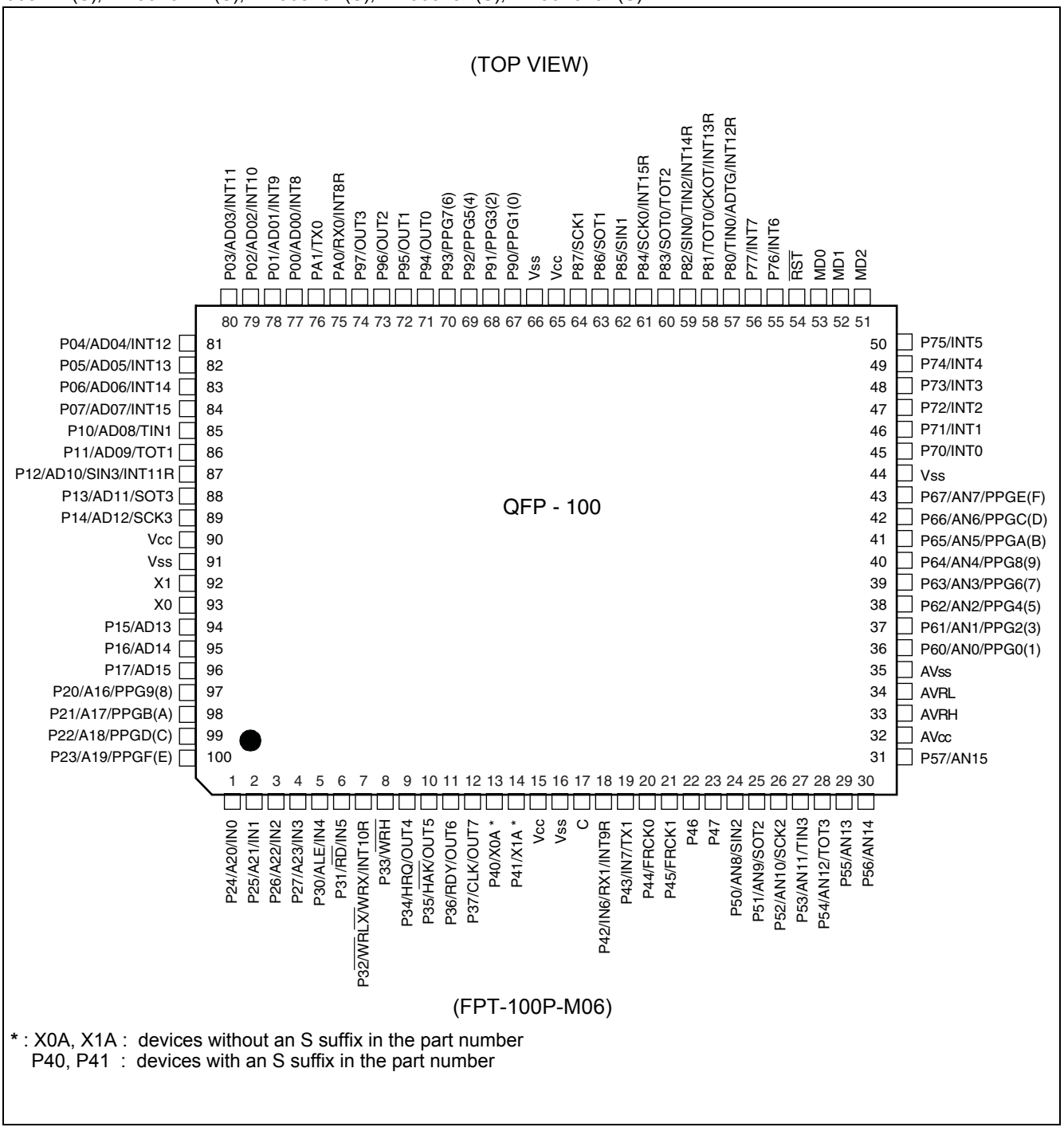
Part Number / Parameter	MB90V340E-101, MB90V340E-102	MB90F342E(S), MB90F342CE(S), MB90F345E(S), MB90F345CE(S), MB90F346E(S), MB90F346CE(S), MB90F347E(S), MB90F347CE(S), MB90F349E(S), MB90F349CE(S)	MB90341E(S), MB90341CE(S), MB90342E(S), MB90342CE(S), MB90346E(S), MB90346CE(S), MB90347E(S), MB90347CE(S), MB90348E(S), MB90348CE(S), MB90349E(S), MB90349CE(S)
External Interrupt (16 channels)	Can be used rising edge, falling edge, starting up by H/L level input, external interrupt, expanded intelligent I/O services (EI^{2}OS) and DMA		
D/A Converter	2 channels	—	
Sub clock (maximum 100 kHz)	Only for MB90V340E-102	Devices with sub clock : devices without an S suffix in the part number Devices without sub clock : devices with an S suffix in the part number	
I/O Ports	Virtually all external pins can be used as general purpose I/O port All ports are push-pull outputs Bit-wise settable as input/output or peripheral signal Can be configured 8 as CMOS schmitt trigger/ automotive inputs (in blocks of 8 pins) TTL input level settable for external bus (32-pin only for external bus)		
Flash Memory	—	Supports automatic programming, Embedded Algorithm Write/Erase/Erase-Suspend/Resume commands A flag indicating completion of the algorithm Number of erase cycles : 10000 cycles Data retention time : 20 years Boot block configuration Erase can be performed on each block Block protection with external programming voltage Flash Security Feature for protecting the content of the Flash (except for MB90F346E(S) and MB90F346CE (S))	

* : It is setting of Jumper switch (TOOL VCC) when Emulator (MB2147-01-E) is used.
Please refer to the Emulator operation manual for details.

2. Pin Assignments

■ MB90341E(S), MB90342E(S), MB90F342E(S), MB90F345E(S), MB90346E(S), MB90F346E(S), MB90347E(S), MB90F347E(S), MB90348E(S), MB90349E(S), MB90F349E(S)



(FPT-100P-M06)

***** : X0A, X1A : devices without an S suffix in the part number
P40, P41 : devices with an S suffix in the part number

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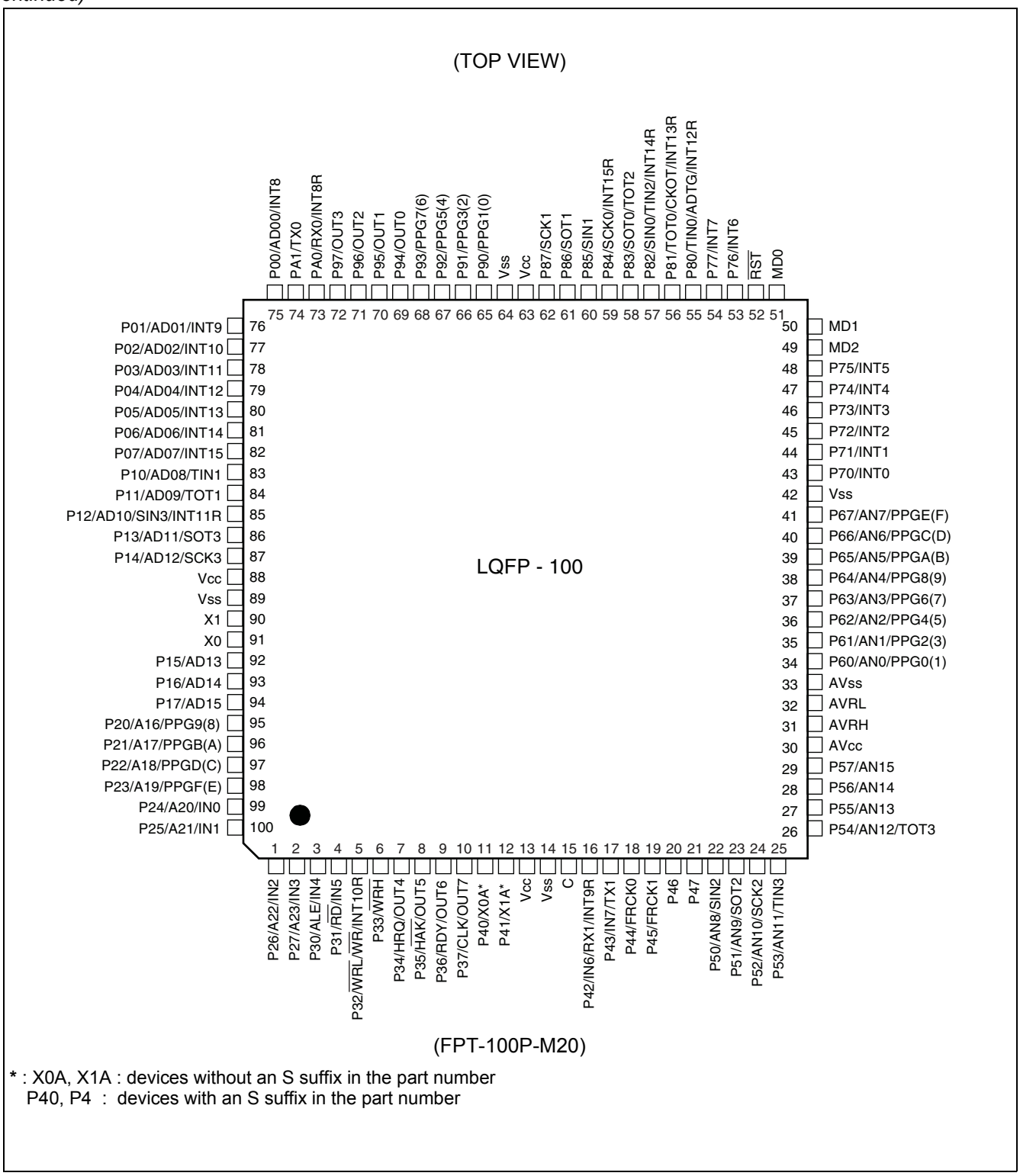
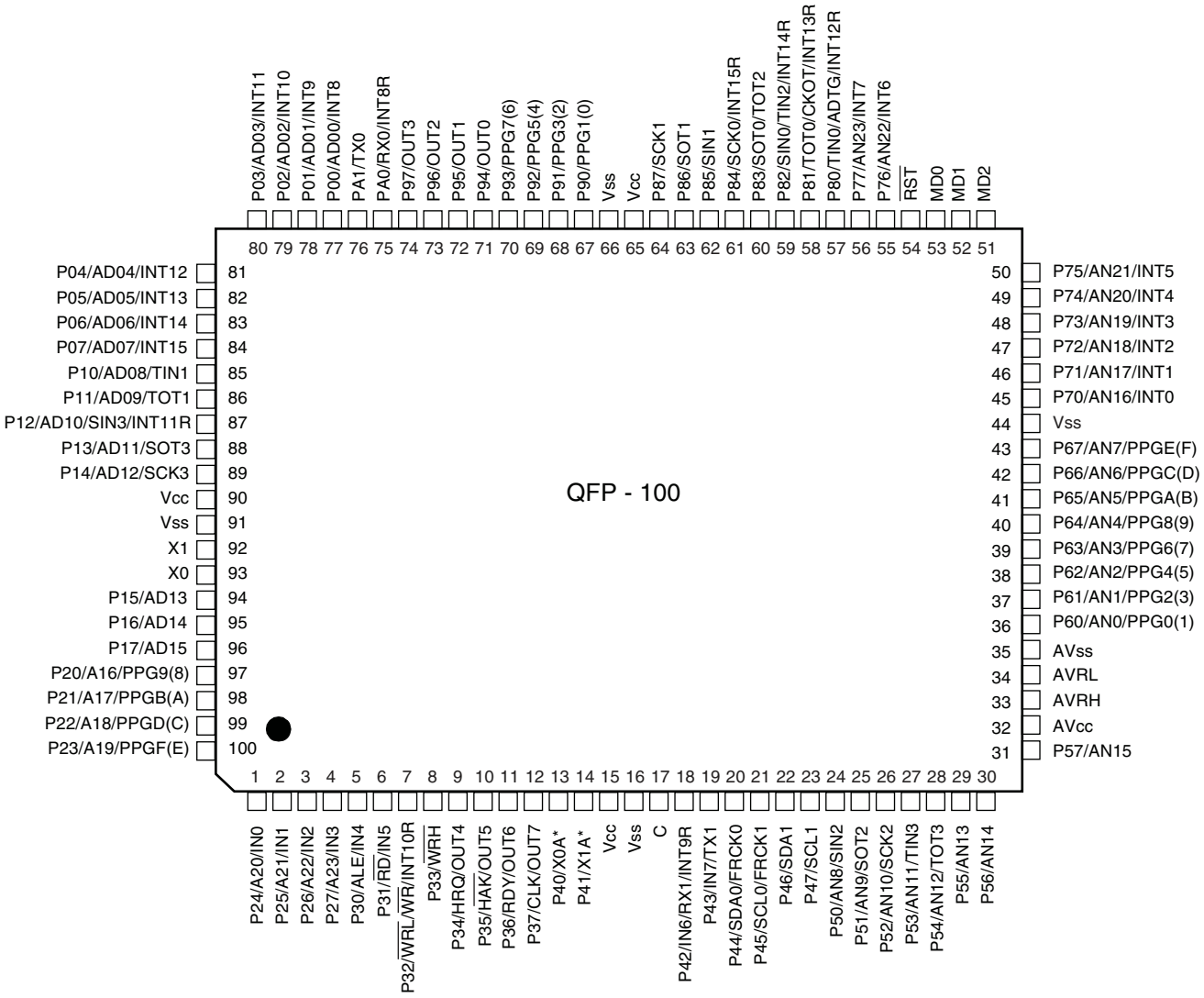


(FPT-100P-M20)

* : X0A, X1A : devices without an S suffix in the part number
P40, P4 : devices with an S suffix in the part number

■ MB90341CE(S), MB90342CE(S), MB90F342CE(S), MB90F345CE(S), MB90346CE(S), MB90F346CE(S), MB90347CE(S), MB90F347CE(S), MB90348CE(S), MB90349CE(S), MB90F349CE(S)

(TOP VIEW)



(FPT-100P-M06)

* : X0A, X1A : devices without an S suffix in the part number
P40, P41 : devices with an S suffix in the part number

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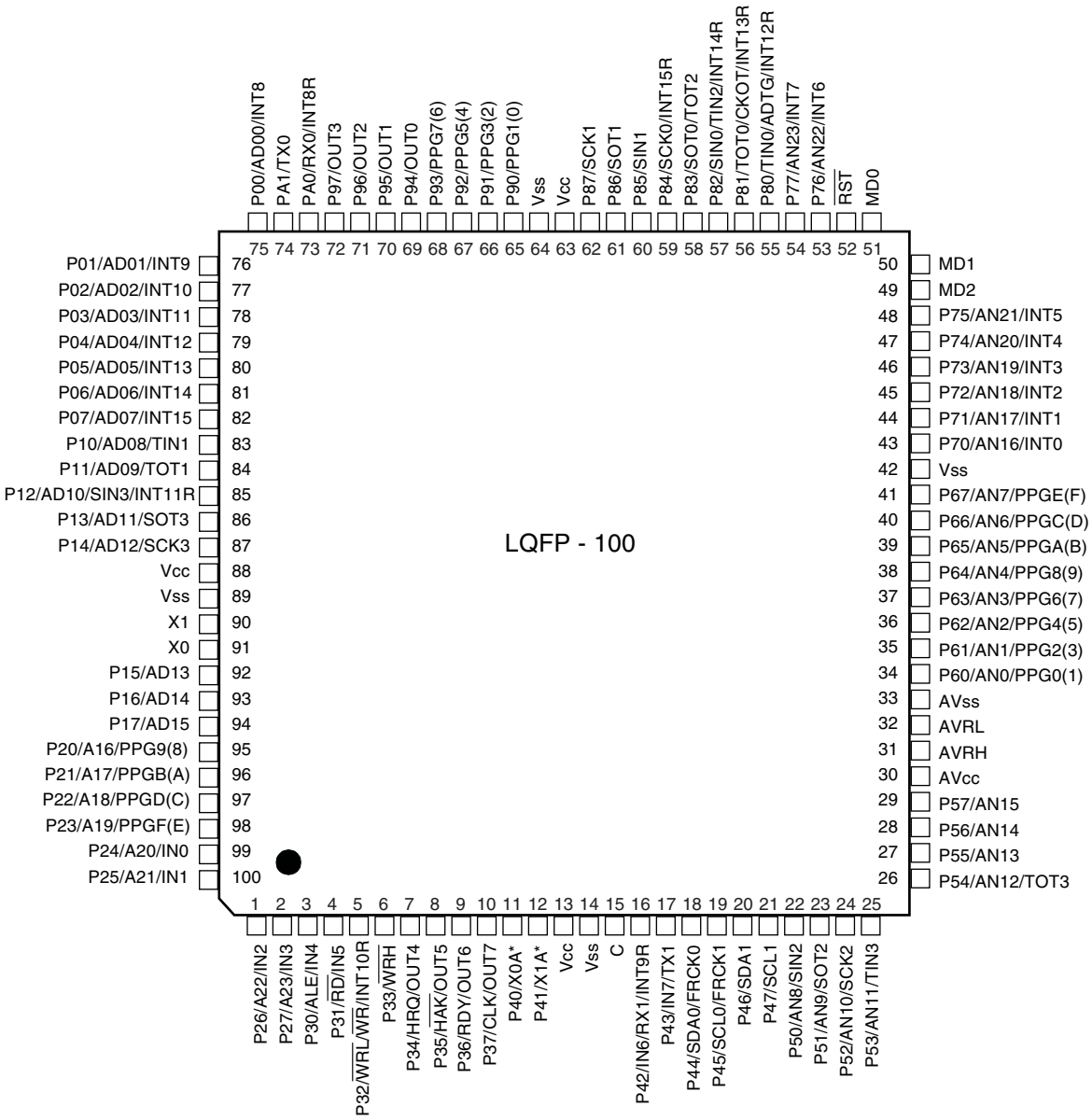
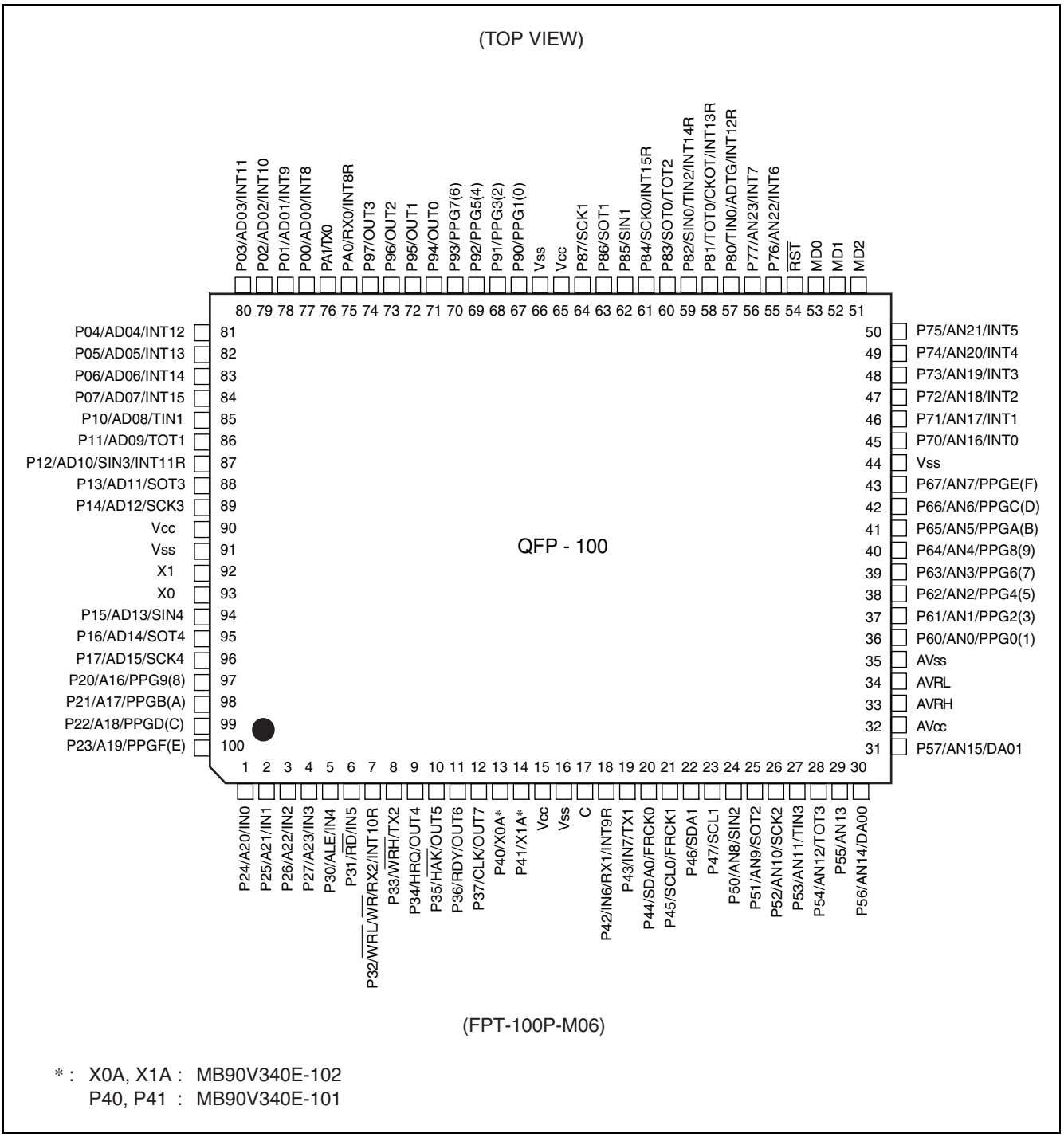
(TOP VIEW)



(FPT-100P-M20)

* : X0A, X1A : devices without an S suffix in the part number
P40, P41 : devices with an S suffix in the part number

■ MB90V340E-101/MB90V340E-102



This pin assignment is for using MB90V340E-101/102 via probecable as MB90340E.

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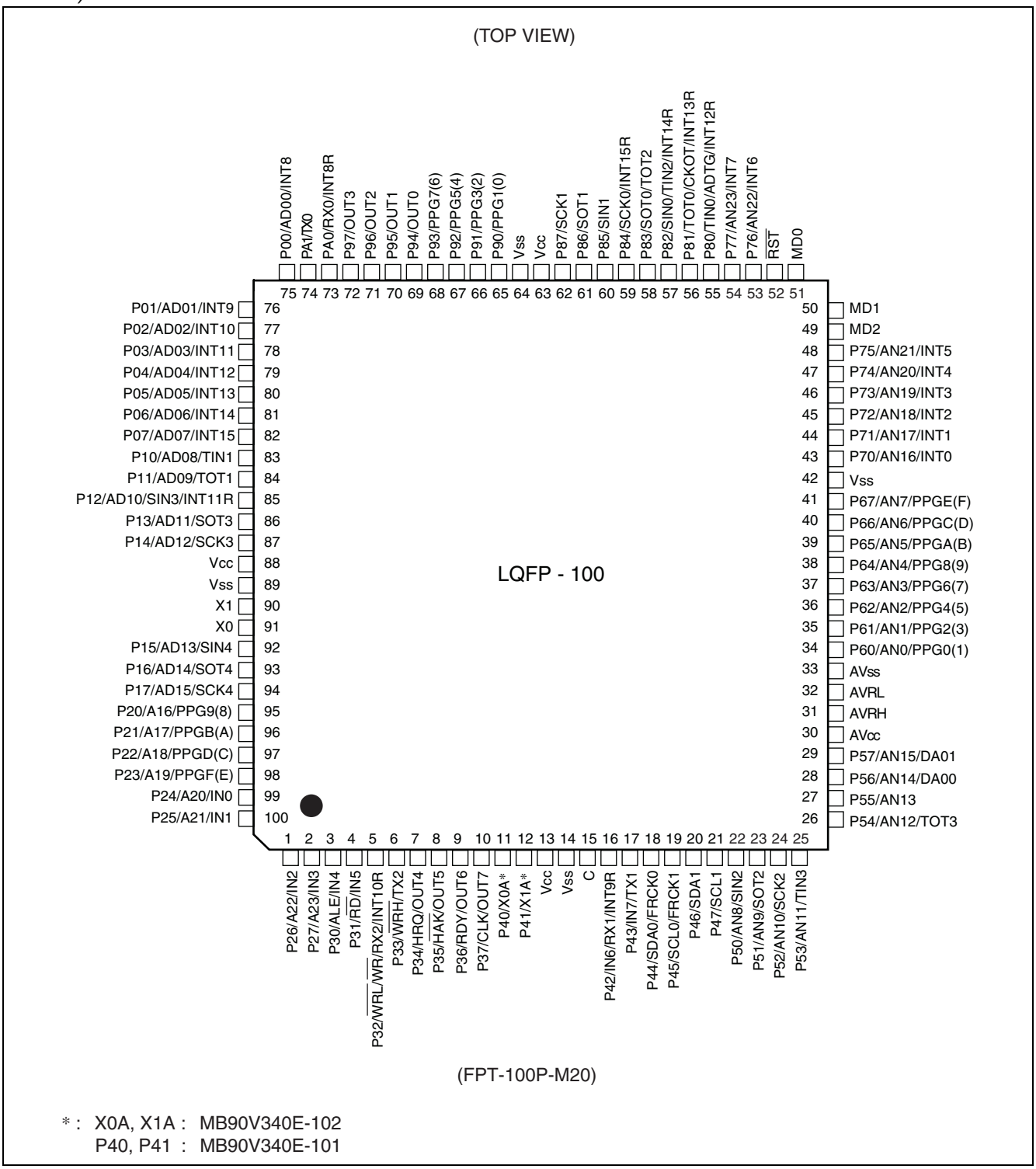

This pin assignment is for using MB90V340E-101/102 via probecable as MB90340E.

3. Pin Description

Pin No.		Pin name	I/O Circuit type*3	Function
QFP100*1	LQFP100*2			
1 to 4	99 to 2	P24 to P27	G	General purpose I/O pins. The register can be set to select whether to use a pull-up resistor.In external bus mode, the pin is enabled as a general-purpose I/O port when the corresponding bit in the external address output control register (HACR) is 1.
		A20 to A23		Output pins of the external address bus. When the corresponding bit in the external address output control register (HACR) is 0, the pins are enabled as high address output pins (A20 to A23).
		IN0 to IN3		Trigger input pins for input captures.
5	3	P30	G	General purpose I/O pin.The register can be set to select whether to use a pull-up resistor. This function is enabled in single-chip mode.
		ALE		Address latch enable output pin. This function is enabled when the external bus is enabled.
		IN4		Trigger input pin for input capture.
6	4	P31	G	General purpose I/O pin.The register can be set to select whether to use a pull-up resistor. This function is enabled in single-chip mode.
		$\overline{RD}$		External read strobe output pin. This function is enabled when the external bus is enabled.
		IN5		Trigger input pin for input capture.
7	5	P32	G	General purpose I/O pin. The register can be set to select whether to use a pull-up resistor. This function is enabled either in single-chip mode or when the WR/WRL pin output is disabled.
		$\overline{WR}$ / $\overline{WRL}$		Write strobe output pin for the external data bus. This function is enabled when both the external bus and the WR/WRL pin output are enabled. $\overline{WRL}$ is used to write-strobe 8 lower bits of the data bus in 16-bit access while $\overline{WR}$ is used to write-strobe 8 bits of the data bus in 8-bit access.
		INT10R		External interrupt request input pin.
8	6	P33	G	General purpose I/O pin. The register can be set to select whether to use a pull-up resistor.This function is enabled either in single-chip mode or when the WRH pin output is disabled.
		$\overline{WRH}$		Write strobe output pin for the upper 8 bits of the external data bus. This function is enabled when the external bus is enabled, when the external bus 16-bit mode is selected, and when the $\overline{WRH}$ output pin is enabled.

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Pin No.		Pin name	I/O Circuit type*3	Function
QFP100*1	LQFP100*2			
9	7	P34	G	General purpose I/O pin. The register can be set to select whether to use a pull-up resistor. This function is enabled either in single-chip mode or when the hold function is disabled.
		HRQ		Hold request input pin. This function is enabled when both the external bus and the hold function are enabled.
		OUT4		Waveform output pin for output compare.
10	8	P35	G	General purpose I/O pin. The register can be set to select whether to use a pull-up resistor. This function is enabled either in single-chip mode or when the hold function is disabled.
		$\overline{\text{HAK}}$		Hold acknowledge output pin. This function is enabled when both the external bus and the hold function are enabled.
		OUT5		Waveform output pin for output compare.
11	9	P36	G	General purpose I/O pin. The register can be set to select whether to use a pull-up resistor. This function is enabled either in single-chip mode or when the external ready function is disabled.
		RDY		External ready input pin. This function is enabled when both the external bus and the external ready function are enabled.
		OUT6		Waveform output pin for output compare.
12	10	P37	G	General purpose I/O pin. The register can be set to select whether to use a pull-up resistor. This function is enabled either in single-chip mode or when the clock output is disabled.
		CLK		Clock output pin. This function is enabled when both the external bus and clock output are enabled.
		OUT7		Waveform output pin for output compare
13, 14	11, 12	P40, P41	F	General purpose I/O pins. (devices with an S suffix in the part number and or MB90V340E-101)
		X0A, X1A	B	Oscillation pins for sub clock (devices without an S suffix in the part number and or MB90V340E-102)
15	13	V_{CC}	—	Power (3.5 V to 5.5 V) input pin
16	14	V_{SS}	—	GND pin
17	15	C	K	This is the power supply stabilization capacitor This pin should be connected to a ceramic capacitor with a capacitance greater than or equal to 0.1 µF.
18	16	P42	F	General purpose I/O pin.
		IN6		Trigger input pin for input capture.
		RX1		RX input pin for CAN1 Interface (MB90341E/342E/F342E/F345E only)
		INT9R		External interrupt request input pin

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Pin No.		Pin name	I/O Circuit type*3	Function
QFP100*1	LQFP100*2			
19	17	P43	F	General purpose I/O pin.
		IN7		Trigger input pin for input capture.
		TX1		TX Output pin for CAN1 (MB90341E/342E/F342E/F345E only)
20	18	P44	H	General purpose I/O pin.
		SDA0		Serial data I/O pin for I^2C (devices with a C suffix in the part number)
		FRCK0		Input pin for the 16-bit Free-run Timer 0
21	19	P45	H	General purpose I/O pin.
		SCL0		Serial clock I/O pin for I^2C (devices with a C suffix in the part number)
		FRCK1		Input pin for the 16-bit Free-run Timer
22	20	P46	H	General purpose I/O pin.
		SDA1		Serial data I/O pin for I^2C (devices with a C suffix in the part number)
23	21	P47	H	General purpose I/O pin.
		SCL1		Serial clock I/O pin for I^2C (devices with a C suffix in the part number)
24	22	P50	O	General purpose I/O pin.
		AN8		Analog input pin for the A/D converter
		SIN2		Serial data input pin for UART2
25	23	P51	I	General purpose I/O pin.
		AN9		Analog input pin for the A/D converter
		SOT2		Serial data output pin for UART2
26	24	P52	I	General purpose I/O pin.
		AN10		Analog input pin for the A/D converter
		SCK2		Clock I/O pin for UART2
27	25	P53	I	General purpose I/O pin.
		AN11		Analog input pin for the A/D converter
		TIN3		Event input pin for the reload timer
28	26	P54	I	General purpose I/O pin.
		AN12		Analog input pin for the A/D converter
		TOT3		Output pin for the reload timer
29	27	P55	I	General purpose I/O pin.
		AN13		Analog input pin for the A/D converter
30, 31	28, 29	P56, P57	J	General purpose I/O pins.
		AN14, AN15		Analog input pins for the A/D converter
32	30	AV_{CC}	K	Analog power input pin for the A/D Converter

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Pin No.		Pin name	I/O Circuit type*3	Function
QFP100*1	LQFP100*2			
33	31	AVRH	L	Reference voltage input pin for the A/D Converter. This power supply must be turned on or off while a voltage higher than or equal to AVRH is applied to AV_{CC}.
34	32	AVRL	K	Lower reference voltage input pin for the A/D Converter
35	33	AV_{SS}	K	Analog GND pin for the A/D Converter
36 to 43	34 to 41	P60 to P67	I	General purpose I/O pins.
		AN0 to AN7		Analog input pins for the A/D converter
		PPG0, 2, 4, 6, 8, A, C, E		Output pins for PPGs
44	42	V_{SS}	—	GND pin
45 to 50	43 to 48	P70 to P75	I	General purpose I/O pins.
		AN16 to AN21		Analog input pins for the A/D converter (devices with a C suffix in the part number)
		INT0 to INT5		External interrupt request input pins
51	49	MD2	D	Input pin for specifying the operating mode.
52, 53	50, 51	MD1, MD0	C	Input pins for specifying the operating mode.
54	52	$\overline{RST}$	E	Reset input pin
55, 56	53, 54	P76, P77	I	General purpose I/O pins.
		AN22, AN23		Analog input pins for the A/D converter (devices with a C suffix in the part number)
		INT6, INT7		External interrupt request input pins
57	55	P80	F	General purpose I/O pin.
		TIN0		Event input pin for the reload timer
		ADTG		Trigger input pin for the A/D converter
		INT12R		External interrupt request input pin
58	56	P81	F	General purpose I/O pin.
		TOT0		Output pin for the reload timer
		CKOT		Output pin for the clock monitor
		INT13R		External interrupt request input pin
59	57	P82	M	General purpose I/O pin.
		SIN0		Serial data input pin for UART0
		TIN2		Event input pin for the reload timer
		INT14R		External interrupt request input pin
60	58	P83	F	General purpose I/O pin.
		SOT0		Serial data output pin for UART0
		TOT2		Output pin for the reload timer

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Pin No.		Pin name	I/O Circuit type*3	Function
QFP100*1	LQFP100*2			
61	59	P84	F	General purpose I/O pin.
		SCK0		Clock I/O pin for UART0
		INT15R		External interrupt request input pin
62	60	P85	M	General purpose I/O pin.
		SIN1		Serial data input pin for UART1
63	61	P86	F	General purpose I/O pin.
		SOT1		Serial data output pin for UART1
64	62	P87	F	General purpose I/O pin.
		SCK1		Clock I/O pin for UART1
65	63	V_{CC}	—	Power (3.5 V to 5.5 V) input pin
66	64	V_{SS}	—	GND pin
67 to 70	65 to 68	P90 to P93	F	General purpose I/O pins
		PPG1, 3, 5, 7		Output pins for PPGs
71 to 74	69 to 72	P94 to P97	F	General purpose I/O pins
		OUT0 to OUT3		Waveform output pins for output compares. This function is enabled when the OCU enables waveform output.
75	73	PA0	F	General purpose I/O pin.
		RX0		RX input pin for CAN0 Interface
		INT8R		External interrupt request input pin
76	74	PA1	F	General purpose I/O pin.
		TX0		TX Output pin for CAN0
77 to 84	75 to 82	P00 to P07	G	General purpose I/O pins. The register can be set to select whether to use a pull-up resistor. This function is enabled in single-chip mode.
		AD00 to AD07		I/O pins for 8 lower bits of the external address/data bus. This function is enabled when the external bus is enabled.
		INT8 to INT15		External interrupt request input pins.
85	83	P10	G	General purpose I/O pin. The register can be set to select whether to use a pull-up resistor. This function is enabled in single-chip mode.
		AD08		I/O pin for the external address/data bus. This function is enabled when the external bus is enabled.
		TIN1		Event input pin for the reload timer

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Pin No.		Pin name	I/O Circuit type*3	Function
QFP100*1	LQFP100*2			
86	84	P11	G	General purpose I/O pin. The register can be set to select whether to use a pull-up resistor. This function is enabled in single-chip mode.
		AD09		I/O pin for the external address/data bus. This function is enabled when the external bus is enabled.
		TOT1		Output pin for the reload timer
87	85	P12	N	General purpose I/O pin. The register can be set to select whether to use a pull-up resistor. This function is enabled in single-chip mode.
		AD10		I/O pin for the external address/data bus. This function is enabled when the external bus is enabled.
		SIN3		Serial data input pin for UART3
		INT11R		External interrupt request input pin
88	86	P13	G	General purpose I/O pin. The register can be set to select whether to use a pull-up resistor. This function is enabled in single-chip mode.
		AD11		I/O pin for the external address/data bus. This function is enabled when the external bus is enabled.
		SOT3		Serial data output pin for UART3
89	87	P14	G	General purpose I/O pin. The register can be set to select whether to use a pull-up resistor. This function is enabled in single-chip mode.
		AD12		I/O pin for the external address/data bus. This function is enabled when the external bus is enabled.
		SCK3		Clock I/O pin for UART3
90	88	V_{CC}	—	Power (3.5 V to 5.5 V) input pin
91	89	V_{SS}	—	GND pin
92	90	X1	A	Main clock output pin
93	91	X0		Main clock input pin
94	92	P15	G	General purpose I/O pin. The register can be set to select whether to use a pull-up resistor. This function is enabled in single-chip mode.
		AD13		I/O pin for the external address/data bus. This function is enabled when the external bus is enabled.
95	93	P16	G	General purpose I/O pin. The register can be set to select whether to use a pull-up resistor. This function is enabled in single-chip mode.
		AD14		I/O pin for the external address/data bus. This function is enabled when the external bus is enabled.

(Continued)

(Continued)

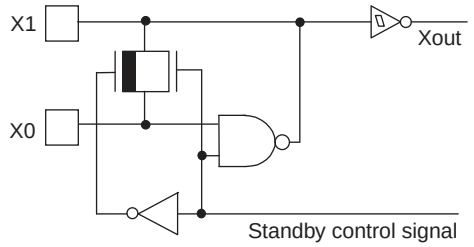
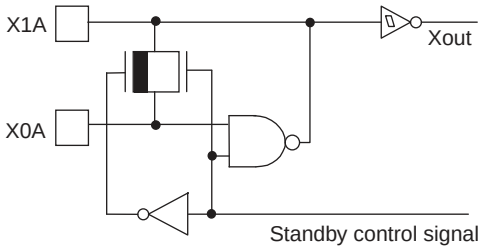
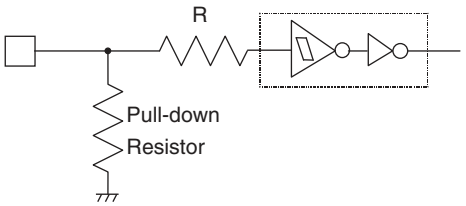
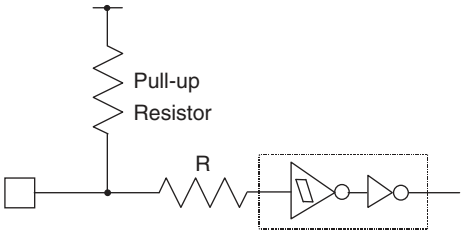
Pin No.		Pin name	I/O Circuit type*3	Function
QFP100*1	LQFP100*2			
96	94	P17	G	General purpose I/O pin. The register can be set to select whether to use a pull-up resistor. This function is enabled in single-chip mode.
		AD15		I/O pin for the external address/data bus. This function is enabled when the external bus is enabled.
97 to 100	95 to 98	P20 to P23	G	General purpose I/O pins. The register can be set to select whether to use a pull-up resistor.In external bus mode, the pin is enabled as a general-purpose I/O port when the corresponding bit in the external address output control register (HACR) is 1.
		A16 to A19		Output pins of the external address bus. When the corresponding bit in the external address output control register (HACR) is 0, the pins are enabled as high address output pins (A16 to A19).
		PPG9,PPGB,PPGD,PPGF		Output pins for PPGs

1 : FPT-100P-M06

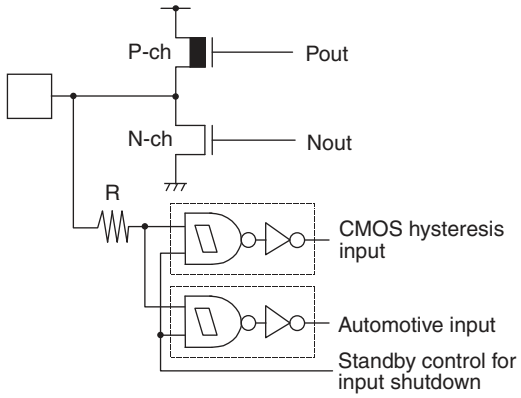
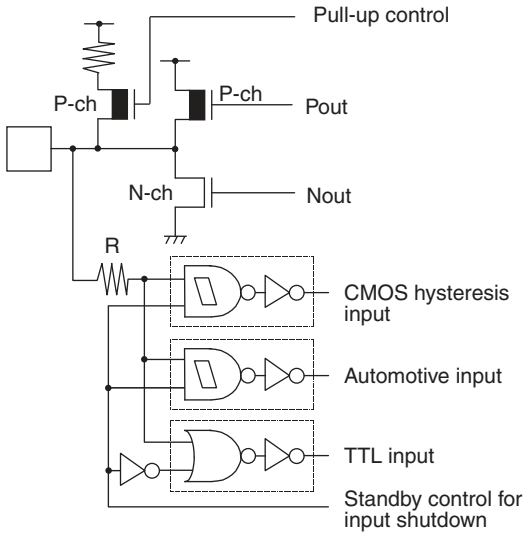
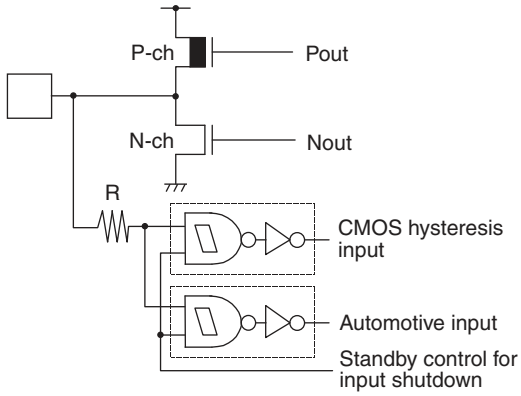
2 : FPT-100P-M20

3 : For I/O circuit type, refer to “I/O Circuit Type”.

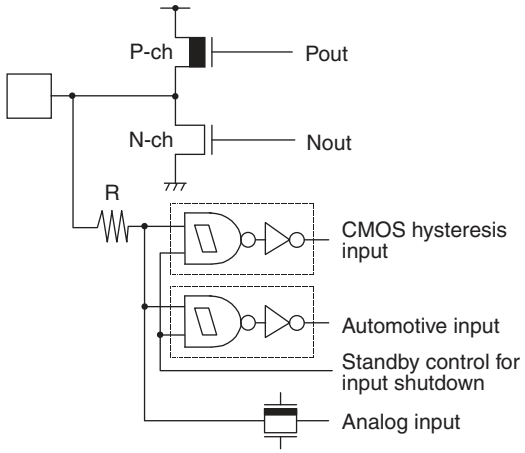
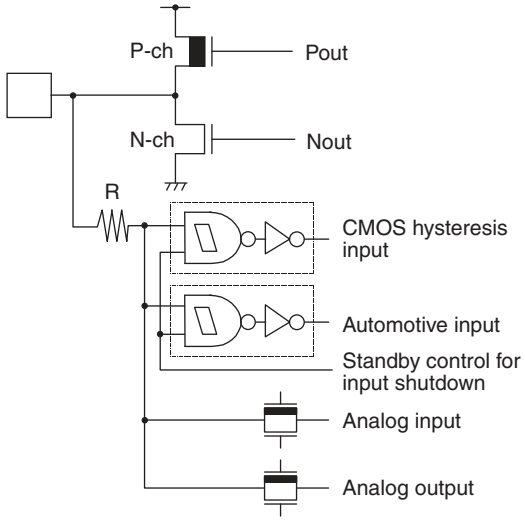
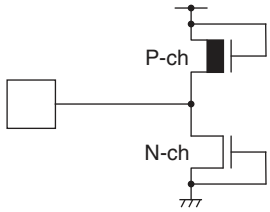
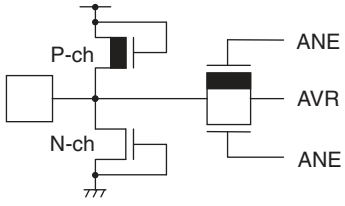
4. I/O Circuit Type

Type	Circuit	Remarks
A		Oscillation circuit High-speed oscillation feedback resistor = approx. 1 MΩ
B		Oscillation circuit Low-speed oscillation feedback resistor = approx. 10 MΩ
C		■ MASK ROM and evaluation products: CMOS hysteresis input pin ■ Flash memory products: CMOS input pin
D		MASK ROM and evaluation products: ■ CMOS hysteresis input pin ■ Pull-down resistor value: approx. 50 kΩ Flash memory products: ■ CMOS input pin ■ No pull-down
E		CMOS hysteresis input pin Pull-up resistor value: approx. 50 kΩ

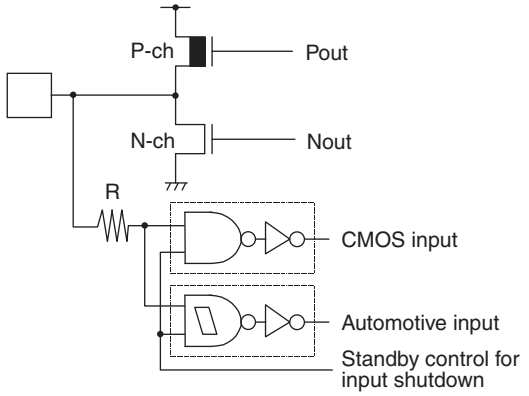
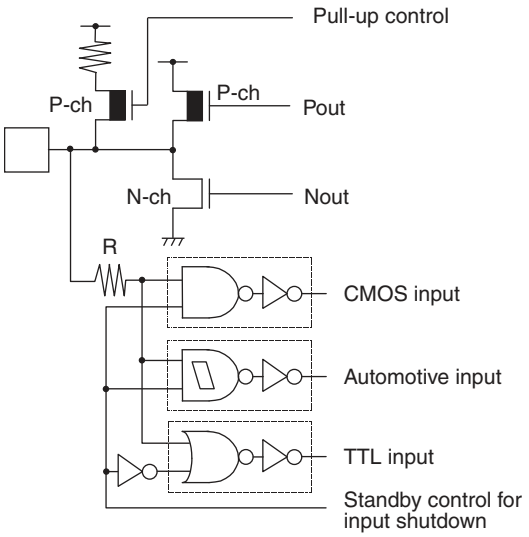
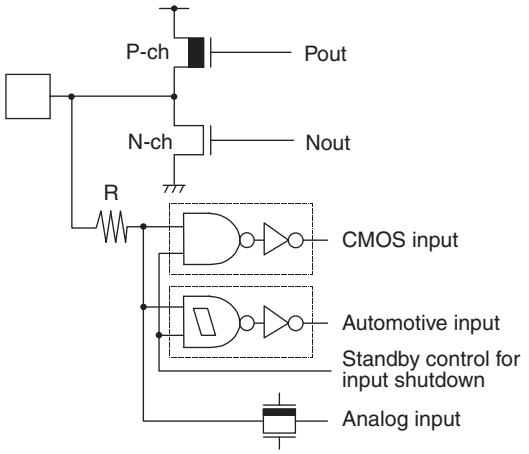
(Continued)

Type	Circuit	Remarks
F		■ CMOS level output (I_{OL} = 4 mA, I_{OH} = –4 mA) ■ CMOS hysteresis input (with function to disconnect input during standby) ■ Automotive input (with function to disconnect input during standby)
G		■ CMOS level output (I_{OL} = 4 mA, I_{OH} = –4 mA) ■ CMOS hysteresis input (with function to disconnect input during standby) ■ Automotive input (with function to disconnect input during standby) ■ TTL input (with function to disconnect input during standby) ■ Programmable pull-up resistor: 50 kΩ approx.
H		■ CMOS level output (I_{OL} = 3 mA, I_{OH} = –3 mA) ■ CMOS hysteresis input (with function to disconnect input during standby) ■ Automotive input (with function to disconnect input during standby)

(Continued)

Type	Circuit	Remarks
I		■ CMOS level output (I_{OL} = 4 mA, I_{OH} = –4 mA) ■ CMOS hysteresis input (with function to disconnect input during standby) ■ Automotive input (with function to disconnect input during standby) ■ A/D converter analog input
J		■ CMOS level output (I_{OL} = 4 mA, I_{OH} = –4 mA) ■ D/A analog output ■ CMOS hysteresis input (with function to disconnect input during standby) ■ Automotive input (with function to disconnect input during standby) ■ A/D converter analog input
K		Power supply input protection circuit
L		■ A/D converter reference voltage power supply input pin, with the protection circuit ■ Flash memory devices do not have a protection circuit against V_{CC} for pin AVRH

(Continued)

Type	Circuit	Remarks
M		■ CMOS level output (I_{OL} = 4 mA, I_{OH} = −4 mA) ■ CMOS input (with function to disconnect input during standby) ■ Automotive input (with function to disconnect input during standby)
N		■ CMOS level output (I_{OL} = 4 mA, I_{OH} = −4 mA) ■ CMOS input (with function to disconnect input during standby) ■ Automotive input (with function to disconnect input during standby) ■ TTL input (with function to disconnect input during standby) Programmable pull-up resistor: 50 kΩ approx
O		■ CMOS level output (I_{OL} = 4 mA, I_{OH} = −4 mA) ■ CMOS input (with function to disconnect input during standby) ■ Automotive input (with function to disconnect input during standby) ■ A/D converter analog input

5. Handling Devices

1. Preventing latch-up

CMOS IC may suffer latch-up under the following conditions:

- A voltage higher than V_{CC} or lower than V_{SS} is applied to an input or output pin.
- A voltage higher than the rated voltage is applied between V_{CC} and V_{SS} pins.
- The AV_{CC} power supply is applied before the V_{CC} voltage.

Latch-up may increase the power supply current drastically, causing thermal damage to the device.

For the same reason, also be careful not to let the analog power-supply voltage (AV_{CC}, AVRH) exceed the digital power-supply voltage.

2. Handling unused pins

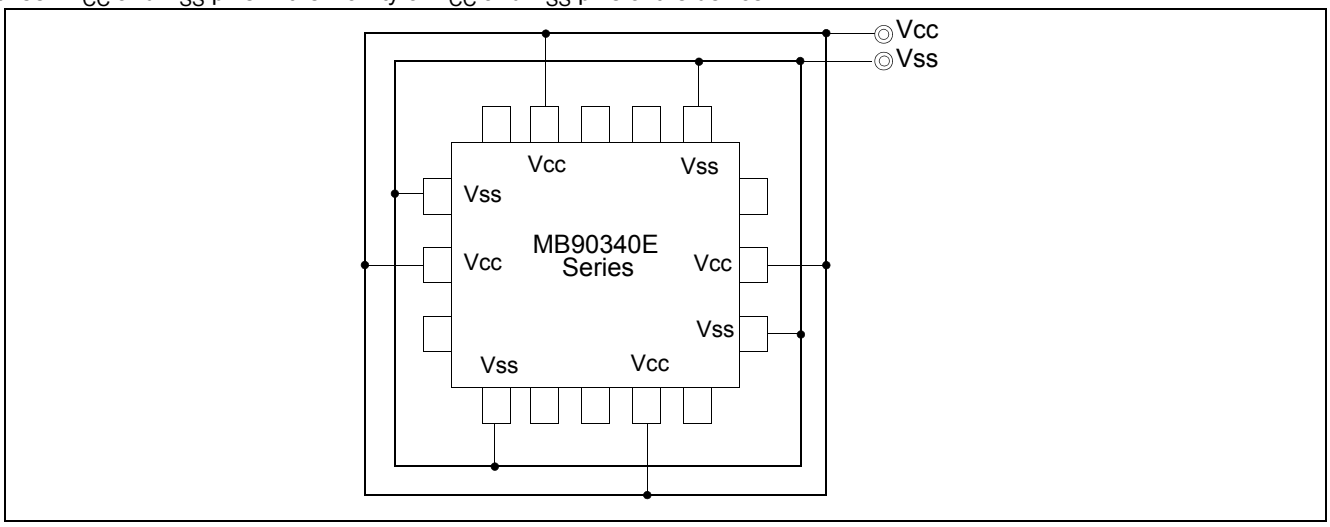
Leaving unused input terminals open may lead to permanent damage due to malfunction and latch-up; pull up or pull down the terminals through the resistors of 2 kΩ or more.

3. Power supply pins (V_{CC}/V_{SS})

- If there are multiple V_{CC} and V_{SS} pins, from the point of view of device design, pins to be of the same potential are connected inside of the device to prevent malfunction such as latch-up.

To reduce unnecessary radiation, prevent malfunctioning of the strobe signal due to the rise of ground level, and observe the standard for total output current, be sure to connect the V_{CC} and V_{SS} pins to the power supply and ground externally.
Connect V_{CC} and V_{SS} pins to the device from the current supply source at a possibly low impedance.

- As a measure against power supply noise, it is recommended to connect a capacitor of about 0.1 µF as a bypass capacitor between V_{CC} and V_{SS} pins in the vicinity of V_{CC} and V_{SS} pins of the device.



4. Mode Pins (MD0 to MD2)

Connect the mode pins directly to V_{CC} or V_{SS} pins. To prevent the device unintentionally entering test mode due to noise, lay out the printed circuit board so as to minimize the distance from the mode pins to V_{CC} or V_{SS} pins and to provide a low-impedance connection.

5. Sequence for Turning On the Power Supply to the A/D Converter and Analog Inputs

Make sure to turn on the A/D converter power supply (AV_{CC}, AVRH, AVRL) and analog inputs (AN0 to AN23) after turning-on the digital power supply (V_{CC}).

Turn-off the digital power after turning off the A/D converter supply and analog inputs. In this case, make sure that the voltage does not exceed AVRH or AV_{CC} (turning on/off the analog and digital power supplies simultaneously is acceptable).

6. Connection of Unused A/D Converter Pins when the A/D Converter is Used

Connect unused pins of A/D converter to $AV_{CC} = V_{CC}$, $AV_{SS} = AVRH = AVRL = V_{SS}$.

7. Crystal Oscillator Circuit

The X0, X1 pins and X0A, X1A pins may be possible causes of abnormal operation. Make sure to provide bypass capacitors via the shortest distance from X0, X1 pins and X0A, X1A pins, crystal oscillator (or ceramic oscillator) and ground lines, and make sure, to the utmost effort, that the oscillation circuit lines do not cross the lines of other circuits. It is highly recommended to provide a printed circuit board art work surrounding X0, X1 pins and X0A, X1A pins with a ground area for stabilizing the operation.

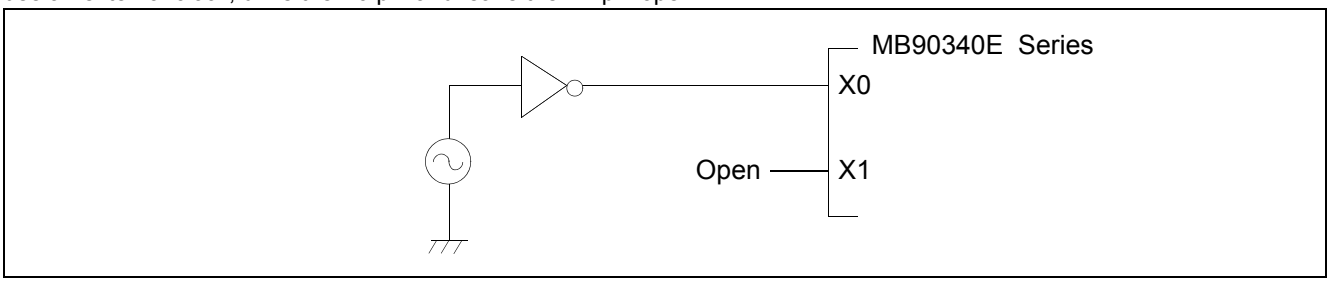
For each of the mass-production products, request an oscillator evaluation from the manufacturer of the oscillator you are using.

8. Pull-up/down resistors

The MB90340E Series does not support internal pull-up/down resistors (except for the pull-up resistors built into ports 0 to 3). Use external components where needed.

9. Using external clock

To use an external clock, drive the X0 pin and leave the X1 pin open.



10. Precautions when not using a sub clock signal

If you do not connect pins X0A and X1A to an oscillator, use pull-down handling on the X0A pin, and leave the X1A pin open.

11. Notes on operation in PLL clock mode

If PLL clock mode is selected, the microcontroller attempt to be working with the self-oscillating circuit even when there is no external oscillator or the external clock input is stopped. Performance of this operation, however, cannot be guaranteed.

12. Notes on Power-On

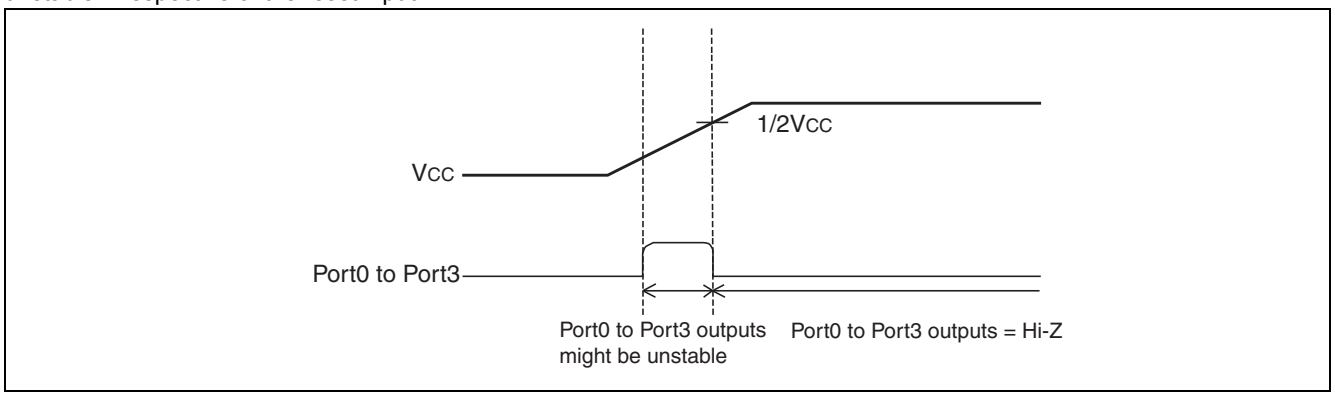
To prevent the internal regulator circuit from malfunctioning, set the voltage rise time during power-on to 50 µs or more (0.2 V to 2.7 V)

13.Stabilization of power supply voltage

A sudden change in the supply voltage may cause the device to malfunction even within the V_{CC} supply voltage operating range. Therefore, the V_{CC} supply voltage should be stabilized. For reference, the supply voltage should be controlled so that V_{CC} ripple variations (peak- to-peak values) at commercial frequencies (50 MHz/60 MHz) fall below 10% of the standard V_{CC} supply voltage and the coefficient of fluctuation does not exceed 0.1 V/ms at instantaneous power switching.

14.Port 0 to Port 3 Output During Power-on (External-bus Mode)

As shown below, when the power is turned on in External-Bus mode, there is a possibility that output signal of Port 0 to Port 3 might be unstable irrespective of the reset input.



15.Notes on Using the CAN Function

To use the CAN function, please set the DIRECT bit of the CAN Direct Mode Register (CDMR) to 1.

16.Flash Security Function (except for MB90F346E)

A security bit is located in the area of the flash memory.
If protection code 01_H is written in the security bit, the flash memory is in the protected state by security.
Therefore please do not write 01_H in this address if you do not use the security function.
Refer to following table for the address of the security bit.

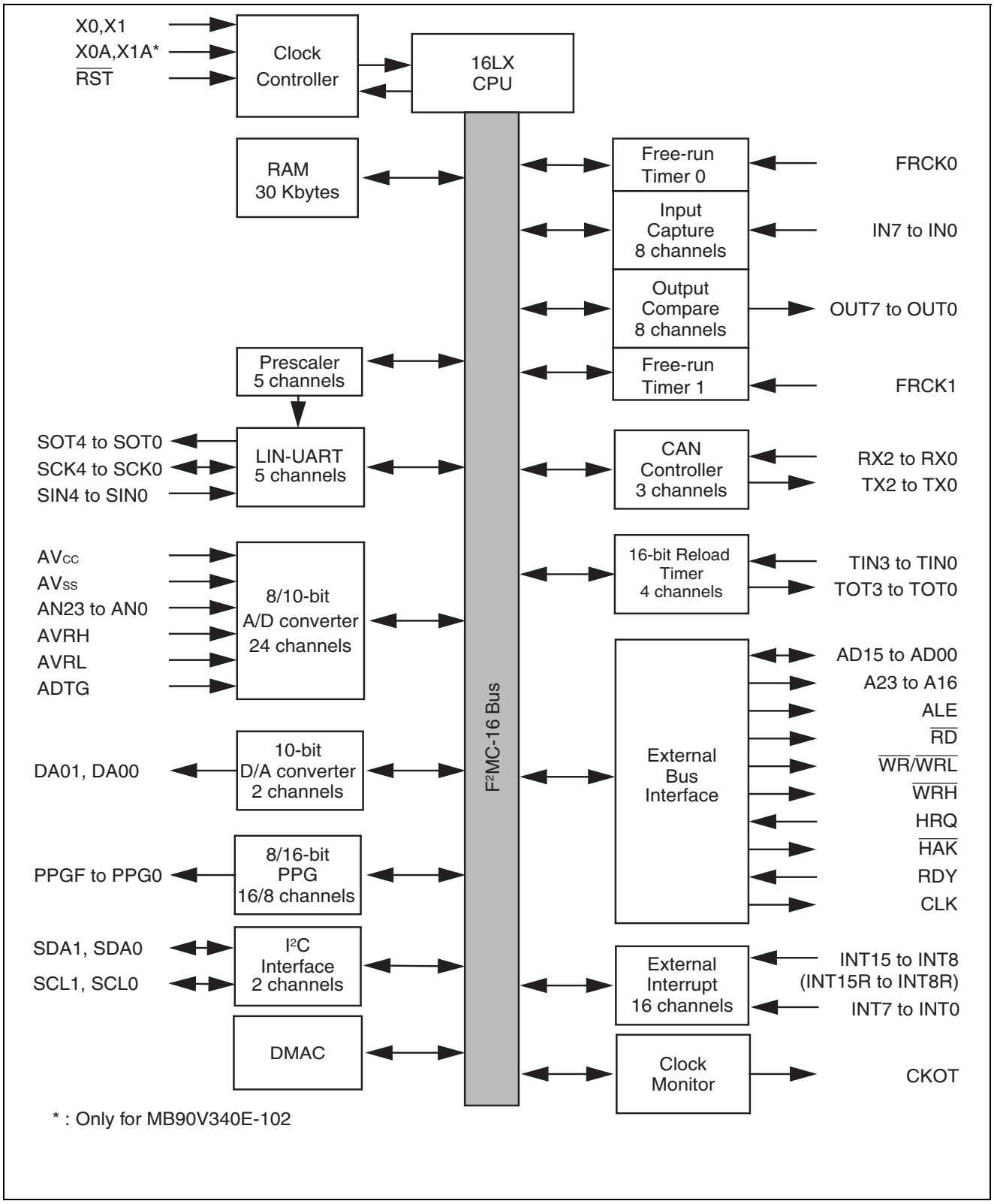
	Flash memory size	Address of the security bit
MB90F347E	Embedded 1 Mbit Flash Memory	$FE0001_H$
MB90F342E MB90F349E	Embedded 2 Mbits Flash Memory	$FC0001_H$
MB90F345E	Embedded 4 Mbits Flash Memory	$F80001_H$

17.Serial Communication

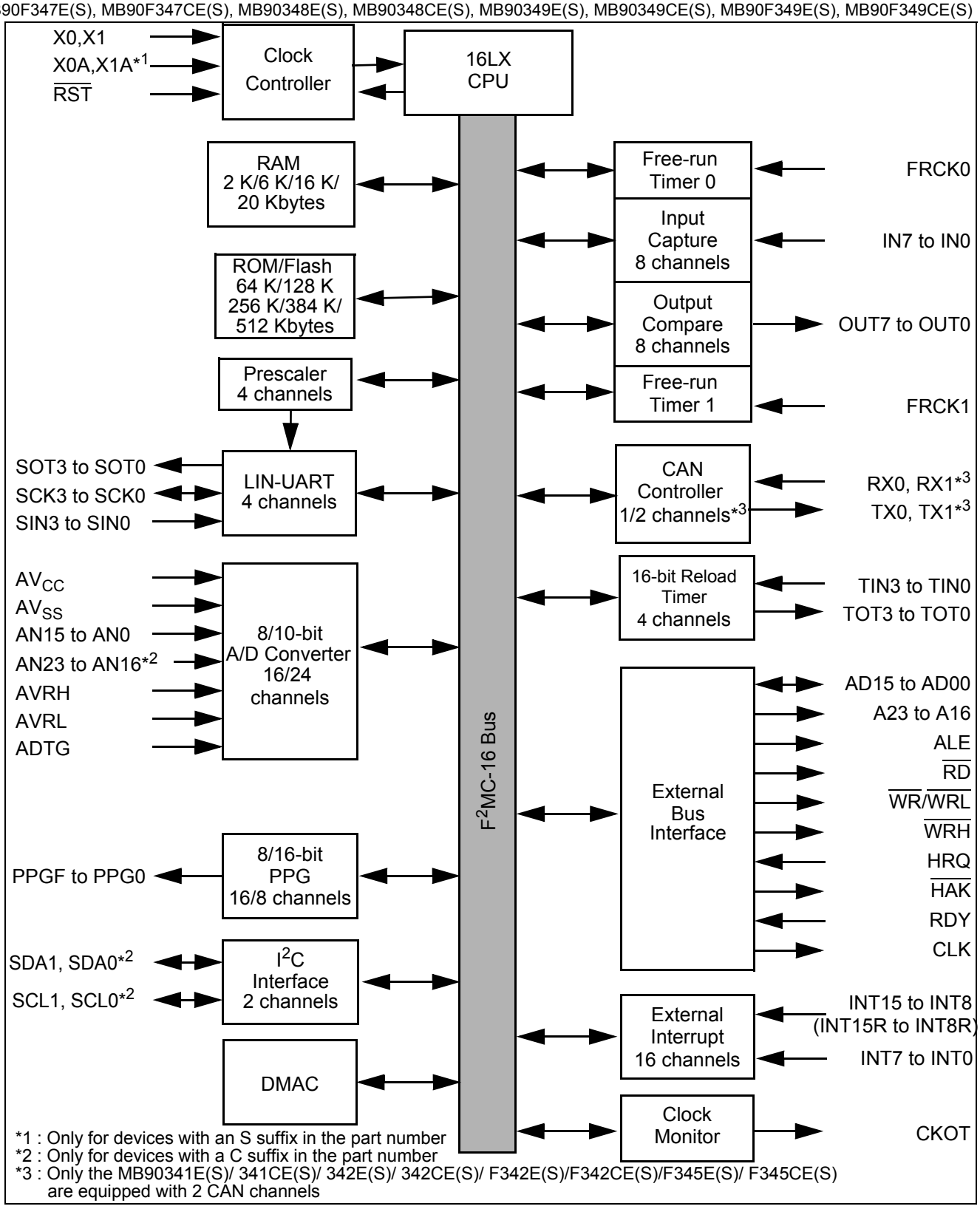
There is a possibility to receive wrong data due to the noise or other causes on the serial communication.
Therefore, design a printed circuit board so as to avoid noise.
Retransmit the data if an error occurs because of applying the checksum to the last data in consideration of receiving wrong data due to the noise.

6. Block Diagrams

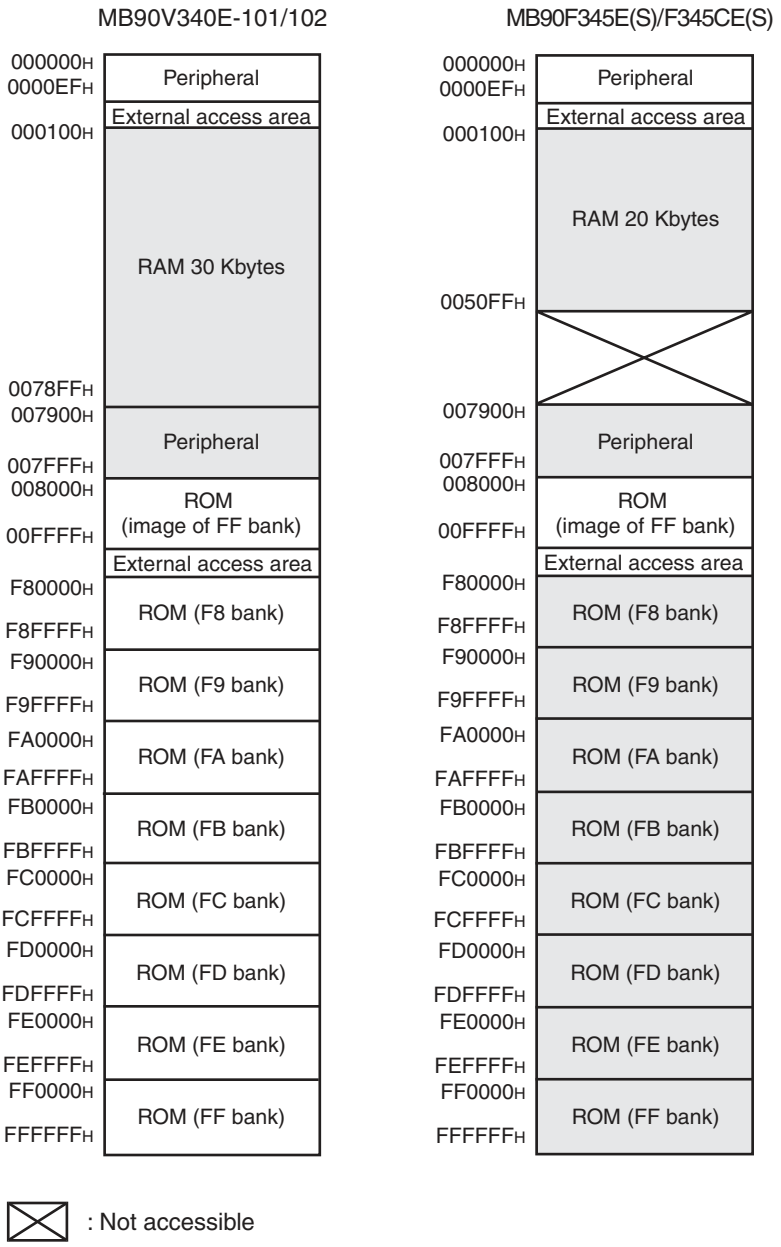
- MB90V340E-101/102

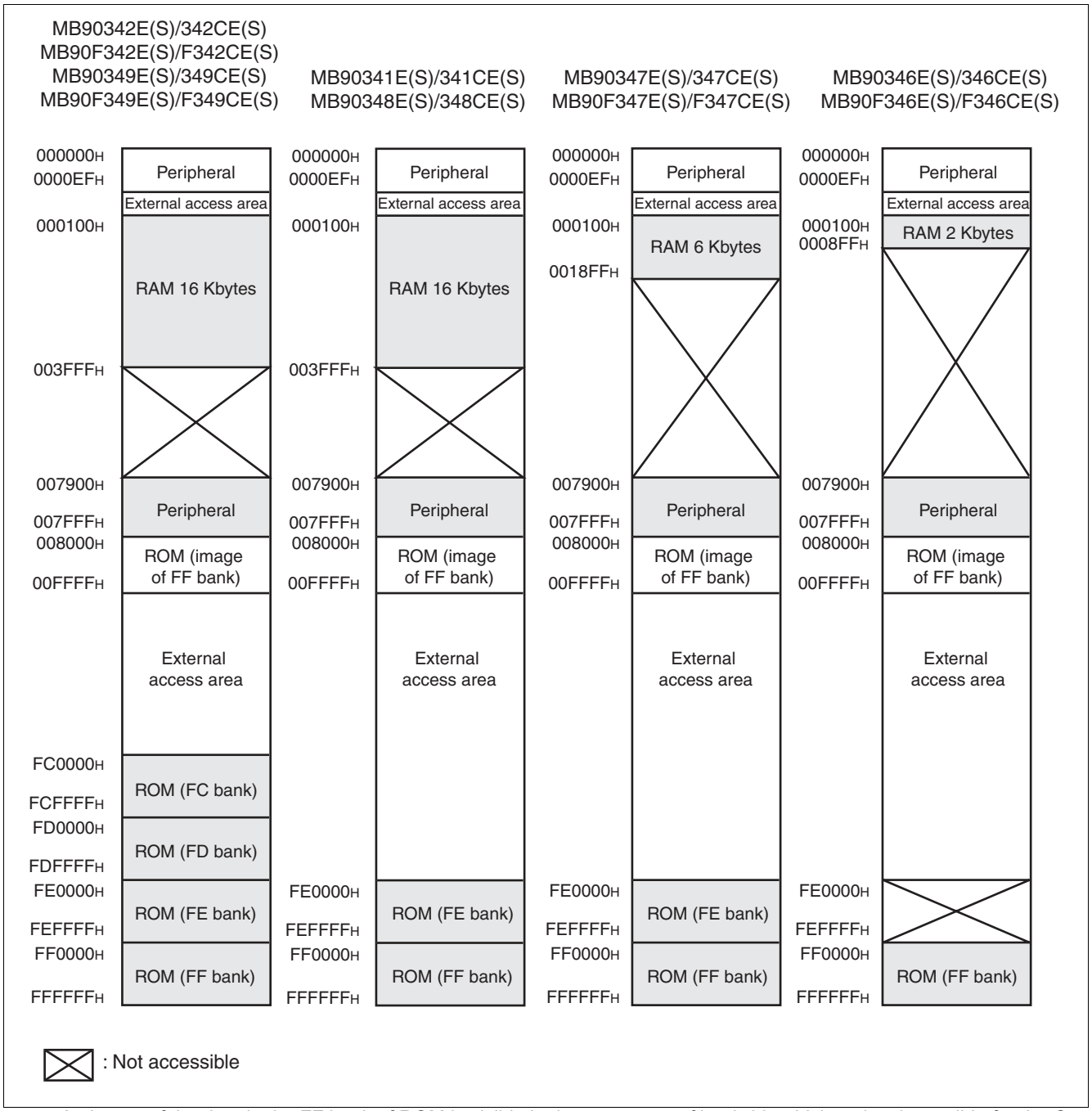


■ MB90341E(S), MB90341CE(S), MB90342E(S), MB90342CE(S), MB90F342E(S), MB90F342CE(S), MB90F345E(S), MB90F345CE(S), MB90346E(S), MB90346CE(S), MB90F346E(S), MB90F346CE(S), MB90347E(S), MB90347CE(S), MB90F347E(S), MB90F347CE(S), MB90348E(S), MB90348CE(S), MB90349E(S), MB90349CE(S), MB90F349E(S), MB90F349CE(S)



7. Memory Map


MB90V340E-101/102
000000H
0000EFH
Peripheral
External access area
000100H
RAM 30 Kbytes
0078FFH
007900H
Peripheral
007FFFH
008000H
ROM
(image of FF bank)
00FFFFH
External access area
F80000H
ROM (F8 bank)
F8FFFFH
F90000H
ROM (F9 bank)
F9FFFFH
FA0000H
ROM (FA bank)
FAFFFFH
FB0000H
ROM (FB bank)
FBFFFFH
FC0000H
ROM (FC bank)
FCFFFFH
FD0000H
ROM (FD bank)
FDFFFFH
FE0000H
ROM (FE bank)
FEFFFFH
FF0000H
ROM (FF bank)
FFFFFFH
MB90F345E(S)/F345CE(S)
000000H
0000EFH
Peripheral
External access area
000100H
RAM 20 Kbytes
0050FFH
007900H
Peripheral
007FFFH
008000H
ROM
(image of FF bank)
00FFFFH
External access area
F80000H
ROM (F8 bank)
F8FFFFH
F90000H
ROM (F9 bank)
F9FFFFH
FA0000H
ROM (FA bank)
FAFFFFH
FB0000H
ROM (FB bank)
FBFFFFH
FC0000H
ROM (FC bank)
FCFFFFH
FD0000H
ROM (FD bank)
FDFFFFH
FE0000H
ROM (FE bank)
FEFFFFH
FF0000H
ROM (FF bank)
FFFFFFH
: Not accessible



Note: :An image of the data in the FF bank of ROM is visible in the upper part of bank 00, which makes it possible for the C compiler to use the small memory model. The lower 16 bits of addresses in the FF bank are the same as the lower 16 bits of addresses in the 00 bank so that tables stored in the ROM can be accessed without using the far specifier in the pointer declaration.
For example, when the address $00C000_H$ is accessed, the data at $FFC000_H$ in ROM is actually accessed.
The ROM area in bank FF exceeds 32 Kbytes, and its entire image cannot be shown in bank 00.
As a result, the image between $FF8000_H$ and $FFFFFF_H$ is visible in bank 00, while the image between $FF0000_H$ and $FF7FFF_H$ is visible only in bank FF.

8. I/O Map

Address	Register	Abbreviation	Access	Resource name	Initial value
000000_H	Port 0 Data Register	PDR0	R/W	Port 0	$XXXXXXXX_B$
000001_H	Port 1 Data Register	PDR1	R/W	Port 1	$XXXXXXXX_B$
000002_H	Port 2 Data Register	PDR2	R/W	Port 2	$XXXXXXXX_B$
000003_H	Port 3 Data Register	PDR3	R/W	Port 3	$XXXXXXXX_B$
000004_H	Port 4 Data Register	PDR4	R/W	Port 4	$XXXXXXXX_B$
000005_H	Port 5 Data Register	PDR5	R/W	Port 5	$XXXXXXXX_B$
000006_H	Port 6 Data Register	PDR6	R/W	Port 6	$XXXXXXXX_B$
000007_H	Port 7 Data Register	PDR7	R/W	Port 7	$XXXXXXXX_B$
000008_H	Port 8 Data Register	PDR8	R/W	Port 8	$XXXXXXXX_B$
000009_H	Port 9 Data Register	PDR9	R/W	Port 9	$XXXXXXXX_B$
$00000A_H$	Port A Data Register	PDRA	R/W	Port A	$XXXXXXXX_B$
$00000B_H$	Port 5 Analog Input Enable Register	ADER5	R/W	Port 5, A/D	11111111_B
$00000C_H$	Port 6 Analog Input Enable Register	ADER6	R/W	Port 6, A/D	11111111_B
$00000D_H$	Port 7 Analog Input Enable Register	ADER7	R/W	Port 7, A/D	11111111_B
$00000E_H$	Input Level Select Register 0	ILSR0	R/W	Ports	$XXXXXXXX_B$
$00000F_H$	Input Level Select Register 1	ILSR1	R/W	Ports	$XXXX0XXX_B$
000010_H	Port 0 Direction Register	DDR0	R/W	Port 0	00000000_B
000011_H	Port 1 Direction Register	DDR1	R/W	Port 1	00000000_B
000012_H	Port 2 Direction Register	DDR2	R/W	Port 2	00000000_B
000013_H	Port 3 Direction Register	DDR3	R/W	Port 3	00000000_B
000014_H	Port 4 Direction Register	DDR4	R/W	Port 4	00000000_B
000015_H	Port 5 Direction Register	DDR5	R/W	Port 5	00000000_B
000016_H	Port 6 Direction Register	DDR6	R/W	Port 6	00000000_B
000017_H	Port 7 Direction Register	DDR7	R/W	Port 7	00000000_B
000018_H	Port 8 Direction Register	DDR8	R/W	Port 8	00000000_B
000019_H	Port 9 Direction Register	DDR9	R/W	Port 9	00000000_B
$00001A_H$	Port A Direction Register	DDRA	R/W	Port A	00000100_B
$00001B_H$	Reserved				
$00001C_H$	Port 0 Pull-up Control Register	PUCR0	R/W	Port 0	00000000_B
$00001D_H$	Port 1 Pull-up Control Register	PUCR1	R/W	Port 1	00000000_B
$00001E_H$	Port 2 Pull-up Control Register	PUCR2	R/W	Port 2	00000000_B
$00001F_H$	Port 3 Pull-up Control Register	PUCR3	W, R/W	Port 3	00000000_B

(Continued)

Address	Register	Abbreviation	Access	Resource name	Initial value
000020_H	Serial Mode Register 0	SMR0	W,R/W	UART0	00000000_B
000021_H	Serial Control Register 0	SCR0	W,R/W		00000000_B
000022_H	Reception/Transmission Data Register 0	RDR0/TDR0	R/W		00000000_B
000023_H	Serial Status Register 0	SSR0	R,R/W		00001000_B
000024_H	Extended Communication Control Register 0	ECCR0	R,W, R/W		$000000XX_B$
000025_H	Extended Status/Control Register 0	ESCR0	R/W		00000100_B
000026_H	Baud Rate Generator Register 00	BGR00	R/W		00000000_B
000027_H	Baud Rate Generator Register 01	BGR01	R/W		00000000_B
000028_H	Serial Mode Register 1	SMR1	W,R/W	UART1	00000000_B
000029_H	Serial Control Register 1	SCR1	W,R/W		00000000_B
$00002A_H$	Reception/Transmission Data Register 1	RDR1/TDR1	R/W		00000000_B
$00002B_H$	Serial Status Register 1	SSR1	R,R/W		00001000_B
$00002C_H$	Extended Communication Control Register 1	ECCR1	R,W, R/W		$000000XX_B$
$00002D_H$	Extended Status/Control Register 1	ESCR1	R/W		00000100_B
$00002E_H$	Baud Rate Generator Register 10	BGR10	R/W		00000000_B
$00002F_H$	Baud Rate Generator Register 11	BGR11	R/W		00000000_B
000030_H	PPG 0 Operation Mode Control Register	PPGC0	W,R/W	16-bit PPG 0/1	$0X000XX1_B$
000031_H	PPG 1 Operation Mode Control Register	PPGC1	W,R/W		$0X000001_B$
000032_H	PPG 0/PPG 1 Count Clock Select Register	PPG01	R/W		$000000X0_B$
000033_H	Reserved				
000034_H	PPG 2 Operation Mode Control Register	PPGC2	W,R/W	16-bit PPG 2/3	$0X000XX1_B$
000035_H	PPG 3 Operation Mode Control Register	PPGC3	W,R/W		$0X000001_B$
000036_H	PPG 2/PPG 3 Count Clock Select Register	PPG23	R/W		$000000X0_B$
000037_H	Reserved				
000038_H	PPG 4 Operation Mode Control Register	PPGC4	W,R/W	16-bit PPG 4/5	$0X000XX1_B$
000039_H	PPG 5 Operation Mode Control Register	PPGC5	W,R/W		$0X000001_B$
$00003A_H$	PPG 4/PPG 5 Clock Select Register	PPG45	R/W		$000000X0_B$
$00003B_H$	Address Detect Control Register 1	PACSR1	R/W	Address Match Detection 1	00000000_B
$00003C_H$	PPG 6 Operation Mode Control Register	PPGC6	W,R/W	16-bit PPG 6/7	$0X000XX1_B$
$00003D_H$	PPG 7 Operation Mode Control Register	PPGC7	W,R/W		$0X000001_B$
$00003E_H$	PPG 6/PPG 7 Count Clock Control Register	PPG67	R/W		$000000X0_B$
$00003F_H$	Reserved				

(Continued)

Address	Register	Abbreviation	Access	Resource name	Initial value
000040_H	PPG 8 Operation Mode Control Register	PPGC8	W,R/W	16-bit PPG 8/9	$0X000XX1_B$
000041_H	PPG 9 Operation Mode Control Register	PPGC9	W,R/W		$0X000001_B$
000042_H	PPG 8/PPG 9 Count Clock Control Register	PPG89	R/W		$000000X0_B$
000043_H	Reserved				
000044_H	PPG A Operation Mode Control Register	PPGCA	W,R/W	16-bit PPG A/B	$0X000XX1_B$
000045_H	PPG B Operation Mode Control Register	PPGCB	W,R/W		$0X000001_B$
000046_H	PPG A/PPG B Count Clock Select Register	PPGAB	R/W		$000000X0_B$
000047_H	Reserved				
000048_H	PPG C Operation Mode Control Register	PPGCC	W,R/W	16-bit PPG C/D	$0X000XX1_B$
000049_H	PPG D Operation Mode Control Register	PPGCD	W,R/W		$0X000001_B$
$00004A_H$	PPG C/PPG D Count Clock Select Register	PPGCD	R/W		$000000X0_B$
$00004B_H$	Reserved				
$00004C_H$	PPG E Operation Mode Control Register	PPGCE	W,R/W	16-bit PPG E/F	$0X000XX1_B$
$00004D_H$	PPG F Operation Mode Control Register	PPGCF	W,R/W		$0X000001_B$
$00004E_H$	PPG E/PPG F Count Clock Select Register	PPGEF	R/W		$000000X0_B$
$00004F_H$	Reserved				
000050_H	Input Capture Control Status 0/1	ICS01	R/W	Input Capture 0/1	00000000_B
000051_H	Input Capture Edge 0/1	ICE01	R/W, R		$XXX0X0XX_B$
000052_H	Input Capture Control Status 2/3	ICS23	R/W	Input Capture 2/3	00000000_B
000053_H	Input Capture Edge 2/3	ICE23	R		$XXXXXXXX_B$
000054_H	Input Capture Control Status 4/5	ICS45	R/W	Input Capture 4/5	00000000_B
000055_H	Input Capture Edge 4/5	ICE45	R		$XXXXXXXX_B$
000056_H	Input Capture Control Status 6/7	ICS67	R/W	Input Capture 6/7	00000000_B
000057_H	Input Capture Edge 6/7	ICE67	R/W, R		$XXX000XX_B$
000058_H	Output Compare Control Status 0	OCS0	R/W	Output Compare 0/1	$0000XX00_B$
000059_H	Output Compare Control Status 1	OCS1	R/W		$0XX00000_B$
$00005A_H$	Output Compare Control Status 2	OCS2	R/W	Output Compare 2/3	$0000XX00_B$
$00005B_H$	Output Compare Control Status 3	OCS3	R/W		$0XX00000_B$
$00005C_H$	Output Compare Control Status 4	OCS4	R/W	Output Compare 4/5	$0000XX00_B$
$00005D_H$	Output Compare Control Status 5	OCS5	R/W		$0XX00000_B$
$00005E_H$	Output Compare Control Status 6	OCS6	R/W	Output Compare 6/7	$0000XX00_B$
$00005F_H$	Output Compare Control Status 7	OCS7	R/W		$0XX00000_B$

(Continued)

Address	Register	Abbreviation	Access	Resource name	Initial value
000060_H	Timer Control Status 0	TMCSR0	R/W	16-bit Reload Timer 0	00000000_B
000061_H	Timer Control Status 0	TMCSR0	R/W		$XXXX0000_B$
000062_H	Timer Control Status 1	TMCSR1	R/W	16-bit Reload Timer 1	00000000_B
000063_H	Timer Control Status 1	TMCSR1	R/W		$XXXX0000_B$
000064_H	Timer Control Status 2	TMCSR2	R/W	16-bit Reload Timer 2	00000000_B
000065_H	Timer Control Status 2	TMCSR2	R/W		$XXXX0000_B$
000066_H	Timer Control Status 3	TMCSR3	R/W	16-bit Reload Timer 3	00000000_B
000067_H	Timer Control Status 3	TMCSR3	R/W		$XXXX0000_B$
000068_H	A/D Control Status 0	ADCS0	R/W	A/D Converter	$000XXXX0_B$
000069_H	A/D Control Status 1	ADCS1	R/W		$0000000X_B$
$00006A_H$	A/D Data 0	ADCR0	R		00000000_B
$00006B_H$	A/D Data 1	ADCR1	R		$XXXXXX00_B$
$00006C_H$	ADC Setting 0	ADSR0	R/W		00000000_B
$00006D_H$	ADC Setting 1	ADSR1	R/W		00000000_B
$00006E_H$	Reserved				
$00006F_H$	ROM Mirror Function Select	ROMM	W	ROM Mirror	$XXXXXXX1_B$
000070_H to $00008F_H$	Reserved for CAN Controller 0/1. Refer to "CAN Controllers"				
000090_H to $00009A_H$	Reserved				
$00009B_H$	DMA Descriptor Channel Specified Register	DCSR	R/W	DMA	00000000_B
$00009C_H$	DMA Status L Register	DSRL	R/W		00000000_B
$00009D_H$	DMA Status H Register	DSRH	R/W		00000000_B
$00009E_H$	Address Detect Control Register 0	PACSR0	R/W	Address Match Detection 0	00000000_B
$00009F_H$	Delayed Interrupt Trigger/Release Register	DIRR	R/W	Delayed Interrupt	$XXXXXXX0_B$
$0000A0_H$	Low-power Mode Control Register	LPMCR	W,R/W	Low Power Control Circuit	00011000_B
$0000A1_H$	Clock Selection Register	CKSCR	R,R/W	Low Power Control Circuit	11111100_B
$0000A2_H$, $0000A3_H$	Reserved				
$0000A4_H$	DMA Stop Status Register	DSSR	R/W	DMA	00000000_B

(Continued)

Address	Register	Abbreviation	Access	Resource name	Initial value
$0000A5_H$	Automatic Ready Function Select Register	ARSR	W	External Memory Access	$0011XX00_B$
$0000A6_H$	External Address Output Control Register	HACR	W		00000000_B
$0000A7_H$	Bus Control Signal Selection Register	ECSR	W		$0000000X_B$
$0000A8_H$	Watchdog Control Register	WDTC	R,W	Watchdog Timer	$XXXXX111_B$
$0000A9_H$	Time Base Timer Control Register	TBTC	W,R/W	Time Base Timer	$1XX00100_B$
$0000AA_H$	Watch Timer Control Register	WTC	R,R/W	Watch Timer	$1X001000_B$
$0000AB_H$	Reserved				
$0000AC_H$	DMA Enable L Register	DERL	R/W	DMA	00000000_B
$0000AD_H$	DMA Enable H Register	DERH	R/W		00000000_B
$0000AE_H$	Flash Control Status Register (Flash memory devices only. Otherwise reserved)	FMCS	R,R/W	Flash Memory	$000X0000_B$
$0000AF_H$	Reserved				
$0000B0_H$	Interrupt Control Register 00	ICR00	W,R/W	Interrupt Control	00000111_B
$0000B1_H$	Interrupt Control Register 01	ICR01	W,R/W		00000111_B
$0000B2_H$	Interrupt Control Register 02	ICR02	W,R/W		00000111_B
$0000B3_H$	Interrupt Control Register 03	ICR03	W,R/W		00000111_B
$0000B4_H$	Interrupt Control Register 04	ICR04	W,R/W		00000111_B
$0000B5_H$	Interrupt Control Register 05	ICR05	W,R/W		00000111_B
$0000B6_H$	Interrupt Control Register 06	ICR06	W,R/W		00000111_B
$0000B7_H$	Interrupt Control Register 07	ICR07	W,R/W		00000111_B
$0000B8_H$	Interrupt Control Register 08	ICR08	W,R/W		00000111_B
$0000B9_H$	Interrupt Control Register 09	ICR09	W,R/W		00000111_B
$0000BA_H$	Interrupt Control Register 10	ICR10	W,R/W		00000111_B
$0000BB_H$	Interrupt Control Register 11	ICR11	W,R/W		00000111_B
$0000BC_H$	Interrupt Control Register 12	ICR12	W,R/W		00000111_B
$0000BD_H$	Interrupt Control Register 13	ICR13	W,R/W		00000111_B
$0000BE_H$	Interrupt Control Register 14	ICR14	W,R/W		00000111_B
$0000BF_H$	Interrupt Control Register 15	ICR15	W,R/W		00000111_B
$0000C0_H$	D/A Converter Data 0	DAT0	R/W	D/A Converter	$XXXXXXXX_B$
$0000C1_H$	D/A Converter Data 1	DAT1	R/W		$XXXXXXXX_B$
$0000C2_H$	D/A Control 0	DACR0	R/W		$XXXXXXX0_B$
$0000C3_H$	D/A Control 1	DACR1	R/W		$XXXXXXX0_B$

(Continued)

Address	Register	Abbreviation	Access	Resource name	Initial value
$0000C4_H$, $0000C5_H$	Reserved				
$0000C6_H$	External Interrupt Enable 0	ENIR0	R/W	External Interrupt 0	00000000_B
$0000C7_H$	External Interrupt Source 0	EIRR0	R/W		$XXXXXXXX_B$
$0000C8_H$	External Interrupt Level Setting 0	ELVR0	R/W		00000000_B
$0000C9_H$	External Interrupt Level Setting 0	ELVR0	R/W		00000000_B
$0000CA_H$	External Interrupt Enable 1	ENIR1	R/W	External Interrupt 1	00000000_B
$0000CB_H$	External Interrupt Source 1	EIRR1	R/W		$XXXXXXXX_B$
$0000CC_H$	External Interrupt Level Setting 1	ELVR1	R/W		00000000_B
$0000CD_H$	External Interrupt Level Setting 1	ELVR1	R/W		00000000_B
$0000CE_H$	External Interrupt Source Select	EISSR	R/W		00000000_B
$0000CF_H$	PLL/Sub clock Control Register	PSCCR	W	PLL	$XXXX0000_B$
$0000D0_H$	DMA Buffer Address Pointer L Register	BAPL	R/W	DMA	$XXXXXXXX_B$
$0000D1_H$	DMA Buffer Address Pointer M Register	BAPM	R/W		$XXXXXXXX_B$
$0000D2_H$	DMA Buffer Address Pointer H Register	BAPH	R/W		$XXXXXXXX_B$
$0000D3_H$	DMA Control Register	DMACS	R/W		$XXXXXXXX_B$
$0000D4_H$	I/O Register Address Pointer L Register	IOAL	R/W		$XXXXXXXX_B$
$0000D5_H$	I/O Register Address Pointer H Register	IOAH	R/W		$XXXXXXXX_B$
$0000D6_H$	Data Counter L Register	DCTL	R/W		$XXXXXXXX_B$
$0000D7_H$	Data Counter H Register	DCTH	R/W		$XXXXXXXX_B$
$0000D8_H$	Serial Mode Register 2	SMR2	W,R/W	UART2	00000000_B
$0000D9_H$	Serial Control Register 2	SCR2	W,R/W		00000000_B
$0000DA_H$	Reception/Transmission Data Register 2	RDR2/TDR2	R/W		00000000_B
$0000DB_H$	Serial Status Register 2	SSR2	R,R/W		00001000_B
$0000DC_H$	Extended Communication Control Register 2	ECCR2	R,W, R/W		$000000XX_B$
$0000DD_H$	Extended Status Control Register 2	ESCR2	R/W		00000100_B
$0000DE_H$	Baud Rate Generator Register 20	BGR20	R/W		00000000_B
$0000DF_H$	Baud Rate Generator Register 21	BGR21	R/W		00000000_B
$0000E0_H$ to $0000EF_H$	Reserved for CAN Controller 2. Refer to "CAN Controllers"				
$0000F0_H$ to $0000FF_H$	External				

(Continued)

Address	Register	Abbreviation	Access	Resource name	Initial value
007900_H	Reload Register L0	PRLL0	R/W	16-bit PPG 0/1	$XXXXXXXX_B$
007901_H	Reload Register H0	PRLH0	R/W		$XXXXXXXX_B$
007902_H	Reload Register L1	PRLL1	R/W		$XXXXXXXX_B$
007903_H	Reload Register H1	PRLH1	R/W		$XXXXXXXX_B$
007904_H	Reload Register L2	PRLL2	R/W	16-bit PPG 2/3	$XXXXXXXX_B$
007905_H	Reload Register H2	PRLH2	R/W		$XXXXXXXX_B$
007906_H	Reload Register L3	PRLL3	R/W		$XXXXXXXX_B$
007907_H	Reload Register H3	PRLH3	R/W		$XXXXXXXX_B$
007908_H	Reload Register L4	PRLL4	R/W	16-bit PPG 4/5	$XXXXXXXX_B$
007909_H	Reload Register H4	PRLH4	R/W		$XXXXXXXX_B$
$00790A_H$	Reload Register L5	PRLL5	R/W		$XXXXXXXX_B$
$00790B_H$	Reload Register H5	PRLH5	R/W		$XXXXXXXX_B$
$00790C_H$	Reload Register L6	PRLL6	R/W	16-bit PPG 6/7	$XXXXXXXX_B$
$00790D_H$	Reload Register H6	PRLH6	R/W		$XXXXXXXX_B$
$00790E_H$	Reload Register L7	PRLL7	R/W		$XXXXXXXX_B$
$00790F_H$	Reload Register H7	PRLH7	R/W		$XXXXXXXX_B$
007910_H	Reload Register L8	PRLL8	R/W	16-bit PPG 8/9	$XXXXXXXX_B$
007911_H	Reload Register H8	PRLH8	R/W		$XXXXXXXX_B$
007912_H	Reload Register L9	PRLL9	R/W		$XXXXXXXX_B$
007913_H	Reload Register H9	PRLH9	R/W		$XXXXXXXX_B$
007914_H	Reload Register LA	PRLLA	R/W	16-bit PPG A/B	$XXXXXXXX_B$
007915_H	Reload Register HA	PRLHA	R/W		$XXXXXXXX_B$
007916_H	Reload Register LB	PRLLB	R/W		$XXXXXXXX_B$
007917_H	Reload Register HB	PRLHB	R/W		$XXXXXXXX_B$
007918_H	Reload Register LC	PRLLC	R/W	16-bit PPG C/D	$XXXXXXXX_B$
007919_H	Reload Register HC	PRLHC	R/W		$XXXXXXXX_B$
$00791A_H$	Reload Register LD	PRLLD	R/W		$XXXXXXXX_B$
$00791B_H$	Reload Register HD	PRLHD	R/W		$XXXXXXXX_B$
$00791C_H$	Reload Register LE	PRLLE	R/W	16-bit PPG E/F	$XXXXXXXX_B$
$00791D_H$	Reload Register HE	PRLHE	R/W		$XXXXXXXX_B$
$00791E_H$	Reload Register LF	PRLLF	R/W		$XXXXXXXX_B$
$00791F_H$	Reload Register HF	PRLHF	R/W		$XXXXXXXX_B$
007920_H	Input Capture 0	IPCP0	R	Input Capture 0/1	$XXXXXXXX_B$
007921_H	Input Capture 0	IPCP0	R		$XXXXXXXX_B$
007922_H	Input Capture 1	IPCP1	R		$XXXXXXXX_B$
007923_H	Input Capture 1	IPCP1	R		$XXXXXXXX_B$

(Continued)

Address	Register	Abbreviation	Access	Resource name	Initial value
007924_H	Input Capture 2	IPCP2	R	Input Capture 2/3	$XXXXXXXX_B$
007925_H	Input Capture 2	IPCP2	R		$XXXXXXXX_B$
007926_H	Input Capture 3	IPCP3	R		$XXXXXXXX_B$
007927_H	Input Capture 3	IPCP3	R		$XXXXXXXX_B$
007928_H	Input Capture 4	IPCP4	R	Input Capture 4/5	$XXXXXXXX_B$
007929_H	Input Capture 4	IPCP4	R		$XXXXXXXX_B$
$00792A_H$	Input Capture 5	IPCP5	R		$XXXXXXXX_B$
$00792B_H$	Input Capture 5	IPCP5	R		$XXXXXXXX_B$
$00792C_H$	Input Capture 6	IPCP6	R	Input Capture 6/7	$XXXXXXXX_B$
$00792D_H$	Input Capture 6	IPCP6	R		$XXXXXXXX_B$
$00792E_H$	Input Capture 7	IPCP7	R		$XXXXXXXX_B$
$00792F_H$	Input Capture 7	IPCP7	R		$XXXXXXXX_B$
007930_H	Output Compare 0	OCCP0	R/W	Output Compare 0/1	$XXXXXXXX_B$
007931_H	Output Compare 0	OCCP0	R/W		$XXXXXXXX_B$
007932_H	Output Compare 1	OCCP1	R/W		$XXXXXXXX_B$
007933_H	Output Compare 1	OCCP1	R/W		$XXXXXXXX_B$
007934_H	Output Compare 2	OCCP2	R/W	Output Compare 2/3	$XXXXXXXX_B$
007935_H	Output Compare 2	OCCP2	R/W		$XXXXXXXX_B$
007936_H	Output Compare 3	OCCP3	R/W		$XXXXXXXX_B$
007937_H	Output Compare 3	OCCP3	R/W		$XXXXXXXX_B$
007938_H	Output Compare 4	OCCP4	R/W	Output Compare 4/5	$XXXXXXXX_B$
007939_H	Output Compare 4	OCCP4	R/W		$XXXXXXXX_B$
$00793A_H$	Output Compare 5	OCCP5	R/W		$XXXXXXXX_B$
$00793B_H$	Output Compare 5	OCCP5	R/W		$XXXXXXXX_B$
$00793C_H$	Output Compare 6	OCCP6	R/W	Output Compare 6/7	$XXXXXXXX_B$
$00793D_H$	Output Compare 6	OCCP6	R/W		$XXXXXXXX_B$
$00793E_H$	Output Compare 7	OCCP7	R/W		$XXXXXXXX_B$
$00793F_H$	Output Compare 7	OCCP7	R/W		$XXXXXXXX_B$
007940_H	Timer Data 0	TCDT0	R/W	Free-run Timer 0	00000000_B
007941_H	Timer Data 0	TCDT0	R/W		00000000_B
007942_H	Timer Control Status 0	TCCSL0	R/W		00000000_B
007943_H	Timer Control Status 0	TCCSH0	R/W		$0XXXXXXX_B$
007944_H	Timer Data 1	TCDT1	R/W	Free-run Timer 1	00000000_B
007945_H	Timer Data 1	TCDT1	R/W		00000000_B
007946_H	Timer Control Status 1	TCCSL1	R/W		00000000_B
007947_H	Timer Control Status 1	TCCSH1	R/W		$0XXXXXXX_B$

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Address	Register	Abbreviation	Access	Resource name	Initial value
007948_H	Timer 0/Reload 0	TMR0/TMRLR0	R/W	16-bit Reload Timer 0	$XXXXXXXX_B$
007949_H			R/W		$XXXXXXXX_B$
$00794A_H$	Timer 1/Reload 1	TMR1/TMRLR1	R/W	16-bit Reload Timer 1	$XXXXXXXX_B$
$00794B_H$			R/W		$XXXXXXXX_B$
$00794C_H$	Timer 2/Reload 2	TMR2/TMRLR2	R/W	16-bit Reload Timer 2	$XXXXXXXX_B$
$00794D_H$			R/W		$XXXXXXXX_B$
$00794E_H$	Timer 3/Reload 3	TMR3/TMRLR3	R/W	16-bit Reload Timer 3	$XXXXXXXX_B$
$00794F_H$			R/W		$XXXXXXXX_B$
007950_H	Serial Mode Register 3	SMR3	W,R/W	UART3	00000000_B
007951_H	Serial Control Register 3	SCR3	W,R/W		00000000_B
007952_H	Reception/Transmission Data Register 3	RDR3/TDR3	R/W		00000000_B
007953_H	Serial Status Register 3	SSR3	R,R/W		00001000_B
007954_H	Extended Communication Control Register 3	ECCR3	R,W, R/W		$000000XX_B$
007955_H	Extended Status Control Register	ESCR3	R/W		00000100_B
007956_H	Baud Rate Generator Register 30	BGR30	R/W		00000000_B
007957_H	Baud Rate Generator Register 31	BGR31	R/W		00000000_B
007958_H	Serial Mode Register 4	SMR4	W,R/W	UART4	00000000_B
007959_H	Serial Control Register 4	SCR4	W,R/W		00000000_B
$00795A_H$	Reception/Transmission Data Register 4	RDR4/TDR4	R/W		00000000_B
$00795B_H$	Serial Status Register 4	SSR4	R,R/W		00001000_B
$00795C_H$	Extended Communication Control Register 4	ECCR4	R,W, R/W		$000000XX_B$
$00795D_H$	Extended Status Control Register	ESCR4	R/W		00000100_B
$00795E_H$	Baud Rate Generator Register 40	BGR40	R/W		00000000_B
$00795F_H$	Baud Rate Generator Register 41	BGR41	R/W		00000000_B
007960_H to $00796B_H$	Reserved				
$00796C_H$	Clock Output Enable Register	CLKR	R/W	Clock Monitor	$XXXX0000_B$
$00796D_H$	Reserved				
$00796E_H$	CAN Direct Mode Register	CDMR	R/W	CAN Clock sync	$XXXXXXX0_B$
$00796F_H$	CAN Switch Register	CANSWR	R/W	CAN 0/1	$XXXXXX00_B$

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Address	Register	Abbreviation	Access	Resource name	Initial value
007970_H	I^2C Bus Status Register 0	IBSR0	R	I^2C Interface 0	00000000_B
007971_H	I^2C Bus Control Register 0	IBCR0	W,R/W		00000000_B
007972_H	I^2C 10-bit Slave Address Register 0	ITBAL0	R/W		00000000_B
007973_H		ITBAH0	R/W		00000000_B
007974_H	I^2C 10-bit Slave Address Mask Register 0	ITMKL0	R/W		11111111_B
007975_H		ITMKH0	R/W		00111111_B
007976_H	I^2C 7-bit Slave Address Register 0	ISBA0	R/W		00000000_B
007977_H	I^2C 7-bit Slave Address Mask Register 0	ISMK0	R/W		01111111_B
007978_H	I^2C Data Register 0	IDAR0	R/W		00000000_B
007979_H, $00797A_H$	Reserved				
$00797B_H$	I^2C Clock Control Register 0	ICCR0	R/W	I^2C Interface 0	00011111_B
$00797C_H$ to $00797F_H$	Reserved				
007980_H	I^2C Bus Status Register 1	IBSR1	R	I^2C Interface 1	00000000_B
007981_H	I^2C Bus Control Register 1	IBCR1	W,R/W		00000000_B
007982_H	I^2C 10-bit Slave Address Register 1	ITBAL1	R/W		00000000_B
007983_H		ITBAH1	R/W		00000000_B
007984_H	I^2C 10-bit Slave Address Mask Register 1	ITMKL1	R/W		11111111_B
007985_H		ITMKH1	R/W		00111111_B
007986_H	I^2C 7-bit Slave Address Register 1	ISBA1	R/W		00000000_B
007987_H	I^2C 7-bit Slave Address Mask Register 1	ISMK1	R/W		01111111_B
007988_H	I^2C Data Register 1	IDAR1	R/W		00000000_B
007989_H, $00798A_H$	Reserved				
$00798B_H$	I^2C Clock Control Register 1	ICCR1	R/W	I^2C Interface 1	00011111_B
$00798C_H$ to $0079C1_H$	Reserved				
$0079C2_H$	Clock Modulator Control Register	CMCR	R, R/W	Clock Modulator	$0001X000_B$
$0079C3_H$ to $0079DF_H$	Reserved				

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(Continued)

Address	Register	Abbreviation	Access	Resource name	Initial value
$0079E0_H$	Detect Address Setting 0	PADR0	R/W	Address Match Detection 0	$XXXXXXXX_B$
$0079E1_H$	Detect Address Setting 0	PADR0	R/W		$XXXXXXXX_B$
$0079E2_H$	Detect Address Setting 0	PADR0	R/W		$XXXXXXXX_B$
$0079E3_H$	Detect Address Setting 1	PADR1	R/W		$XXXXXXXX_B$
$0079E4_H$	Detect Address Setting 1	PADR1	R/W		$XXXXXXXX_B$
$0079E5_H$	Detect Address Setting 1	PADR1	R/W		$XXXXXXXX_B$
$0079E6_H$	Detect Address Setting 2	PADR2	R/W		$XXXXXXXX_B$
$0079E7_H$	Detect Address Setting 2	PADR2	R/W		$XXXXXXXX_B$
$0079E8_H$	Detect Address Setting 2	PADR2	R/W		$XXXXXXXX_B$
$0079E9_H$ to $0079EF_H$	Reserved				
$0079F0_H$	Detect Address Setting 3	PADR3	R/W	Address Match Detection 1	$XXXXXXXX_B$
$0079F1_H$	Detect Address Setting 3	PADR3	R/W		$XXXXXXXX_B$
$0079F2_H$	Detect Address Setting 3	PADR3	R/W		$XXXXXXXX_B$
$0079F3_H$	Detect Address Setting 4	PADR4	R/W		$XXXXXXXX_B$
$0079F4_H$	Detect Address Setting 4	PADR4	R/W		$XXXXXXXX_B$
$0079F5_H$	Detect Address Setting 4	PADR4	R/W		$XXXXXXXX_B$
$0079F6_H$	Detect Address Setting 5	PADR5	R/W		$XXXXXXXX_B$
$0079F7_H$	Detect Address Setting 5	PADR5	R/W		$XXXXXXXX_B$
$0079F8_H$	Detect Address Setting 5	PADR5	R/W		$XXXXXXXX_B$
$0079F9_H$ to $0079FF_H$	Reserved				
$007A00_H$ to $007AFF_H$	Reserved for CAN Controller 0. Refer to “CAN Controllers				
$007B00_H$ to $007BFF_H$	Reserved for CAN Controller 0. Refer to “CAN Controllers”				
$007C00_H$ to $007CFF_H$	Reserved for CAN Controller 1. Refer to “CAN Controllers”				
$007D00_H$ to $007DFF_H$	Reserved for CAN Controller 1. Refer to “CAN Controllers”				
$007E00_H$ to $007FFF_H$	Reserved				

Note:
- Initial value of “X” represents unknown value.
- Any write access to reserved addresses in I/O map should not be performed. A read access to reserved addresses results in reading “X”.

9. CAN Controllers

The CAN controller has the following features:

- Conforms to CAN Specification Version 2.0 Part A and B
- Supports transmission/reception in standard frame and extended frame formats
- Supports transmission of data frames by receiving remote frames
- 16 transmission/reception message buffers
- 29-bit ID and 8-byte data
- Multi-level message buffer configuration
- Provides full-bit comparison, full-bit mask, acceptance register 0/acceptance register 1 for each message buffer as ID acceptance mask
- Two acceptance mask registers in either standard frame format or extended frame formats
- Bit rate programmable from 10 kbps to 2 Mbps (when input clock is at 16 MHz)

List of Control Registers (1)

Address		Register	Abbreviation	Access	Initial Value
CAN0	CAN1				
000070_H	000080_H	Message Buffer Valid Register	BVALR	R/W	00000000_B 00000000_B
000071_H	000081_H				
000072_H	000082_H	Transmit Request Register	TREQR	R/W	00000000_B 00000000_B
000073_H	000083_H				
000074_H	000084_H	Transmit Cancel Register	TCANR	W	00000000_B 00000000_B
000075_H	000085_H				
000076_H	000086_H	Transmission Complete Register	TCR	R/W	00000000_B 00000000_B
000077_H	000087_H				
000078_H	000088_H	Receive Complete Register	RCR	R/W	00000000_B 00000000_B
000079_H	000089_H				
$00007A_H$	$00008A_H$	Remote Request Receiving Register	RRTRR	R/W	00000000_B 00000000_B
$00007B_H$	$00008B_H$				
$00007C_H$	$00008C_H$	Receive Overrun Register	ROVRR	R/W	00000000_B 00000000_B
$00007D_H$	$00008D_H$				
$00007E_H$	$00008E_H$	Reception Interrupt Enable Register	RIER	R/W	00000000_B 00000000_B
$00007F_H$	$00008F_H$				

List of Control Registers (2)

Address		Register	Abbreviation	Access	Initial Value
CAN0	CAN1				
$007B00_H$	$007D00_H$	Control Status Register	CSR	R/W, W R/W, R	$0XXXX0X1_B$ $00XXX000_B$
$007B01_H$	$007D01_H$				
$007B02_H$	$007D02_H$	Last Event Indicator Register	LEIR	R/W	$000X0000_B$ $XXXXXXXX_B$
$007B03_H$	$007D03_H$				
$007B04_H$	$007D04_H$	Receive And Transmit Error Counter	RTEC	R	00000000_B 00000000_B
$007B05_H$	$007D05_H$				
$007B06_H$	$007D06_H$	Bit Timing Register	BTR	R/W	11111111_B $X1111111_B$
$007B07_H$	$007D07_H$				
$007B08_H$	$007D08_H$	IDE Register	IDER	R/W	$XXXXXXXX_B$ $XXXXXXXX_B$
$007B09_H$	$007D09_H$				
$007B0A_H$	$007D0A_H$	Transmit RTR Register	TRTRR	R/W	00000000_B 00000000_B
$007B0B_H$	$007D0B_H$				
$007B0C_H$	$007D0C_H$	Remote Frame Receive Waiting Register	RFWTR	R/W	$XXXXXXXX_B$ $XXXXXXXX_B$
$007B0D_H$	$007D0D_H$				
$007B0E_H$	$007D0E_H$	Transmit Interrupt Enable Register	TIER	R/W	00000000_B 00000000_B
$007B0F_H$	$007D0F_H$				
$007B10_H$	$007D10_H$	Acceptance Mask Select Register	AMSR	R/W	$XXXXXXXX_B$ $XXXXXXXX_B$
$007B11_H$	$007D11_H$				
$007B12_H$	$007D12_H$				$XXXXXXXX_B$ $XXXXXXXX_B$
$007B13_H$	$007D13_H$				
$007B14_H$	$007D14_H$	Acceptance Mask Register 0	AMR0	R/W	$XXXXXXXX_B$ $XXXXXXXX_B$
$007B15_H$	$007D15_H$				
$007B16_H$	$007D16_H$				$XXXXXXXX_B$ $XXXXXXXX_B$
$007B17_H$	$007D17_H$				
$007B18_H$	$007D18_H$	Acceptance Mask Register 1	AMR1	R/W	$XXXXXXXX_B$ $XXXXXXXX_B$
$007B19_H$	$007D19_H$				
$007B1A_H$	$007D1A_H$				$XXXXXXXX_B$ $XXXXXXXX_B$
$007B1B_H$	$007D1B_H$				

List of Message Buffers (ID Registers) (1)

Address		Register	Abbreviation	Access	Initial Value
CAN0	CAN1				
$007A00_H$ to $007A1F_H$	$007C00_H$ to $007C1F_H$	General-Purpose RAM	——	R/W	$XXXXXXXX_B$ to $XXXXXXXX_B$
$007A20_H$	$007C20_H$	ID Register 0	IDR0	R/W	$XXXXXXXX_B$ $XXXXXXXX_B$
$007A21_H$	$007C21_H$				
$007A22_H$	$007C22_H$				$XXXXXXXX_B$ $XXXXXXXX_B$
$007A23_H$	$007C23_H$				
$007A24_H$	$007C24_H$	ID Register 1	IDR1	R/W	$XXXXXXXX_B$ $XXXXXXXX_B$
$007A25_H$	$007C25_H$				
$007A26_H$	$007C26_H$				$XXXXXXXX_B$ $XXXXXXXX_B$
$007A27_H$	$007C27_H$				
$007A28_H$	$007C28_H$	ID Register 2	IDR2	R/W	$XXXXXXXX_B$ $XXXXXXXX_B$
$007A29_H$	$007C29_H$				
$007A2A_H$	$007C2A_H$				$XXXXXXXX_B$ $XXXXXXXX_B$
$007A2B_H$	$007C2B_H$				
$007A2C_H$	$007C2C_H$	ID Register 3	IDR3	R/W	$XXXXXXXX_B$ $XXXXXXXX_B$
$007A2D_H$	$007C2D_H$				
$007A2E_H$	$007C2E_H$				$XXXXXXXX_B$ $XXXXXXXX_B$
$007A2F_H$	$007C2F_H$				
$007A30_H$	$007C30_H$	ID Register 4	IDR4	R/W	$XXXXXXXX_B$ $XXXXXXXX_B$
$007A31_H$	$007C31_H$				
$007A32_H$	$007C32_H$				$XXXXXXXX_B$ $XXXXXXXX_B$
$007A33_H$	$007C33_H$				
$007A34_H$	$007C34_H$	ID Register 5	IDR5	R/W	$XXXXXXXX_B$ $XXXXXXXX_B$
$007A35_H$	$007C35_H$				
$007A36_H$	$007C36_H$				$XXXXXXXX_B$ $XXXXXXXX_B$
$007A37_H$	$007C37_H$				
$007A38_H$	$007C38_H$	ID Register 6	IDR6	R/W	$XXXXXXXX_B$ $XXXXXXXX_B$
$007A39_H$	$007C39_H$				
$007A3A_H$	$007C3A_H$				$XXXXXXXX_B$ $XXXXXXXX_B$
$007A3B_H$	$007C3B_H$				
$007A3C_H$	$007C3C_H$	ID Register 7	IDR7	R/W	$XXXXXXXX_B$ $XXXXXXXX_B$
$007A3D_H$	$007C3D_H$				
$007A3E_H$	$007C3E_H$				$XXXXXXXX_B$ $XXXXXXXX_B$
$007A3F_H$	$007C3F_H$				

List of Message Buffers (ID Registers) (2)

Address		Register	Abbreviation	Access	Initial Value
CAN0	CAN1				
$007A40_H$	$007C40_H$	ID Register 8	IDR8	R/W	$XXXXXXXX_B$ $XXXXXXXX_B$
$007A41_H$	$007C41_H$				
$007A42_H$	$007C42_H$				$XXXXXXXX_B$ $XXXXXXXX_B$
$007A43_H$	$007C43_H$				
$007A44_H$	$007C44_H$	ID Register 9	IDR9	R/W	$XXXXXXXX_B$ $XXXXXXXX_B$
$007A45_H$	$007C45_H$				
$007A46_H$	$007C46_H$				$XXXXXXXX_B$ $XXXXXXXX_B$
$007A47_H$	$007C47_H$				
$007A48_H$	$007C48_H$	ID Register 10	IDR10	R/W	$XXXXXXXX_B$ $XXXXXXXX_B$
$007A49_H$	$007C49_H$				
$007A4A_H$	$007C4A_H$				$XXXXXXXX_B$ $XXXXXXXX_B$
$007A4B_H$	$007C4B_H$				
$007A4C_H$	$007C4C_H$	ID Register 11	IDR11	R/W	$XXXXXXXX_B$ $XXXXXXXX_B$
$007A4D_H$	$007C4D_H$				
$007A4E_H$	$007C4E_H$				$XXXXXXXX_B$ $XXXXXXXX_B$
$007A4F_H$	$007C4F_H$				
$007A50_H$	$007C50_H$	ID Register 12	IDR12	R/W	$XXXXXXXX_B$ $XXXXXXXX_B$
$007A51_H$	$007C51_H$				
$007A52_H$	$007C52_H$				$XXXXXXXX_B$ $XXXXXXXX_B$
$007A53_H$	$007C53_H$				
$007A54_H$	$007C54_H$	ID Register 13	IDR13	R/W	$XXXXXXXX_B$ $XXXXXXXX_B$
$007A55_H$	$007C55_H$				
$007A56_H$	$007C56_H$				$XXXXXXXX_B$ $XXXXXXXX_B$
$007A57_H$	$007C57_H$				
$007A58_H$	$007C58_H$	ID Register 14	IDR14	R/W	$XXXXXXXX_B$ $XXXXXXXX_B$
$007A59_H$	$007C59_H$				
$007A5A_H$	$007C5A_H$				$XXXXXXXX_B$ $XXXXXXXX_B$
$007A5B_H$	$007C5B_H$				
$007A5C_H$	$007C5C_H$	ID Register 15	IDR15	R/W	$XXXXXXXX_B$ $XXXXXXXX_B$
$007A5D_H$	$007C5D_H$				
$007A5E_H$	$007C5E_H$				$XXXXXXXX_B$ $XXXXXXXX_B$
$007A5F_H$	$007C5F_H$				

List of Message Buffers (DLC Registers and Data Registers) (1)

Address		Register	Abbreviation	Access	Initial Value
CAN0	CAN1				
$007A60_H$	$007C60_H$	DLC Register 0	DLCR0	R/W	$XXXXXXXX_B$
$007A61_H$	$007C61_H$				
$007A62_H$	$007C62_H$	DLC Register 1	DLCR1	R/W	$XXXXXXXX_B$
$007A63_H$	$007C63_H$				
$007A64_H$	$007C64_H$	DLC Register 2	DLCR2	R/W	$XXXXXXXX_B$
$007A65_H$	$007C65_H$				
$007A66_H$	$007C66_H$	DLC Register 3	DLCR3	R/W	$XXXXXXXX_B$
$007A67_H$	$007C67_H$				
$007A68_H$	$007C68_H$	DLC Register 4	DLCR4	R/W	$XXXXXXXX_B$
$007A69_H$	$007C69_H$				
$007A6A_H$	$007C6A_H$	DLC Register 5	DLCR5	R/W	$XXXXXXXX_B$
$007A6B_H$	$007C6B_H$				
$007A6C_H$	$007C6C_H$	DLC Register 6	DLCR6	R/W	$XXXXXXXX_B$
$007A6D_H$	$007C6D_H$				
$007A6E_H$	$007C6E_H$	DLC Register 7	DLCR7	R/W	$XXXXXXXX_B$
$007A6F_H$	$007C6F_H$				
$007A70_H$	$007C70_H$	DLC Register 8	DLCR8	R/W	$XXXXXXXX_B$
$007A71_H$	$007C71_H$				
$007A72_H$	$007C72_H$	DLC Register 9	DLCR9	R/W	$XXXXXXXX_B$
$007A73_H$	$007C73_H$				
$007A74_H$	$007C74_H$	DLC Register 10	DLCR10	R/W	$XXXXXXXX_B$
$007A75_H$	$007C75_H$				
$007A76_H$	$007C76_H$	DLC Register 11	DLCR11	R/W	$XXXXXXXX_B$
$007A77_H$	$007C77_H$				
$007A78_H$	$007C78_H$	DLC Register 12	DLCR12	R/W	$XXXXXXXX_B$
$007A79_H$	$007C79_H$				
$007A7A_H$	$007C7A_H$	DLC Register 13	DLCR13	R/W	$XXXXXXXX_B$
$007A7B_H$	$007C7B_H$				
$007A7C_H$	$007C7C_H$	DLC Register 14	DLCR14	R/W	$XXXXXXXX_B$
$007A7D_H$	$007C7D_H$				
$007A7E_H$	$007C7E_H$	DLC Register 15	DLCR15	R/W	$XXXXXXXX_B$
$007A7F_H$	$007C7F_H$				

List of Message Buffers (DLC Registers and Data Registers) (2)

Address		Register	Abbreviation	Access	Initial Value
CAN0	CAN1				
$007A80_H$ to $007A87_H$	$007C80_H$ to $007C87_H$	Data Register 0 (8 bytes)	DTR0	R/W	$XXXXXXXX_B$ to $XXXXXXXX_B$
$007A88_H$ to $007A8F_H$	$007C88_H$ to $007C8F_H$	Data Register 1 (8 bytes)	DTR1	R/W	$XXXXXXXX_B$ to $XXXXXXXX_B$
$007A90_H$ to $007A97_H$	$007C90_H$ to $007C97_H$	Data Register 2 (8 bytes)	DTR2	R/W	$XXXXXXXX_B$ to $XXXXXXXX_B$
$007A98_H$ to $007A9F_H$	$007C98_H$ to $007C9F_H$	Data Register 3 (8 bytes)	DTR3	R/W	$XXXXXXXX_B$ to $XXXXXXXX_B$
$007AA0_H$ to $007AA7_H$	$007CA0_H$ to $007CA7_H$	Data Register 4 (8 bytes)	DTR4	R/W	$XXXXXXXX_B$ to $XXXXXXXX_B$
$007AA8_H$ to $007AAF_H$	$007CA8_H$ to $007CAF_H$	Data Register 5 (8 bytes)	DTR5	R/W	$XXXXXXXX_B$ to $XXXXXXXX_B$
$007AB0_H$ to $007AB7_H$	$007CB0_H$ to $007CB7_H$	Data Register 6 (8 bytes)	DTR6	R/W	$XXXXXXXX_B$ to $XXXXXXXX_B$
$007AB8_H$ to $007ABF_H$	$007CB8_H$ to $007CBF_H$	Data Register 7 (8 bytes)	DTR7	R/W	$XXXXXXXX_B$ to $XXXXXXXX_B$
$007AC0_H$ to $007AC7_H$	$007CC0_H$ to $007CC7_H$	Data Register 8 (8 bytes)	DTR8	R/W	$XXXXXXXX_B$ to $XXXXXXXX_B$
$007AC8_H$ to $007ACF_H$	$007CC8_H$ to $007CCF_H$	Data Register 9 (8 bytes)	DTR9	R/W	$XXXXXXXX_B$ to $XXXXXXXX_B$
$007AD0_H$ to $007AD7_H$	$007CD0_H$ to $007CD7_H$	Data Register 10 (8 bytes)	DTR10	R/W	$XXXXXXXX_B$ to $XXXXXXXX_B$
$007AD8_H$ to $007ADF_H$	$007CD8_H$ to $007CDF_H$	Data Register 11 (8 bytes)	DTR11	R/W	$XXXXXXXX_B$ to $XXXXXXXX_B$
$007AE0_H$ to $007AE7_H$	$007CE0_H$ to $007CE7_H$	Data Register 12 (8 bytes)	DTR12	R/W	$XXXXXXXX_B$ to $XXXXXXXX_B$
$007AE8_H$ to $007AEF_H$	$007CE8_H$ to $007CEF_H$	Data Register 13 (8 bytes)	DTR13	R/W	$XXXXXXXX_B$ to $XXXXXXXX_B$

List of Message Buffers (DLC Registers and Data Registers) (3)

Address		Register	Abbreviation	Access	Initial Value
CAN0	CAN1				
$007AF0_H$ to $007AF7_H$	$007CF0_H$ to $007CF7_H$	Data Register 14 (8 bytes)	DTR14	R/W	$XXXXXXXX_B$ to $XXXXXXXX_B$
$007AF8_H$ to $007AFF_H$	$007CF8_H$ to $007CFF_H$	Data Register 15 (8 bytes)	DTR15	R/W	$XXXXXXXX_B$ to $XXXXXXXX_B$

10. Interrupt Factors, Interrupt Vectors, Interrupt Control Register

Interrupt cause	EI^{2}OS Support	DMA channel number	Interrupt vector		Interrupt control register	
			Number	Address	Number	Address
Reset	N	—	#08	FFFFDC$_H$	—	—
INT9 instruction	N	—	#09	FFFFD8$_H$	—	—
Exception	N	—	#10	FFFFD4$_H$	—	—
CAN 0 RX	N	—	#11	FFFFD0$_H$	ICR00	0000B0$_H$
CAN 0 TX/NS	N	—	#12	FFFFCC$_H$		
CAN 1 RX / Input Capture 6	Y1	—	#13	FFFFC8$_H$	ICR01	0000B1$_H$
CAN 1 TX/NS / Input Capture 7	Y1	—	#14	FFFFC4$_H$		
CAN 2 RX / I^{2}C0	N	—	#15	FFFFC0$_H$	ICR02	0000B2$_H$
CAN 2 TX/NS	N	—	#16	FFFFBC$_H$		
16-bit Reload Timer 0	Y1	0	#17	FFFFB8$_H$	ICR03	0000B3$_H$
16-bit Reload Timer 1	Y1	1	#18	FFFFB4$_H$		
16-bit Reload Timer 2	Y1	2	#19	FFFFB0$_H$	ICR04	0000B4$_H$
16-bit Reload Timer 3	Y1	—	#20	FFFFAC$_H$		
PPG 0/1/4/5	N	—	#21	FFFFA8$_H$	ICR05	0000B5$_H$
PPG 2/3/6/7	N	—	#22	FFFFA4$_H$		
PPG 8/9/C/D	N	—	#23	FFFFA0$_H$	ICR06	0000B6$_H$
PPG A/B/E/F	N	—	#24	FFFF9C$_H$		
Time Base Timer	N	—	#25	FFFF98$_H$	ICR07	0000B7$_H$
External Interrupt 0 to 3, 8 to 11	Y1	3	#26	FFFF94$_H$		
Watch Timer	N	—	#27	FFFF90$_H$	ICR08	0000B8$_H$
External Interrupt 4 to 7, 12 to 15	Y1	4	#28	FFFF8C$_H$		
A/D Converter	Y1	5	#29	FFFF88$_H$	ICR09	0000B9$_H$
Free-run Timer 0 / Free-run Timer 1	N	—	#30	FFFF84$_H$		
Input Capture 4/5 / I^{2}C1	Y1	6	#31	FFFF80$_H$	ICR10	0000BA$_H$
Output Compare 0/1/4/5	Y1	7	#32	FFFF7C$_H$		
Input Capture 0 to 3	Y1	8	#33	FFFF78$_H$	ICR11	0000BB$_H$
Output Compare 2/3/6/7	Y1	9	#34	FFFF74$_H$		
UART 0 RX	Y2	10	#35	FFFF70$_H$	ICR12	0000BC$_H$
UART 0 TX	Y1	11	#36	FFFF6C$_H$		
UART 1 RX / UART 3 RX	Y2	12	#37	FFFF68$_H$	ICR13	0000BD$_H$
UART 1 TX / UART 3 TX	Y1	13	#38	FFFF64$_H$		

(Continued)

(Continued)

Interrupt cause	EI^{2}OS Support	DMA channel number	Interrupt vector		Interrupt control register	
			Number	Address	Number	Address
UART 2 RX / UART 4 RX	Y2	14	#39	$FFFF60_H$	ICR14	$0000BE_H$
UART 2 TX / UART 4 TX	Y1	15	#40	$FFFF5C_H$		
Flash Memory	N	——	#41	$FFFF58_H$	ICR15	$0000BF_H$
Delayed Interrupt	N	——	#42	$FFFF54_H$		

Y1 : Usable
Y2 : Usable, with EI^{2}OS stop function
N : Unusable

Note:
- The peripheral resources sharing the ICR register have the same interrupt level.
- When two peripheral resources share the ICR register, only one can use Extended Intelligent I/O Service at a time.
- When either of the two peripheral resources sharing the ICR register specifies Extended Intelligent I/O Service, the other one cannot use interrupts.

11. Electrical Characteristics

11.1 Absolute Maximum Ratings

Parameter	Symbol	Rating		Unit	Remarks
		Min	Max		
Power supply voltage*1	V_{CC}	$V_{SS} - 0.3$	$V_{SS} + 6.0$	V	
	AV_{CC}	$V_{SS} - 0.3$	$V_{SS} + 6.0$	V	$V_{CC} = AV_{CC}$*2
	AVRH, AVRL	$V_{SS} - 0.3$	$V_{SS} + 6.0$	V	$AV_{CC} \geq$ AVRH, $AV_{CC} \geq$ AVRL, AVRH $\geq$ AVRL
Input voltage*1	V_I	$V_{SS} - 0.3$	$V_{SS} + 6.0$	V	*3
Output voltage*1	V_O	$V_{SS} - 0.3$	$V_{SS} + 6.0$	V	*3
Maximum Clamp Current	I_{CLAMP}	−4.0	+4.0	mA	*5
Total Maximum Clamp Current	$\Sigma\lvert I_{CLAMP}\rvert$	—	40	mA	*5
“L” level maximum output current	I_{OL}	—	15	mA	*4, *6
“L” level average output current	I_{OLAV}	—	4	mA	*4, *7
“L” level maximum overall output current	ΣI_{OL}	—	100	mA	*4
“L” level average overall output current	ΣI_{OLAV}	—	50	mA	*4, *8
“H” level maximum output current	I_{OH}	—	−15	mA	*4, *6
“H” level average output current	I_{OHAV}	—	−4	mA	*4, *7
“H” level maximum overall output current	ΣI_{OH}	—	−100	mA	*4
“H” level average overall output current	ΣI_{OHAV}	—	−50	mA	*4, *8
Power consumption	P_D	—	450	mW	
Operating temperature	T_A	−40	+105	°C	
Storage temperature	T_{STG}	−55	+150	°C	

*1: This parameter is based on $V_{SS} = AV_{SS} = 0$ V

*2: Set AV_{CC} and V_{CC} to the same voltage. Make sure that AV_{CC} does not exceed V_{CC} and that the voltage at the analog inputs does not exceed AV_{CC} when the power is switched on.

*3: V_I and V_O should not exceed $V_{CC} + 0.3$ V. V_I should not exceed the specified ratings. However if the maximum current to/from an input is limited by some means with external components, the I_{CLAMP} rating supersedes the V_I rating.

*4: Applicable to pins: P00 to P07, P10 to P17, P20 to P27, P30 to P37, P40 to P47, P50 to P57, P60 to P67, P70 to P77, P80 to P87, P90 to P97, PA0, PA1

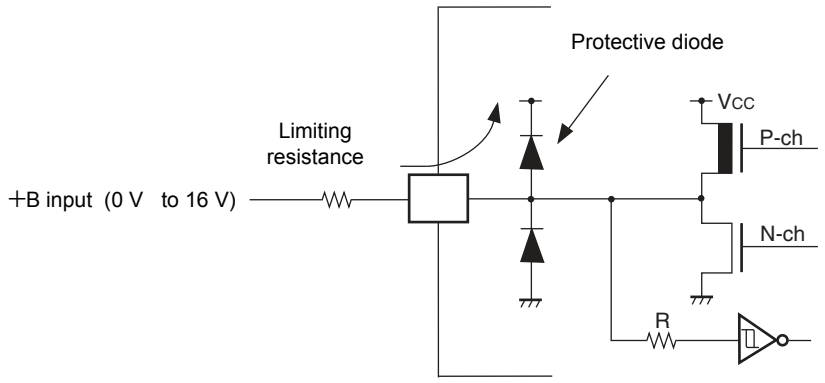
*5:
- Applicable to pins: P00 to P07, P10 to P17, P20 to P27, P30 to P37, P40 to P47, P50 to P57 (Evaluation device : P50 to P55) , P60 to P67, P70 to P77, P80 to P87, P90 to P97, PA0 to PA1
- Use within recommended operating conditions.
- Use with DC voltage (current)
- The +B signal should always be applied by using a limiting resistance placed between the +B signal and the microcontroller.
- The value of the limiting resistance should be set so that when the +B signal is applied, the input current to the microcontroller pin does not exceed the rated value, either instantaneously or for prolonged periods.
- Note that when the microcontroller drive current is low, such as in the power saving modes, the +B input potential may pass through the protective diode and increase the potential at the V_{CC} pin, and this may affect other devices.

(Continued)

(Continued)

- Note that if a +B signal is input when the microcontroller power supply is off (not fixed at 0 V) , the power supply is provided from the pins, so that incomplete operation may result.
- Note that if the +B input is applied during power-on, the power supply is provided from the pins and the resulting supply voltage may not be sufficient to operate the power-on reset.
- Care must be taken not to leave the +B input pin open.
- Sample recommended circuits:

■ Input/output equivalent circuits



*6: The maximum output current is defined as the peak value of the current of any one of the corresponding pins.

*7: The average output current is defined as the value of the average current flowing over 100 ms at any one of the corresponding pins.

*8: The average total output current is defined as the value of the average current flowing over 100 ms at all of the corresponding pins.

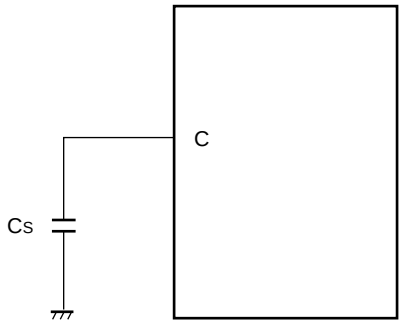
WARNING: Semiconductor devices can be permanently damaged by application of stress (voltage, current, temperature, etc.) in excess of absolute maximum ratings. Do not exceed these ratings.

11.2 Recommended Operating Conditions

(V_{SS} = AV_{SS} = 0 V)

Parameter	Symbol	Value			Unit	Remarks
		Min	Typ	Max		
Power supply voltage	V_{CC}, AV_{CC}	4.0	5.0	5.5	V	Under normal operation
		3.5	5.0	5.5	V	Under normal operation, when not using the A/D converter and not Flash programming.
		4.5	5.0	5.5	V	When External bus is used.
		3.0	—	5.5	V	Maintains RAM data in stop mode
Smoothing capacitor	C_S	0.1	—	1.0	µF	Use a ceramic capacitor or capacitor of better AC characteristics. Capacitor at the V_{CC} should be greater than this capacitor.
Operating temperature	T_A	−40	—	+105	°C	

C Pin Connection Diagram



WARNING: The recommended operating conditions are required in order to ensure the normal operation of the semiconductor device. All of the device's electrical characteristics are warranted when the device is operated within these ranges.

Always use semiconductor devices within their recommended operating condition ranges. Operation outside these ranges may adversely affect reliability and could result in device failure.

No warranty is made with respect to uses, operating conditions, or combinations not represented on the data sheet. Users considering application outside the listed conditions are advised to contact their representatives beforehand.

11.3 DC Characteristics

($T_A = -40°C$ to $+105°C$, $V_{CC} = 5.0\ V \pm 10\%$, $f_{CP} \leq 24$ MHz, $V_{SS} = AV_{SS} = 0\ V$)

Parameter	Symbol	Pin	Condition	Value			Unit	Remarks
				Min	Typ	Max		
Input H voltage (At V_{CC} = 5 V ± 10%)	V_{IHS}	—	—	0.8 V_{CC}	—	V_{CC} + 0.3	V	Port inputs if CMOS hysteresis input levels are selected (except P12, P44, P45, P46, P47, P50, P82, P85)
	V_{IHA}	—	—	0.8 V_{CC}	—	V_{CC} + 0.3	V	Port inputs if Automotive input levels are selected
	V_{IHT}	—	—	2.0	—	V_{CC} + 0.3	V	Port inputs if TTL input levels are selected
	V_{IHS}	—	—	0.7 V_{CC}	—	V_{CC} + 0.3	V	P12, P50, P82, P85 inputs if CMOS input levels are selected
	V_{IHI}	—	—	0.7 V_{CC}	—	V_{CC} + 0.3	V	P44, P45, P46, P47 inputs if CMOS hysteresis input levels are selected
	V_{IHR}	—	—	0.8 V_{CC}	—	V_{CC} + 0.3	V	$\overline{RST}$ input pin (CMOS hysteresis)
	V_{IHM}	—	—	V_{CC} − 0.3	—	V_{CC} + 0.3	V	MD input pin
Input L voltage (At V_{CC} = 5 V ± 10%)	V_{ILS}	—	—	V_{SS} − 0.3	—	0.2 V_{CC}	V	Port inputs if CMOS hysteresis input levels are selected (except P12, P44, P45, P46, P47, P50, P82, P85)
	V_{ILA}	—	—	V_{SS} − 0.3	—	0.5 V_{CC}	V	Port inputs if Automotive input levels are selected
	V_{ILT}	—	—	V_{SS} − 0.3	—	0.8	V	Port inputs if TTL input levels are selected
	V_{ILS}	—	—	V_{SS} − 0.3	—	0.3 V_{CC}	V	P12, P50, P82, P85 inputs if CMOS input levels are selected
	V_{ILI}	—	—	V_{SS} − 0.3	—	0.3 V_{CC}	V	P44, P45, P46, P47 inputs if CMOS hysteresis input levels are selected
	V_{ILR}	—	—	V_{SS} − 0.3	—	0.2 V_{CC}	V	$\overline{RST}$ input pin (CMOS hysteresis)
	V_{ILM}	—	—	V_{SS} − 0.3	—	V_{SS} + 0.3	V	MD input pin
Output H voltage	V_{OH}	Normal outputs	V_{CC} = 4.5 V, I_{OH} = −4.0 mA	V_{CC} − 0.5	—	—	V	
Output H voltage	V_{OHI}	I^2C current outputs	V_{CC} = 4.5 V, I_{OH} = −3.0 mA	V_{CC} − 0.5	—	—	V	
Output L voltage	V_{OL}	Normal outputs	V_{CC} = 4.5 V, I_{OL} = 4.0 mA	—	—	0.4	V	
Output L voltage	V_{OLI}	I^2C current outputs	V_{CC} = 4.5 V, I_{OL} = 3.0 mA	—	—	0.4	V	

(Continued)

(Continued)

(T_A = −40°C to +105°C, V_{CC} = 5.0 V ± 10%, f_{CP} ≤ 24 MHz, V_{SS} = AV_{SS} = 0 V)

Parameter	Symbol	Pin	Condition	Value			Unit	Remarks
				Min	Typ	Max		
Input leak current	I_{IL}	—	V_{CC} = 5.5 V, V_{SS} < V_I < V_{CC}	−1	—	+1	µA	
Pull-up resistance	R_{UP}	P00 to P07, P10 to P17, P20 to P27, P30 to P37, RST	—	25	50	100	kΩ	
Pull-down resistance	R_{DOWN}	MD2	—	25	50	100	kΩ	Except Flash memory devices
Power supply current*	I_{CC}	V_{CC}	V_{CC} = 5.0 V, Internal frequency : 24 MHz, At normal operation.	—	55	70	mA	
			V_{CC} = 5.0 V, Internal frequency : 24 MHz, At writing Flash memory.	—	70	85	mA	Flash memory devices
			V_{CC} = 5.0 V, Internal frequency : 24 MHz, At erasing Flash memory.	—	75	90	mA	Flash memory devices
	I_{CCS}		V_{CC} = 5.0 V, Internal frequency : 24 MHz, In Sleep mode.	—	25	35	mA	
	I_{CTS}		V_{CC} = 5.0 V, Internal frequency : 2 MHz, In Main Timer mode	—	0.3	0.8	mA	
	$I_{CTSPLL6}$		V_{CC} = 5.0 V, Internal frequency : 24 MHz, In PLL Timer mode, external frequency = 4 MHz	—	4	7	mA	
	I_{CCL}		V_{CC} = 5.0 V Internal frequency : 8 kHz, In sub operation T_A = +25°C	—	70	140	µA	
	I_{CCLS}		V_{CC} = 5.0 V Internal frequency : 8 kHz, In sub sleep T_A = +25°C	—	20	50	µA	
	I_{CCT}		V_{CC} = 5.0 V Internal frequency : 8 kHz, In watch mode T_A = +25°C	—	10	35	µA	
	I_{CCH}		V_{CC} = 5.0 V, In Stop mode, T_A = +25°C	—	7	25	µA	
Input capacitance	C_{IN}	Other than C, AV_{CC}, AV_{SS}, AVRH, AVRL, V_{CC}, V_{SS}	—	—	5	15	pF	

* : The power supply current is measured with an external clock.

11.4 AC Characteristics

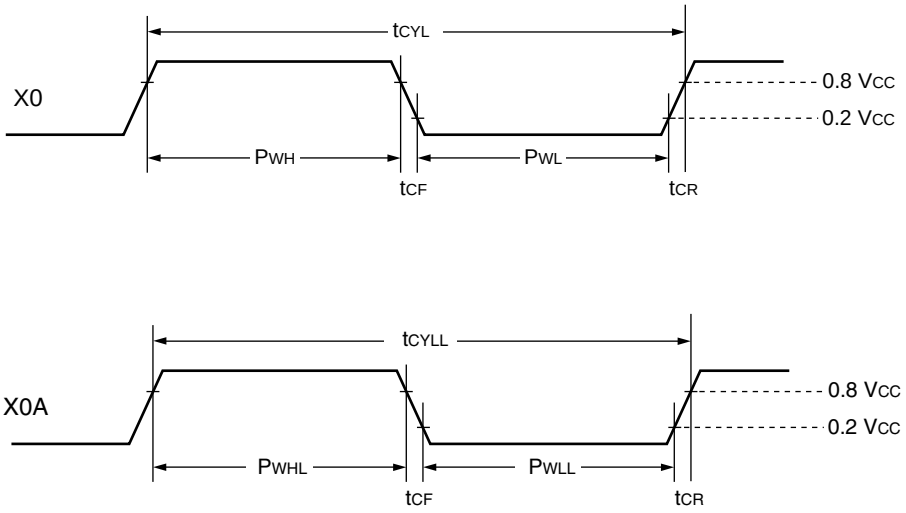
11.4.1 Clock Timing

(T_A = –40°C to +105°C, V_{CC} = 5.0 V ± 10%, f_{CP}≤ 24 MHz, V_{SS} = AV_{SS} = 0 V)

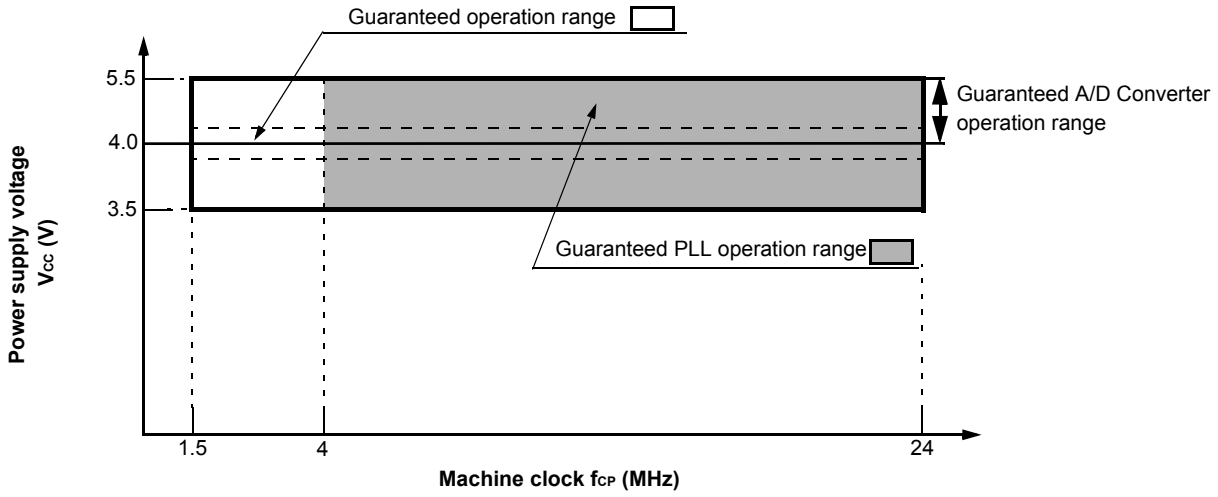
Parameter	Symbol	Pin	Value			Unit	Remarks
			Min	Typ	Max		
Clock frequency	f_C	X0, X1	3	—	16	MHz	When using an oscillation circuit
			4	—	16	MHz	PLL multiplied by 1 When using an oscillation circuit
			4	—	12	MHz	PLL multiplied by 2 When using an oscillation circuit
			4	—	8	MHz	PLL multiplied by 3 When using an oscillation circuit
			4	—	6	MHz	PLL multiplied by 4 When using an oscillation circuit
			—	—	4	MHz	PLL multiplied by 6 When using an oscillation circuit
			3	—	24	MHz	When using an external clock*
	f_{CL}	X0A, X1A	—	32.768	100	kHz	
Clock cycle time	t_{CYL}	X0, X1	62.5	—	333	ns	When using an oscillation circuit
		X0, X1	41.67	—	333	ns	When using an external clock
	t_{CYLL}	X0A, X1A	10	30.5	—	µs	
Input clock pulse width	P_{WH}, P_{WL}	X0	10	—	—	ns	Duty ratio is about 30% to 70%.
	P_{WHL}, P_{WLL}	X0A	5	15.2	—	µs	
Input clock rise and fall time	t_{CR}, t_{CF}	X0	—	—	5	ns	When using external clock
Internal operating clock frequency (machine clock)	f_{CP}	—	1.5	—	24	MHz	When using main clock
	f_{CPL}	—	—	8.192	50	kHz	When using sub clock
Internal operating clock cycle time (machine clock)	t_{CP}	—	41.67	—	666	ns	When using main clock
	t_{CPL}	—	20	122.1	—	µs	When using sub clock

* : When selecting the PLL clock, the range of clock frequency is limited. Use this product within the range as mentioned in “Relation between the external clock frequency and machine clock frequency”.

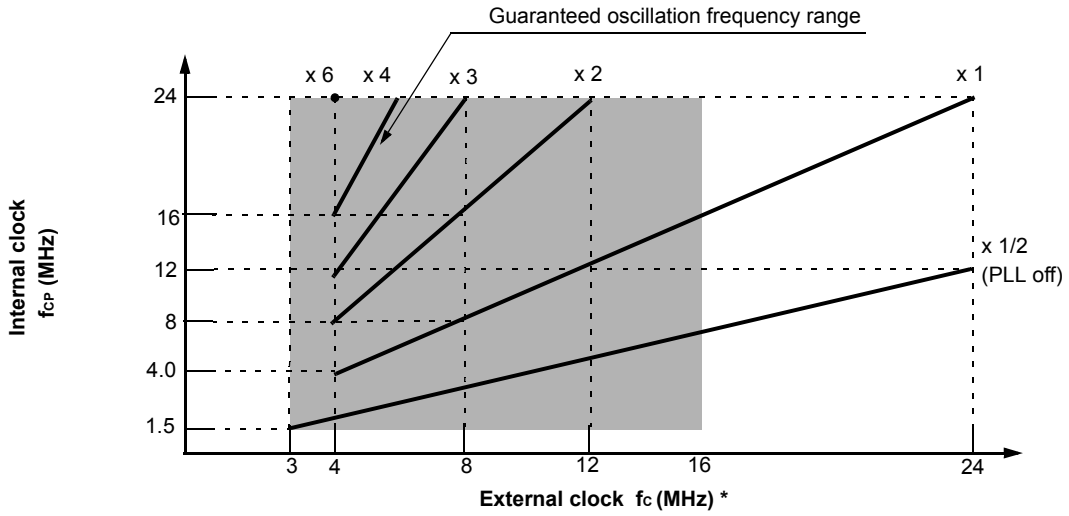
Clock Timing



Guaranteed PLL operation range



Guaranteed operation range of MB90340E series



* : When using a crystal oscillator or ceramic oscillator, the maximum oscillation clock frequency is 16 MHz

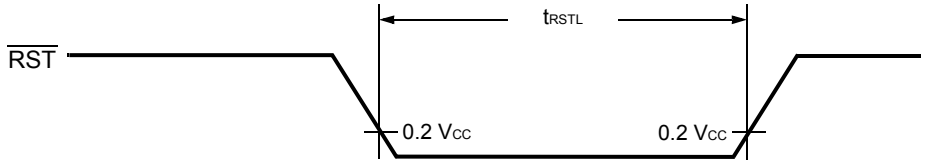
11.4.2 Reset Standby Input

(T_A = −40°C to +105°C, V_{CC} = 5.0 V ± 10%, f_{CP} ≤ 24 MHz, V_{SS} = AV_{SS} = 0.0 V)

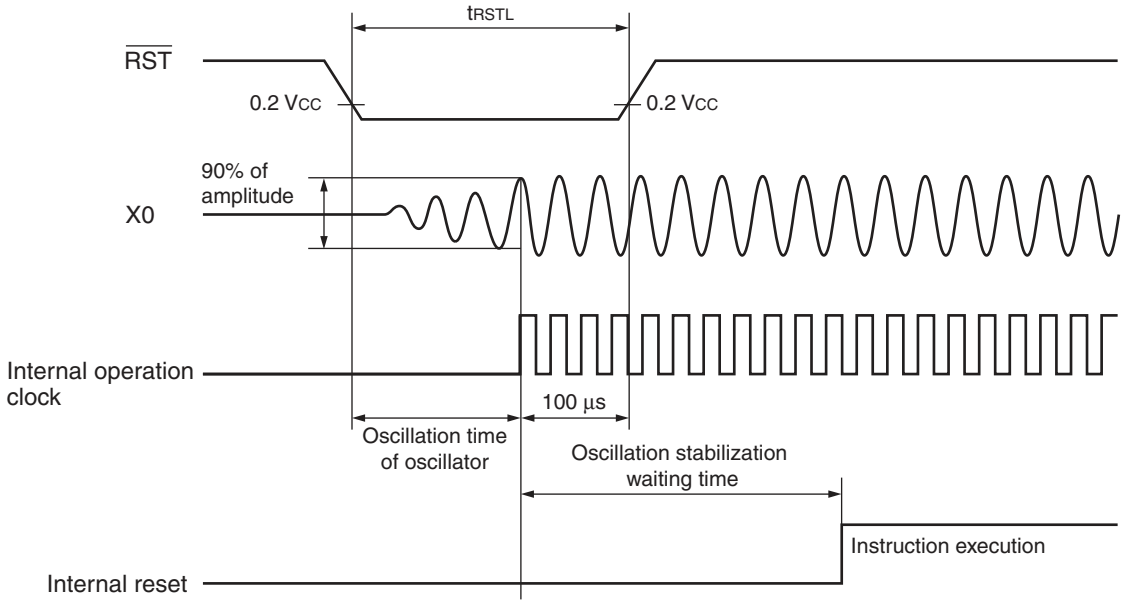
Parameter	Symbol	Pin	Value		Unit	Remarks
			Min	Max		
Reset input time	t_{RSTL}	$\overline{RST}$	500	—	ns	Under normal operation
			Oscillation time of oscillator* + 100 µs	—	µs	In Stop mode, Sub Clock mode, Sub Sleep mode and Watch mode
			100	—	µs	In Time Timer mode

* : The oscillation time of the oscillator is the time it takes for the amplitude of the oscillations to reach 90%. For crystal oscillators, this time is between several ms and several tens of ms, for ceramic oscillators the time is between several hundred µs and several ms, and for an external clock, the time is 0 ms.

- **Under normal operation:**



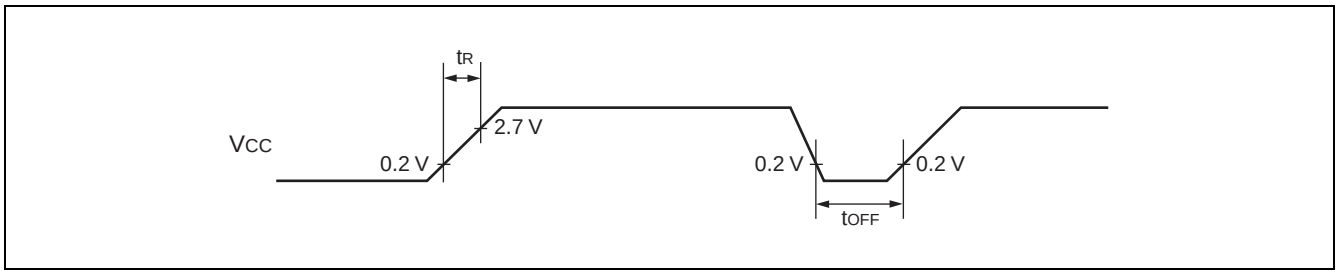
- **In Stop mode, Sub Clock mode, Sub Sleep mode, Watch mode:**



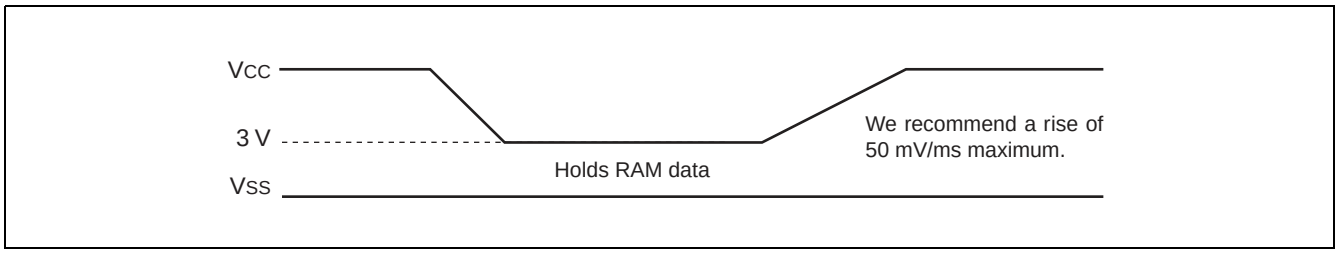
11.4.3 Power On Reset

(T_A = −40°C to +105°C, V_{CC} = 5.0 V ± 10%, f_{CP} ≤ 24 MHz, V_{SS} = AV_{SS} = 0.0 V)

Parameter	Symbol	Pin	Condition	Value		Unit	Remarks
				Min	Max		
Power on rise time	t_R	V_{CC}	—	0.05	30	ms	
Power off time	t_{OFF}	V_{CC}		1	—	ms	Waiting time until power-on



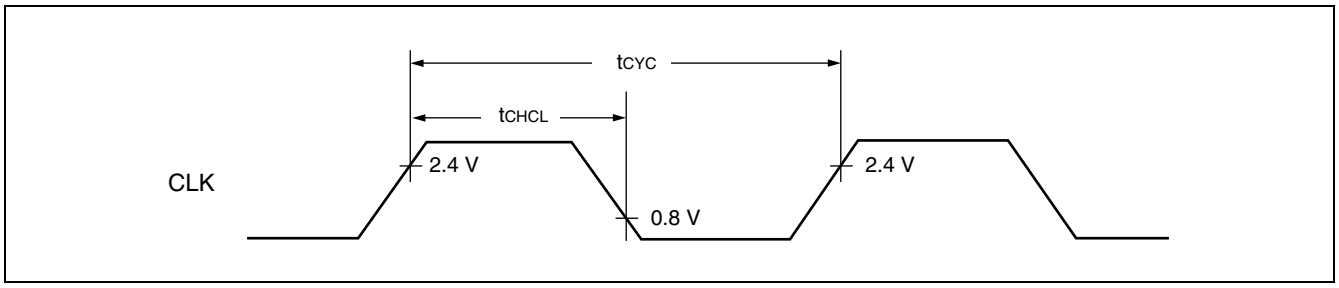
Note: : If you change the power supply voltage too rapidly, a power on reset may occur. We recommend that you startup smoothly by restraining voltages when changing the power supply voltage during operation, as shown in the figure below. Perform while not using the PLL clock. However, if voltage drops are within 1 V/s, you can operate while using the PLL clock.



11.4.4 Clock Output Timing

(T_A = −40°C to +105°C, V_{CC} = 5.0 V ± 10%, V_{SS} = 0.0 V, f_{CP} ≤ 24 MHz)

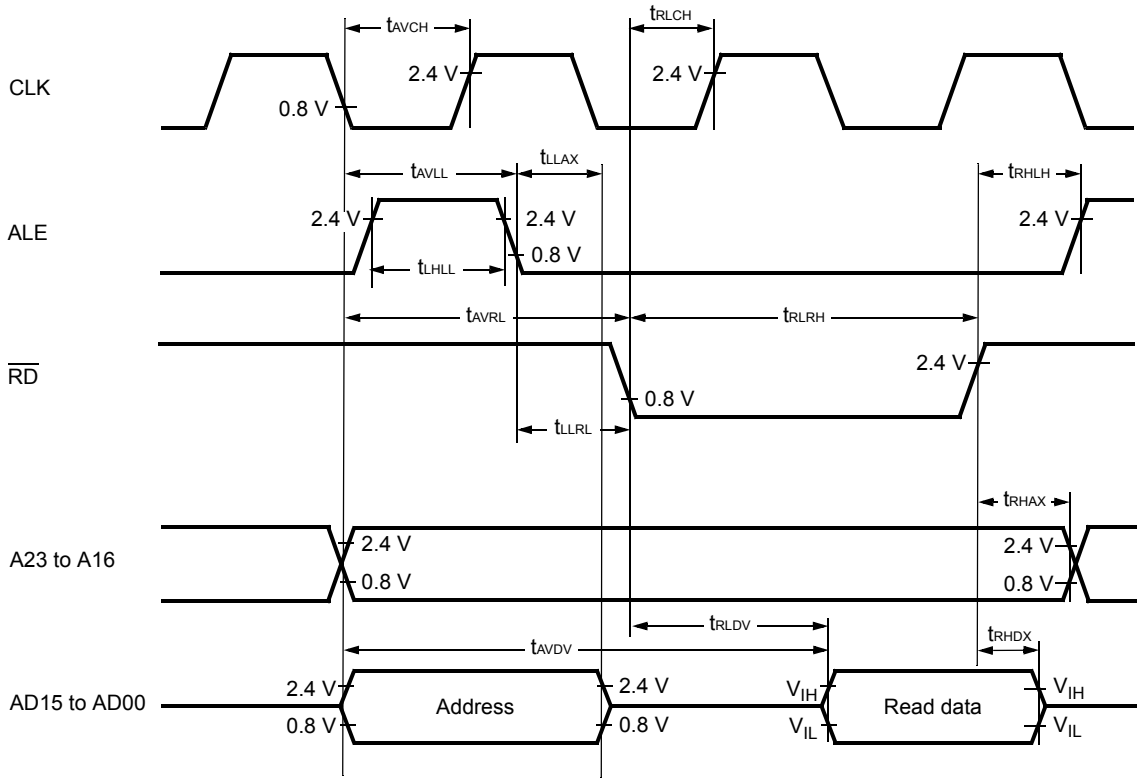
Parameter	Symbol	Pin	Condition	Value		Unit	Remarks
				Min	Max		
Cycle time	t_{CYC}	CLK	—	62.5	—	ns	f_{CP} = 16 MHz
				41.67	—	ns	f_{CP} = 24 MHz
CLK ↑ → CLK ↓	t_{CHCL}	CLK	—	20	—	ns	f_{CP} = 16 MHz
				13	—	ns	f_{CP} = 24 MHz


tCYC
tCHCL
CLK
2.4 V
2.4 V
0.8 V

11.4.5 Bus Timing (Read)

(T_A = −40°C to +105°C, V_{CC} = 5.0 V ± 10%, V_{SS} = 0.0 V, f_{CP} ≤ 24 MHz)

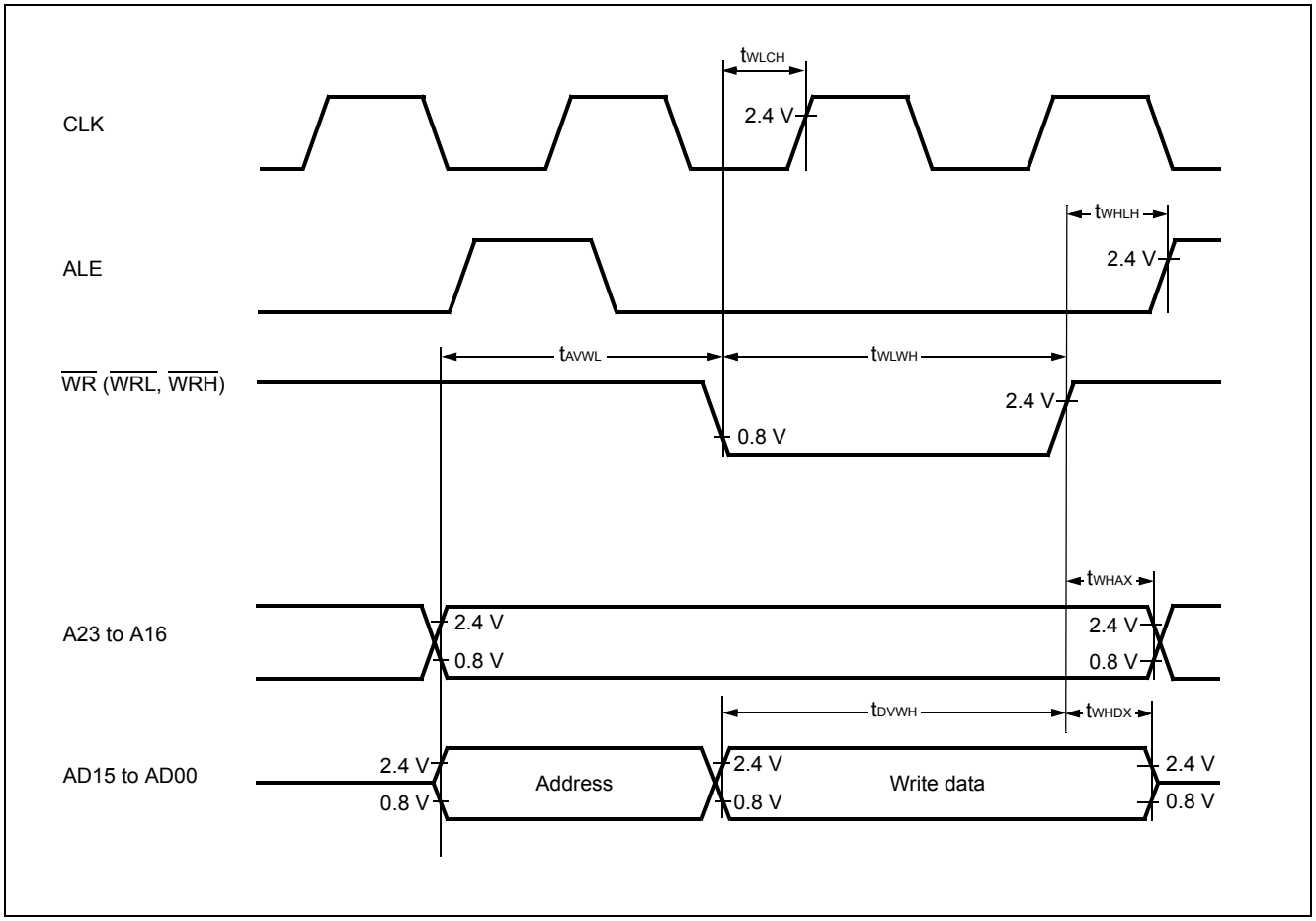
Parameter	Symbol	Pin	Condition	Value		Unit
				Min	Max	
ALE pulse width	t_{LHLL}	ALE		$t_{CP}/2 - 10$	—	ns
Valid address → ALE ↓ time	t_{AVLL}	ALE, A23 to A16, AD15 to AD00		$t_{CP}/2 - 20$	—	ns
ALE ↓ → Address valid time	t_{LLAX}	ALE, AD15 to AD00		$t_{CP}/2 - 15$	—	ns
Valid address → $\overline{RD}$ ↓ time	t_{AVRL}	A23 to A16, AD15 to AD00, $\overline{RD}$		$t_{CP} - 15$	—	ns
Valid address → Valid data input	t_{AVDV}	A23 to A16, AD15 to AD00		—	$5\ t_{CP}/2 - 60$	ns
$\overline{RD}$ pulse width	t_{RLRH}	$\overline{RD}$	—	$3\ t_{CP}/2 - 20$	—	ns
$\overline{RD}$ ↓ → Valid data input	t_{RLDV}	$\overline{RD}$, AD15 to AD00		—	$3\ t_{CP}/2 - 50$	ns
$\overline{RD}$ ↑ → Data hold time	t_{RHDX}	$\overline{RD}$, AD15 to AD00		0	—	ns
$\overline{RD}$ ↑ → ALE ↑ time	t_{RHLH}	$\overline{RD}$, ALE		$t_{CP}/2 - 15$	—	ns
$\overline{RD}$ ↑ → Address valid time	t_{RHAX}	$\overline{RD}$, A23 to A16		$t_{CP}/2 - 10$	—	ns
Valid address → CLK ↑ time	t_{AVCH}	A23 to A16, AD15 to AD00, CLK		$t_{CP}/2 - 16$	—	ns
$\overline{RD}$ ↓ → CLK ↑ time	t_{RLCH}	$\overline{RD}$, CLK		$t_{CP}/2 - 15$	—	ns
ALE ↓ → $\overline{RD}$ ↓ time	t_{LLRL}	ALE, $\overline{RD}$		$t_{CP}/2 - 15$	—	ns



11.4.6 Bus Timing (Write)

(T_A = −40°C to +105°C, V_{CC} = 5.0 V ± 10%, V_{SS} = 0.0 V, f_{CP} ≤ 24 MHz)

Parameter	Symbol	Pin	Condition	Value		Unit
				Min	Max	
Valid address → $\overline{WR}$ ↓ time	t_{AVWL}	A23 to A16, AD15 to AD00, $\overline{WR}$		t_{CP}−15	—	ns
$\overline{WR}$ pulse width	t_{WLWH}	$\overline{WR}$		3 t_{CP}/2 − 20	—	ns
Valid data output → $\overline{WR}$ ↑ time	t_{DVWH}	AD15 to AD00, $\overline{WR}$		3 t_{CP}/2 − 20	—	ns
$\overline{WR}$ ↑ → Data hold time	t_{WHDX}	AD15 to AD00, $\overline{WR}$	—	15	—	ns
$\overline{WR}$ ↑ → Address valid time	t_{WHAX}	A23 to A16, $\overline{WR}$		t_{CP}/2 − 10	—	ns
$\overline{WR}$ ↑ → ALE ↑ time	t_{WHLH}	$\overline{WR}$, ALE		t_{CP}/2 − 15	—	ns
$\overline{WR}$ ↓ → CLK ↑ time	t_{WLCH}	$\overline{WR}$, CLK		t_{CP}/2 − 15	—	ns

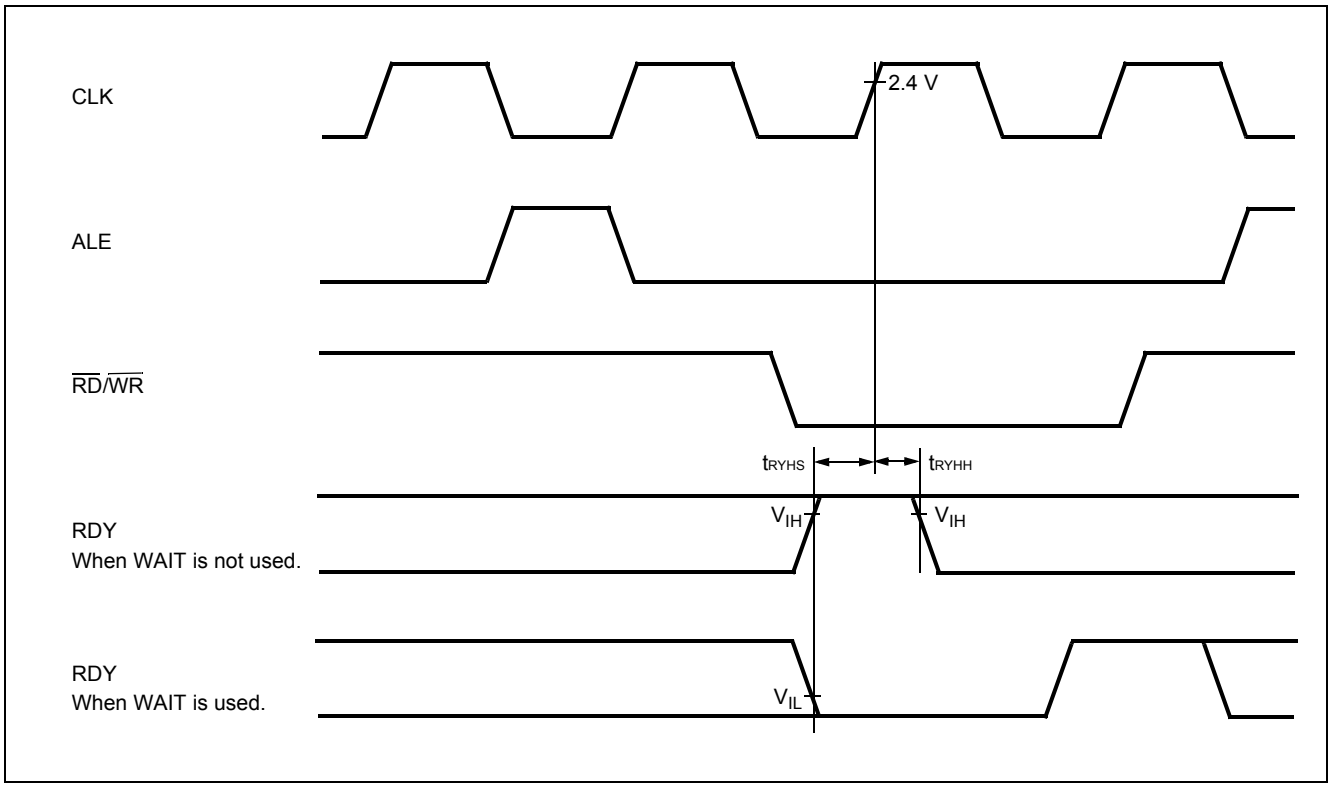


11.4.7 Ready Input Timing

(T_A = −40°C to +105°C, V_{CC} = 5.0 V ± 10%, V_{SS} = 0.0 V, f_{CP} ≤ 24 MHz)

Parameter	Symbol	Pin	Test Condition	Rated Value		Unit	Remarks
				Min	Max		
RDY setup time	t_{RYHS}	RDY	—	45	—	ns	f_{CP} = 16 MHz
				32	—	ns	f_{CP} = 24 MHz
RDY hold time	t_{RYHH}	RDY		0	—	ns	

Note: : If the RDY setup time is insufficient, use the auto-ready function.

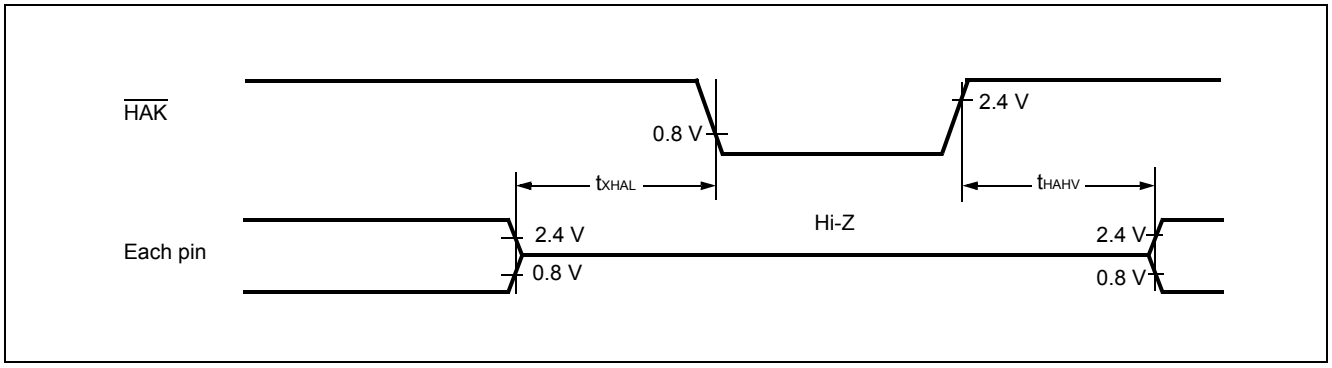


11.4.8 Hold Timing

($T_A = -40°C$ to $+105°C$, $V_{CC} = 5.0\ V \pm 10\%$, $V_{SS} = 0.0\ V$, $f_{CP} \leq 24$ MHz)

Parameter	Symbol	Pin	Condition	Value		Unit
				Min	Max	
Pin floating → $\overline{HAK}$ ↓ time	t_{XHAL}	$\overline{HAK}$	—	30	t_{CP}	ns
$\overline{HAK}$ ↑ time → Pin valid time	t_{HAHV}	$\overline{HAK}$		t_{CP}	2 t_{CP}	ns

Note: : There is more than 1 cycle from when HRQ reads in until the $\overline{HAK}$ is changed.



11.4.9 LIN-UART0/1/2/3

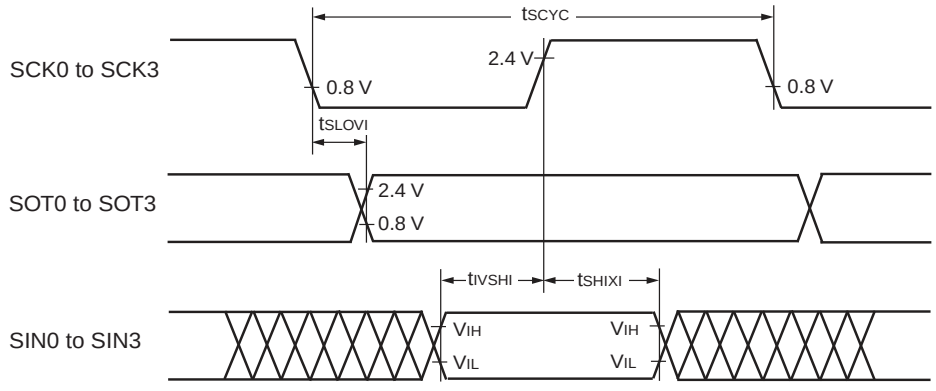
■ **Bit setting: ESCR:SCES = 0, ECCR:SCDE = 0**

(T_A = −40°C to +105°C, V_{CC} = 5.0 V ± 10%, f_{CP} ≤ 24 MHz, V_{SS} = 0 V)

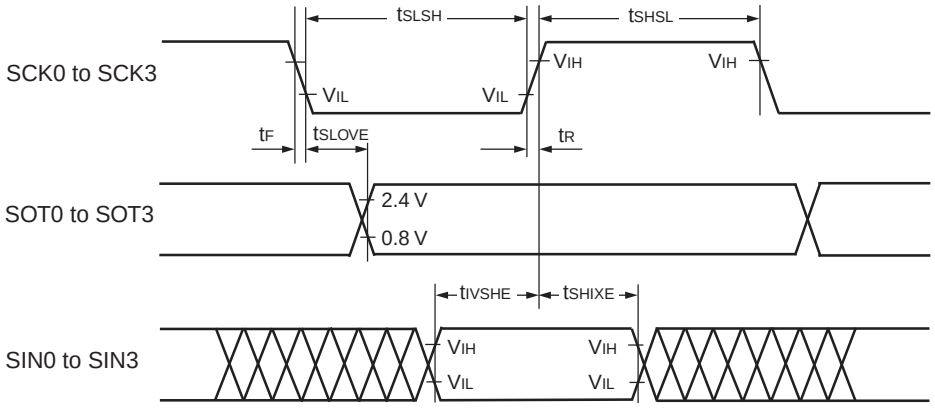
Parameter	Symbol	Pin	Condition	Value		Unit
				Min	Max	
Serial clock cycle time	t_{SCYC}	SCK0 to SCK3	Internal shift clock mode output pins are C_L = 80 pF + 1 TTL.	5 t_{CP}	—	ns
SCK ↓ → SOT delay time	t_{SLOVI}	SCK0 to SCK3, SOT0 to SOT3		−50	+50	ns
Valid SIN → SCK ↑	t_{IVSHI}	SCK0 to SCK3, SIN0 to SIN3		t_{CP} + 80	—	ns
SCK ↑ → Valid SIN hold time	t_{SHIXI}	SCK0 to SCK3, SIN0 to SIN3		0	—	ns
Serial clock “L” pulse width	t_{SHSL}	SCK0 to SCK3	External shift clock mode output pins are C_L = 80 pF + 1 TTL.	3 t_{CP} - t_R	—	ns
Serial clock “H” pulse width	t_{SLSH}	SCK0 to SCK3		t_{CP} + 10	—	ns
SCK ↓ → SOT delay time	t_{SLOVE}	SCK0 to SCK3, SOT0 to SOT3		—	2 t_{CP} + 60	ns
Valid SIN → SCK ↑	t_{IVSHE}	SCK0 to SCK3, SIN0 to SIN3		30	—	ns
SCK ↑ → Valid SIN hold time	t_{SHIXE}	SCK0, SCK1, SIN0 to SIN3		t_{CP} + 30	—	ns
SCK fall time	t_F	SCK0 to SCK3		—	10	ns
SCK rise time	t_R	SCK0 to SCK3		—	10	ns

Note:
- AC characteristic in CLK synchronized mode.
- C_L is load capacity value of pins when testing.
- t_{CP} is internal operating clock cycle time (machine clock) . Refer to “ (1) Clock Timing”.

- Internal Shift Clock Mode



- External Shift Clock Mode



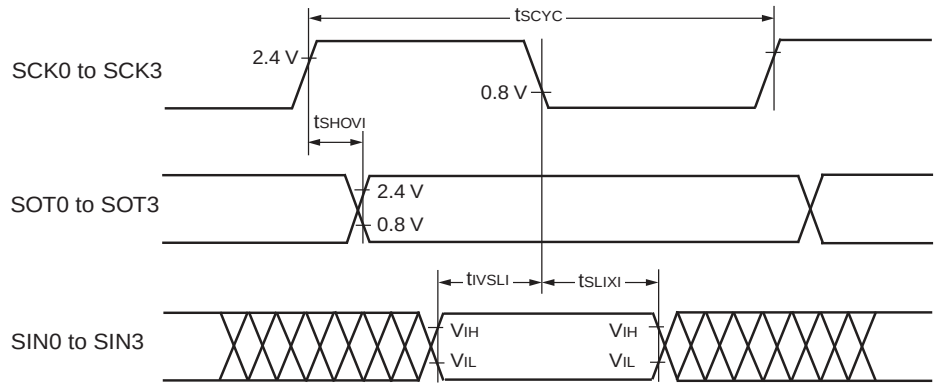
■ **Bit setting: ESCR:SCES = 1, ECCR:SCDE = 0**

(T_A = −40°C to +105°C, V_{CC} = 5.0 V ± 10%, f_{CP} ≤ 24 MHz, V_{SS} = 0 V)

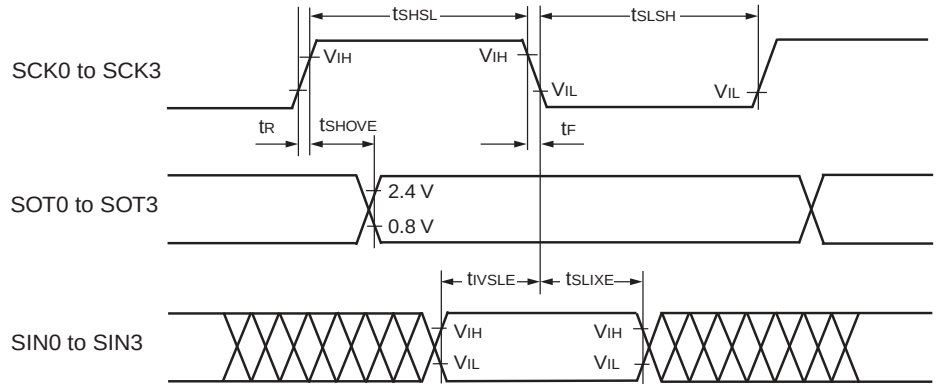
Parameter	Symbol	Pin	Condition	Value		Unit
				Min	Max	
Serial clock cycle time	t_{SCYC}	SCK0 to SCK3	Internal shift clock mode output pins are C_L = 80 pF + 1 TTL.	5 t_{CP}	—	ns
SCK ↑ → SOT delay time	t_{SHOVI}	SCK0 to SCK3, SOT0 to SOT3		−50	+50	ns
Valid SIN → SCK ↓	t_{IVSLI}	SCK0 to SCK3, SIN0 to SIN3		t_{CP} + 80	—	ns
SCK ↓ → Valid SIN hold time	t_{SLIXI}	SCK0 to SCK3, SIN0 to SIN3		0	—	ns
Serial clock “H” pulse width	t_{SHSL}	SCK0 to SCK3	External shift clock mode output pins are C_L = 80 pF + 1 TTL.	3 t_{CP} - t_R	—	ns
Serial clock “L” pulse width	t_{SLSH}	SCK0 to SCK3		t_{CP} + 10	—	ns
SCK ↑ → SOT delay time	t_{SHOVE}	SCK0 to SCK3, SOT0 to SOT3		—	2 t_{CP} + 60	ns
Valid SIN → SCK ↓	t_{IVSLE}	SCK0 to SCK3, SIN0 to SIN3		30	—	ns
SCK ↓ → Valid SIN hold time	t_{SLIXE}	SCK0 to SCK3, SIN0 to SIN3		t_{CP} + 30	—	ns
SCK fall time	t_F	SCK0 to SCK3		—	10	ns
SCK rise time	t_R	SCK0 to SCK3		—	10	ns

Note:
- C_L is load capacity value of pins when testing.
- t_{CP} is internal operating clock cycle time (machine clock) . Refer to “Clock Timing”.

- Internal Shift Clock Mode



- External Shift Clock Mode

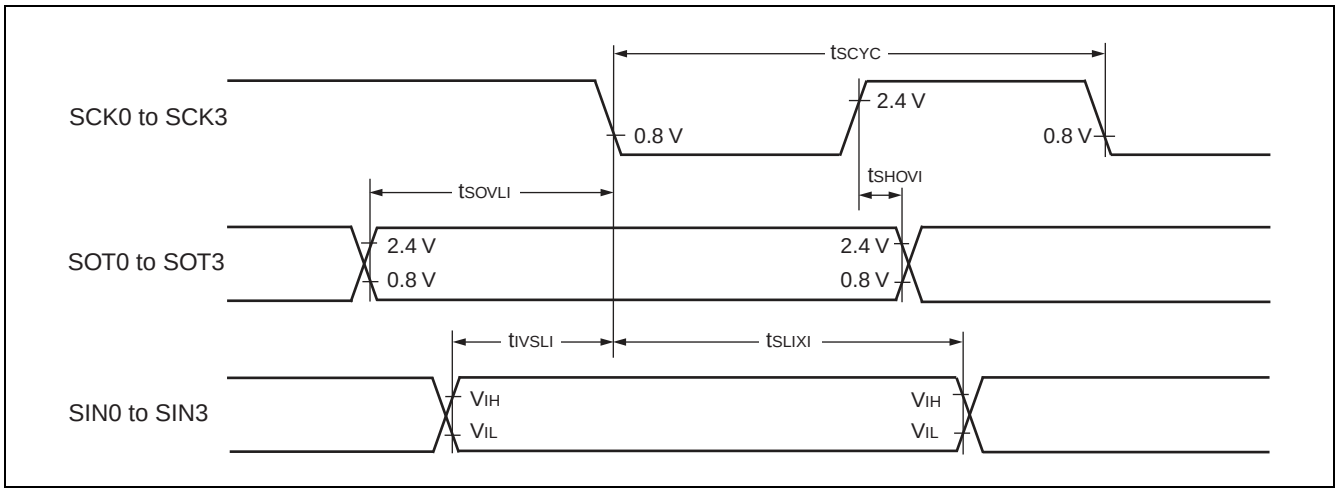


■ **Bit setting: ESCR:SCES = 0, ECCR:SCDE = 1**

(T_A = −40°C to +105°C, V_{CC} = 5.0 V ± 10%, f_{CP} ≤ 24 MHz, V_{SS} = 0 V)

Parameter	Symbol	Pin	Condition	Value		Unit
				Min	Max	
Serial clock cycle time	t_{SCYC}	SCK0 to SCK3	Internal clock operation output pins are C_L = 80 pF + 1 TTL.	5 t_{CP}	—	ns
SCK ↑ → SOT delay time	t_{SHOVI}	SCK0 to SCK3, SOT0 to SOT3		−50	+50	ns
Valid SIN → SCK ↓	t_{IVSLI}	SCK0 to SCK3, SIN0 to SIN3		t_{CP} + 80	—	ns
SCK ↓ → Valid SIN hold time	t_{SLIXI}	SCK0 to SCK3, SIN0 to SIN3		0	—	ns
SOT → SCK ↓ delay time	t_{SOVLI}	SCK0 to SCK3, SOT0 to SOT3		3 t_{CP} − 70	—	ns

Note:
- C_L is load capacity value of pins when testing.
- t_{CP} is internal operating clock cycle time (machine clock) . Refer to "Clock Timing".

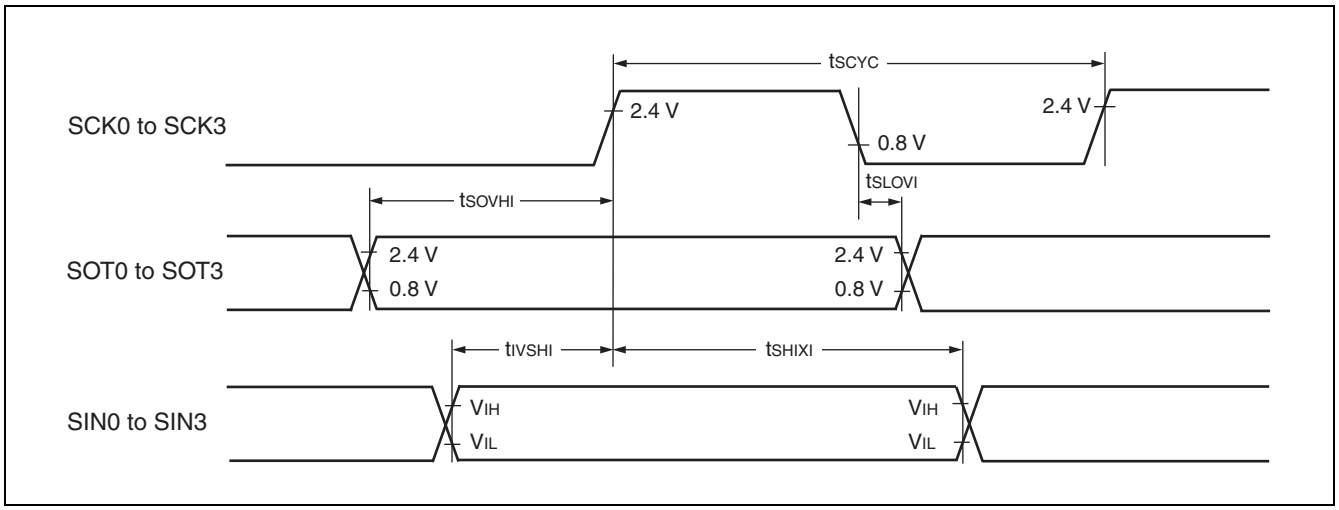


■ **Bit setting: ESCR:SCES = 1, ECCR:SCDE = 1**

(T_A = −40°C to +105°C, V_{CC} = 5.0 V ± 10%, f_{CP} ≤ 24 MHz, V_{SS} = 0 V)

Parameter	Symbol	Pin	Condition	Value		Unit
				Min	Max	
Serial clock cycle time	t_{SCYC}	SCK0 to SCK3	Internal clock operation output pins are C_L = 80 pF + 1 TTL.	5 t_{CP}	—	ns
SCK ↓ → SOT delay time	t_{SLOVI}	SCK0 to SCK3, SOT0 to SOT3		−50	+50	ns
Valid SIN → SCK ↑	t_{IVSHI}	SCK0 to SCK3, SIN0 to SIN3		t_{CP} + 80	—	ns
SCK ↑ → Valid SIN hold time	t_{SHIXI}	SCK0 to SCK3, SIN0 to SIN3		0	—	ns
SOT → SCK ↑ delay time	t_{SOVHI}	SCK0 to SCK3, SOT0 to SOT3		3 t_{CP} − 70	—	ns

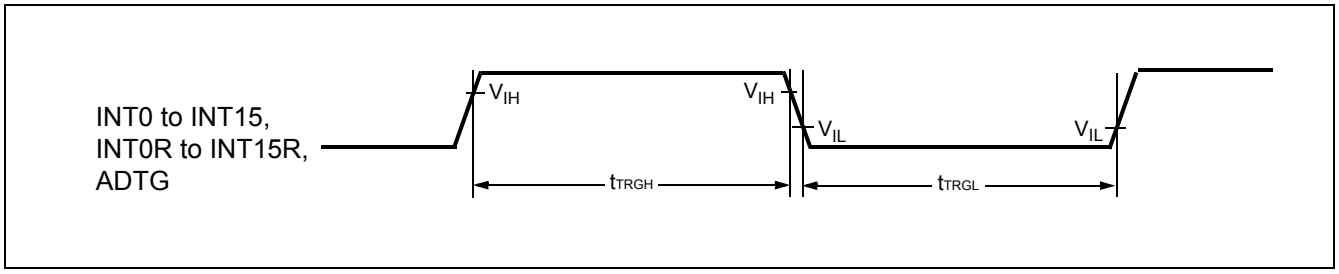
Note:
- C_L is load capacity value of pins when testing.
- t_{CP} is internal operating clock cycle time (machine clock) . Refer to "Clock Timing".



11.4.10 Trigger Input Timing

(T_A = −40°C to +105°C, V_{CC} = 5.0 V ± 10%, f_{CP} ≤ 24 MHz, V_{SS} = 0.0 V)

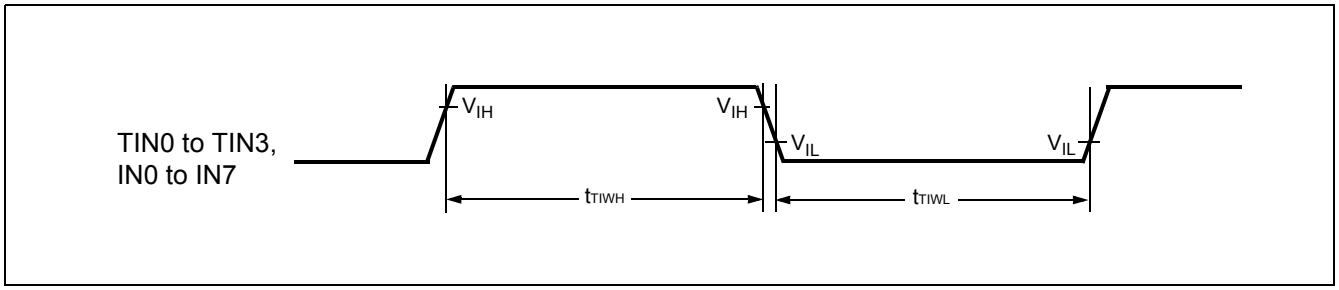
Parameter	Symbol	Pin	Condition	Value		Unit
				Min	Max	
Input pulse width	t_{TRGH} t_{TRGL}	INT0 to INT15, INT0R to INT15R, ADTG	—	5 t_{CP}	—	ns



11.4.11 Timer Related Resource Input Timing

(T_A = –40°C to +105°C, V_{CC} = 5.0 V ± 10%, f_{CP} ≤ 24 MHz, V_{SS} = 0 V)

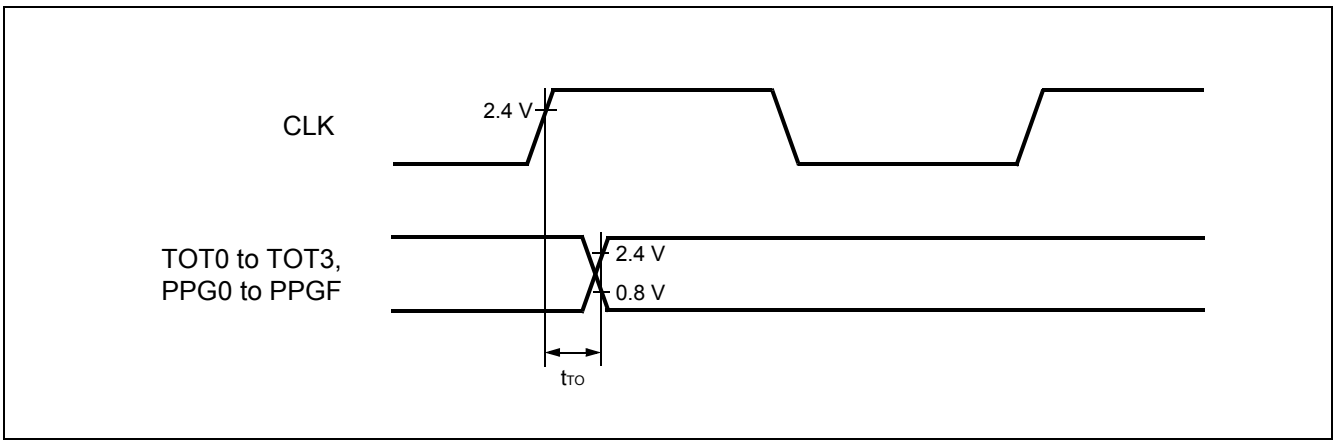
Parameter	Symbol	Pin	Condition	Value		Unit
				Min	Max	
Input pulse width	t_{TIWH} t_{TIWL}	TIN0 to TIN3, IN0 to IN7	—	4 t_{CP}	—	ns



11.4.12 Timer Related Resource Output Timing

(T_A = –40°C to +105°C, V_{CC} = 5.0 V ± 10%, f_{CP} ≤ 24 MHz, V_{SS} = 0.0 V)

Parameter	Symbol	Pin	Condition	Value		Unit
				Min	Max	
CLK ↑ → T_{OUT} change time	t_{TO}	TOT0 to TOT3, PPG0 to PPGF	—	30	—	ns



11.4.13 I^2C Timing

(T_A = –40°C to +105°C, V_{CC} = 5.0 V ± 10%, V_{SS} = 0.0 V)

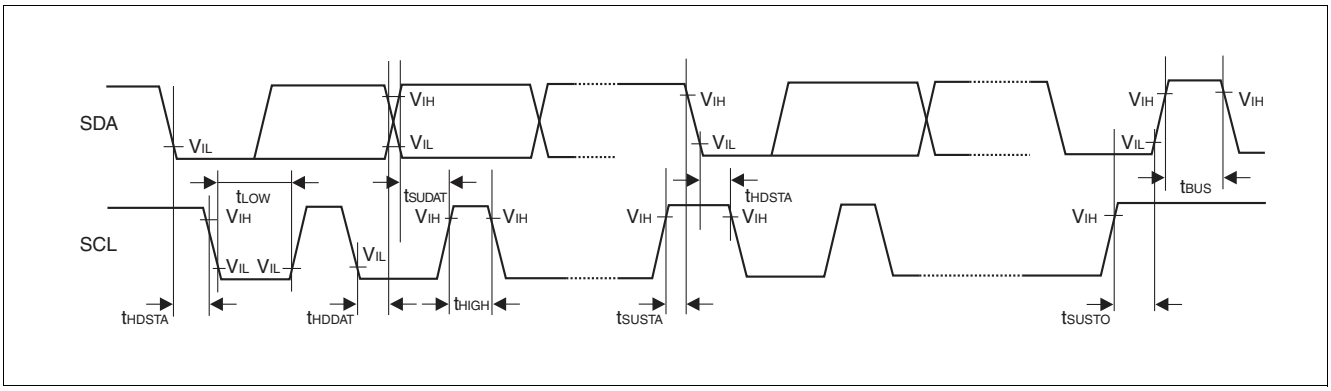
Parameter	Symbol	Condition	Standard-mode		Fast-mode*1		Unit
			Min	Max	Min	Max	
SCL clock frequency	f_{SCL}	R = 1.7 kΩ, C = 50 pF*2	0	100	0	400	kHz
Hold time (repeated) START condition SDA↓ → SCL ↓	t_{HDSTA}		4.0	—	0.6	—	µs
"L" width of the SCL clock	t_{LOW}		4.7	—	1.3	—	µs
"H" width of the SCL clock	t_{HIGH}		4.0	—	0.6	—	µs
Set-up time (repeated) START condition SCL ↑ → SDA ↓	t_{SUSTA}		4.7	—	0.6	—	µs
Data hold time SCL ↓ → SDA ↓ ↑	t_{HDDAT}		0	3.45*3	0	0.9*4	µs
Data set-up time SDA ↓ ↑ → SCL ↑	t_{SUDAT}		250	—	100	—	ns
Set-up time for STOP condition SCL ↑ → SDA ↑	t_{SUSTO}		4.0	—	0.6	—	µs
Bus free time between a STOP and START condition	t_{BUS}		4.7	—	1.3	—	µs

*1:For use at over 100 kHz, set the machine clock to at least 6 MHz.

*2:R,C: Pull-up resistor and load capacitor of the SCL and SDA lines.

*3:The maximum t_{HDDAT} meets the requirement that it does not extend the "L" width (t_{LOW}) of the SCL signal.

*4:A Fast-mode I^2C-bus device can be used in a Standard-mode I^2C-bus system, but the requirement $t_{SUDAT} \geq 250$ ns must then be met.



11.5 A/D Converter

(T_A = −40°C to +105°C, 3.0 V≤ AVRH − AVRL, V_{CC} = AV_{CC} = 5.0 V ± 10%, f_{CP}≤ 24 MHz, V_{SS} = AV_{SS} = 0 V)

Parameter	Symbol	Pin	Value			Unit	Remarks
			Min	Typ	Max		
Resolution	—	—	—	—	10	bit	
Total error	—	—	—	—	±3.0	LSB	
Nonlinearity error	—	—	—	—	±2.5	LSB	
Differential nonlinearity error	—	—	—	—	±1.9	LSB	
Zero reading voltage	V_{OT}	AN0 to AN23	AVRL − 1.5 × LSB	AVRL + 0.5 × LSB	AVRL + 2.5 × LSB	V	
Full scale reading voltage	V_{FST}	AN0 to AN23	AVRH − 3.5 × LSB	AVRH − 1.5 × LSB	AVRH + 0.5 × LSB	V	
Compare time	—	—	1.0	—	16500	µs	4.5 V≤ AV_{CC}≤ 5.5 V
			2.0				4.0 V≤ AV_{CC} < 4.5 V
Sampling time	—	—	0.5	—	∞	µs	4.5 V≤ AV_{CC}≤ 5.5 V
			1.2				4.0 V≤ AV_{CC} < 4.5 V
Analog port input current	I_{AIN}	AN0 to AN23	−0.3	—	+0.3	µA	
Analog input voltage range	V_{AIN}	AN0 to AN23	AVRL	—	AVRH	V	
Reference voltage range	—	AVRH	AVRL + 2.7	—	AV_{CC}	V	
	—	AVRL	0	—	AVRH − 2.7	V	
Power supply current	I_A	AV_{CC}	—	3.5	7.5	mA	
	I_{AH}	AV_{CC}	—	—	5	µA	*
Reference voltage current	I_R	AVRH	—	600	900	µA	
	I_{RH}	AVRH	—	—	5	µA	*
Offset between input channels	—	AN0 to AN23	—	—	4	LSB	

*: If the A/D convertor is not operating, a current when CPU is stopped is applicable (V_{CC} = AV_{CC} = AVRH = 5.0 V) .

Note: : The accuracy gets worse as |AVRH − AVRL| becomes smaller.

11.6 Definition of A/D Converter Terms

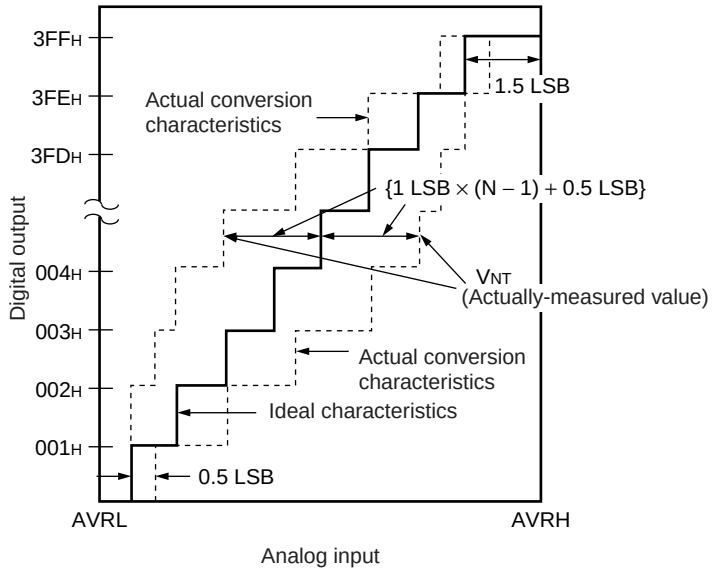
Resolution : Analog variation that is recognized by the A/D converter.

Non linearity error : The deviation between the actual conversion characteristics and a line that joins the zero-transition line (“00 0000 0000” ← → “00 0000 0001”) to the full-scale transition line (“11 1111 1110” ← → “11 1111 1111”) .

Differential linearity error : Deviation of input voltage, which is required for changing output code by 1 LSB, from an ideal value.

Total error : Difference between the actual value and the ideal value. The total error includes zero transition error, full-scale transition error, and linear error.

Total error



$$\text{Total error of digital output “N”} = \frac{V_{NT} - \{1\ \text{LSB} \times (N - 1) + 0.5\ \text{LSB}\}}{1\ \text{LSB}}\ [\text{LSB}]$$

$$1\ \text{LSB (Ideal value)} = \frac{\text{AVRH} - \text{AVRL}}{1024}\ [\text{V}]$$

N : Value of the digital output from the A/D converter

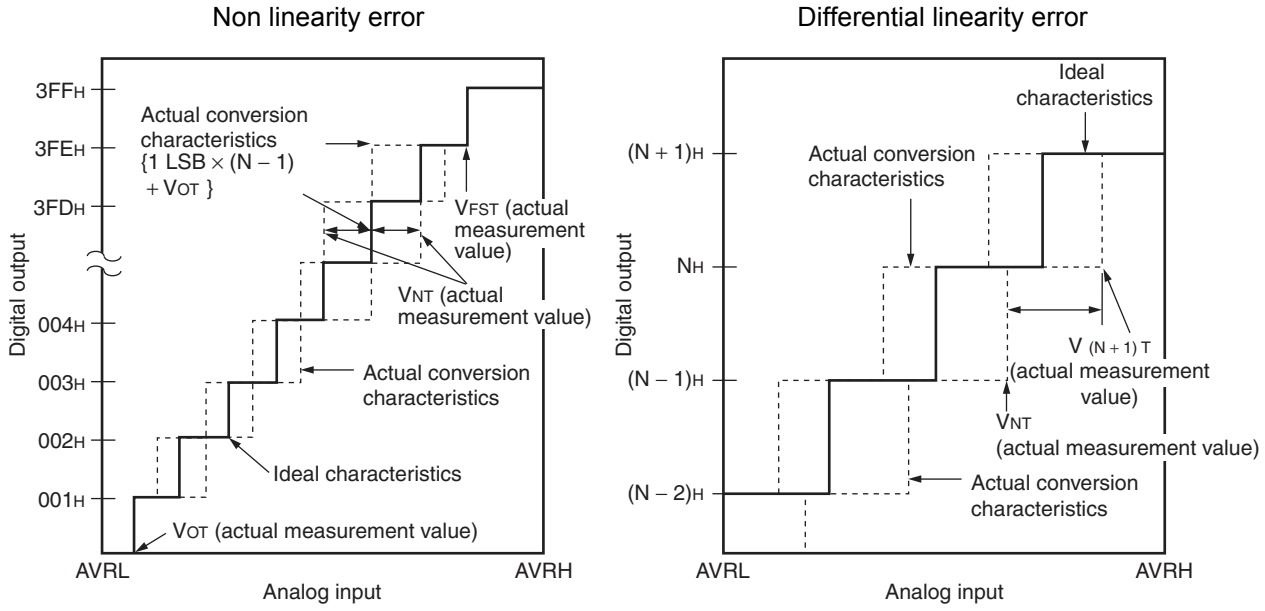
V_{OT} (Ideal value) = AVRL + 0.5 LSB [V]

V_{FST} (Ideal value) = AVRH − 1.5 LSB [V]

V_{NT} : A voltage at which the digital output transitions from $(N - 1)_H$ to N_H.

(Continued)

(Continued)



$$\text{Non linearity error of digital output N} = \frac{V_{NT} - \{1\ \text{LSB} \times (N - 1) + V_{OT}\}}{1\ \text{LSB}}\ [\text{LSB}]$$

$$\text{Differential linearity error of digital output N} = \frac{V_{(N+1)T} - V_{NT}}{1\ \text{LSB}} - 1\ \text{LSB}\ [\text{LSB}]$$

$$1\ \text{LSB} = \frac{V_{FST} - V_{OT}}{1022}\ [\text{V}]$$

N : Value of the digital output from the A/D converter
V_{OT} : Voltage at which digital output transits from "000_H" to "001_H."
V_{FST} : Voltage at which digital output transits from "$3FE_H$" to "$3FF_H$."

11.7 Notes on A/D Converter Section

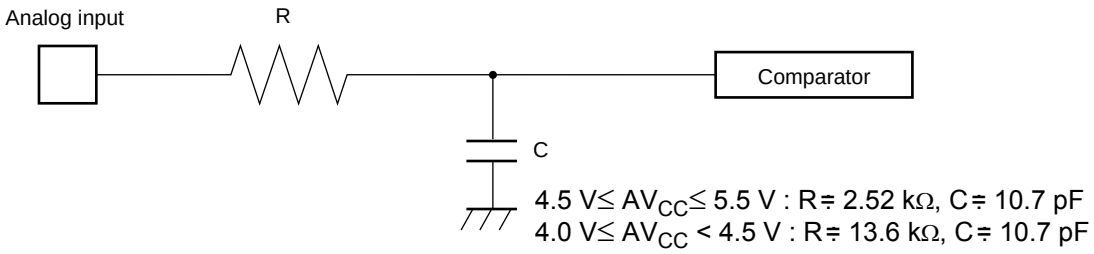
Use the device with external circuits of the following output impedance for analog inputs :

Recommended output impedance of external circuits are : Approx. 1.5 kΩ or lower (4.0 V≤ AV_{CC}≤ 5.5 V, sampling period = 0.5 µs)

If an external capacitor is used, in consideration of the capacitive voltage dividing effect between the external capacitor and the internal on-chip capacitor, it is recommended that the capacitance of the external capacitor be several thousand times greater than the capacitance of the internal capacitor.

If the output impedance of the external circuit is too high, a sampling period for an analog voltage may be insufficient.

- Analog input circuit model



Note: : Use the values in the figure only as a guideline.

11.8 Flash Memory Program/Erase Characteristics

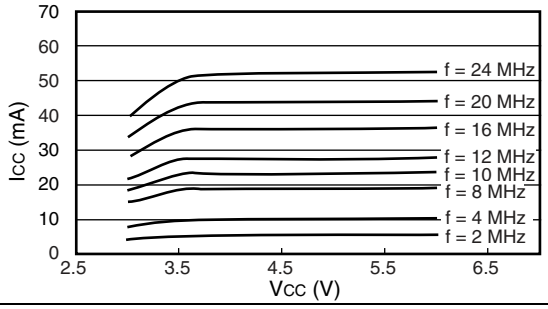
Parameter	Conditions	Value			Unit	Remarks
		Min	Typ	Max		
Sector erase time	$T_A = +25°C$ $V_{CC} = 5.0$ V	—	1	15	s	Excludes programming prior to erasure
Chip erase time		—	9	—	s	Excludes programming prior to erasure
Word (16-bit width) programming time		—	16	3600	µs	Except for the over head time of the system
Program/Erase cycle	—	10000	—	—	cycle	
Flash Data Retention Time	Average $T_A = +85°C$	20	—	—	year	*

* : This value was converted from the results of evaluating the reliability of the technology (using Arrhenius equation to translate high temperature measurements into normalized value at +85°C) .

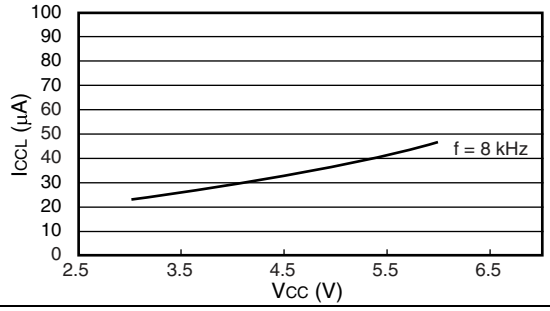
12. Example Characteristics

- MB90F346E, MB90F346ES, MB90F346CE, MB90F346CES

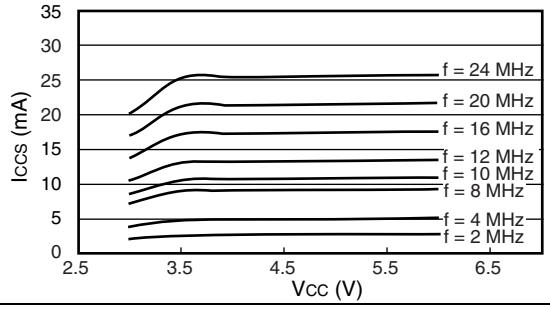
$I_{CC} - V_{CC}$
$T_A = +25°C$, external clock operation, f = Internal operation frequency



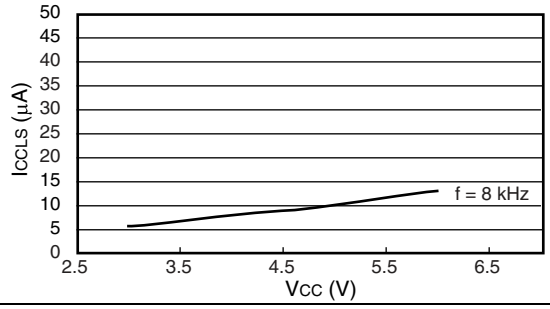
$I_{CCL} - V_{CC}$
$T_A = +25°C$, external clock operation, f = Internal operation frequency



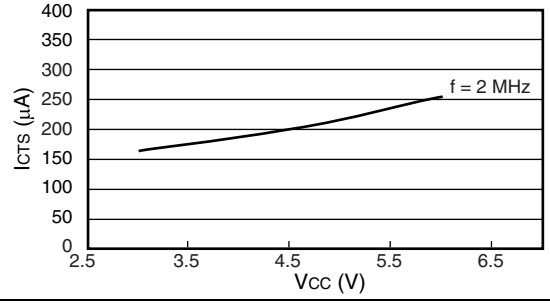
$I_{CCS} - V_{CC}$
$T_A = +25°C$, external clock operation, f = Internal operation frequency



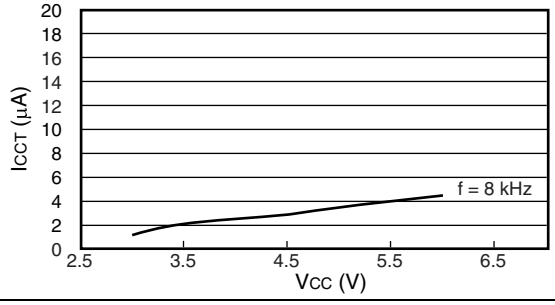
$I_{CCLS} - V_{CC}$
$T_A = +25°C$, external clock operation, f = Internal operation frequency



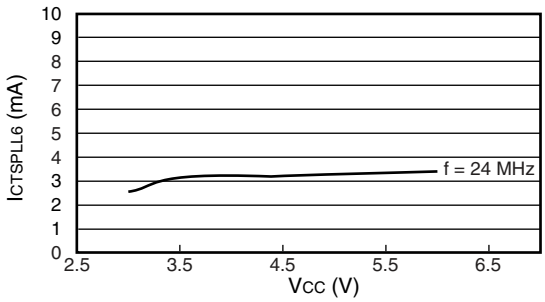
$I_{CTS} - V_{CC}$
$T_A = +25°C$, external clock operation, f = Internal operation frequency



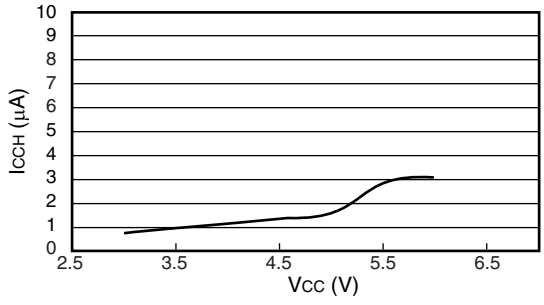
$I_{CCT} - V_{CC}$
$T_A = +25°C$, external clock operation, f = Internal operation frequency



$I_{CTSPLL6} - V_{CC}$
$T_A = +25°C$, external clock operation, f = Internal operation frequency



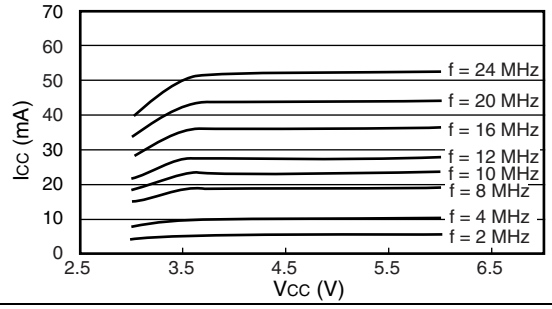
$I_{CCH} - V_{CC}$
$T_A = +25°C$, stopped



■ MB90F347E, MB90F347ES, MB90F347CE, MB90F347CES

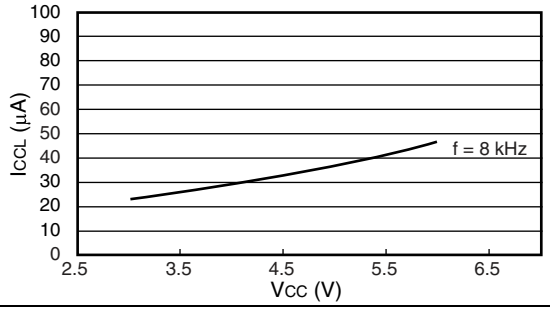
$I_{CC} - V_{CC}$

$T_A = +25°C$, external clock operation f = Internal operation frequency



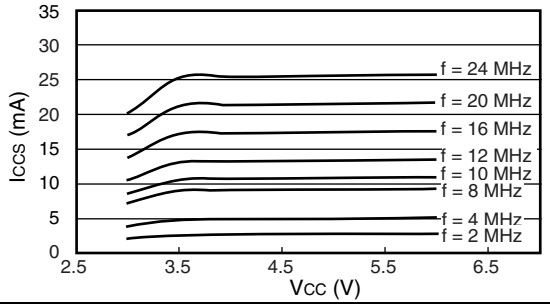
$I_{CCL} - V_{CC}$

$T_A = +25°C$, external clock operation f = Internal operation frequency



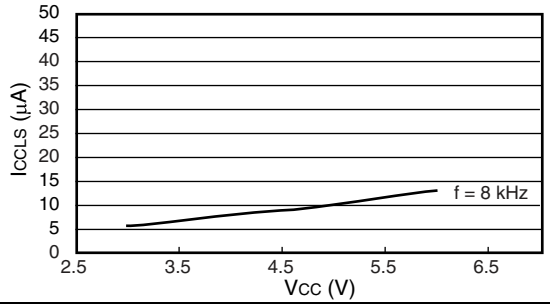
$I_{CCS} - V_{CC}$

$T_A = +25°C$, external clock operation f = Internal operation frequency



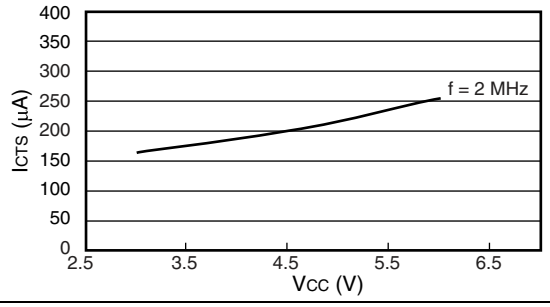
$I_{CCLS} - V_{CC}$

$T_A = +25°C$, external clock operation f = Internal operation frequency



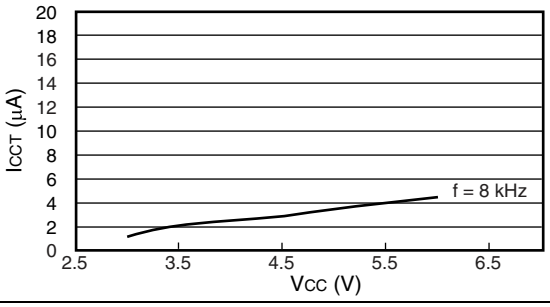
$I_{CTS} - V_{CC}$

$T_A = +25°C$, external clock operation f = Internal operation frequency



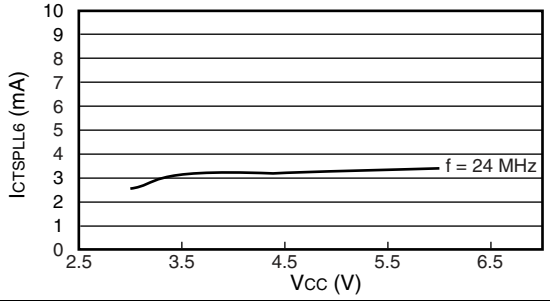
$I_{CCT} - V_{CC}$

$T_A = +25°C$, external clock operation f = Internal operation frequency



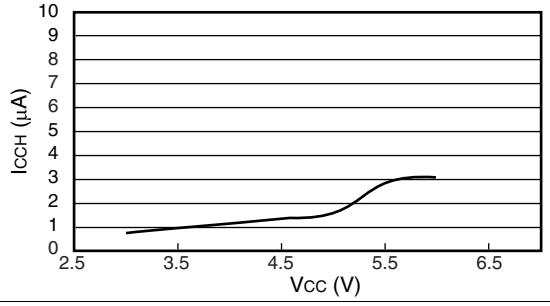
$I_{CTSPLL6} - V_{CC}$

$T_A = +25°C$, external clock operation f = Internal operation frequency



$I_{CCH} - V_{CC}$

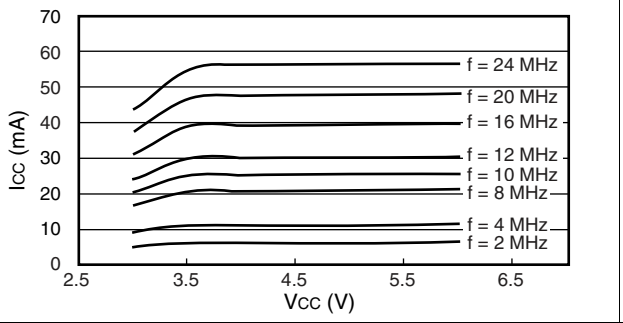
$T_A = +25°C$, stopped



■ MB90F349E, MB90F349ES, MB90F349CE, MB90F349CES

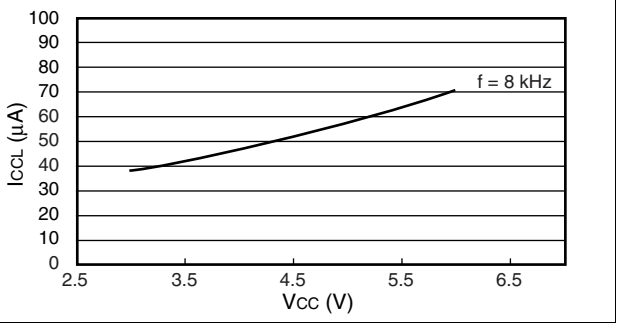
$I_{CC} - V_{CC}$

$T_A = +25°C$, external clock operation f = Internal operation frequency



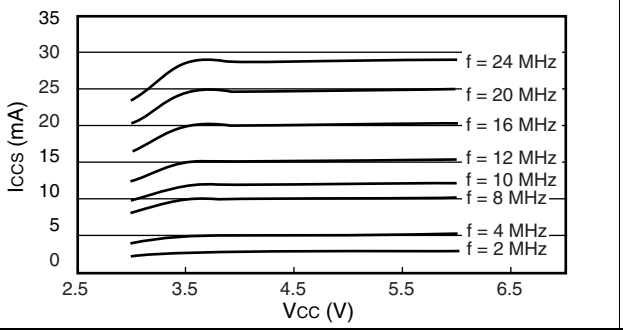
$I_{CCL} - V_{CC}$

$T_A = +25°C$, external clock operation f = Internal operation frequency



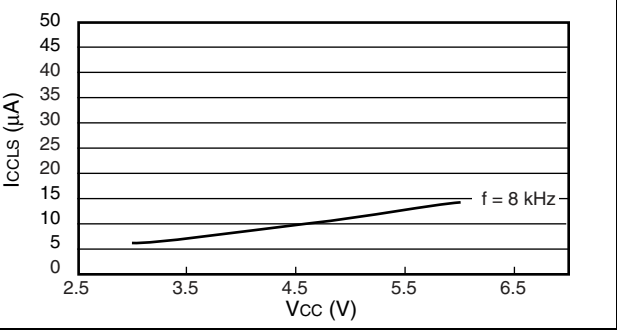
$I_{CCS} - V_{CC}$

$T_A = +25°C$, external clock operation f = Internal operation frequency



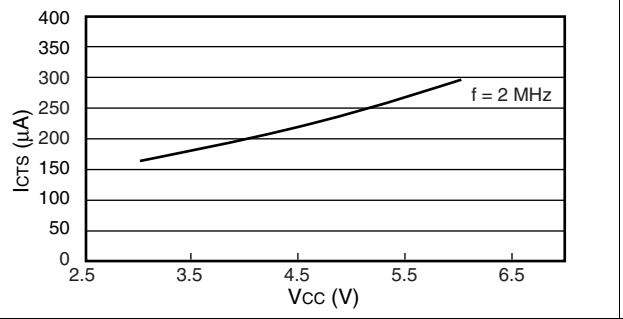
$I_{CCLS} - V_{CC}$

$T_A = +25°C$, external clock operation f = Internal operation frequency



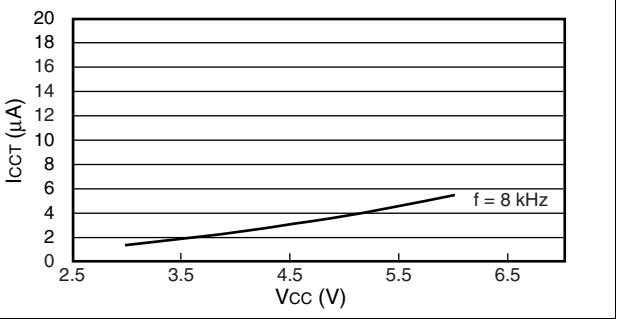
$I_{CTS} - V_{CC}$

$T_A = +25°C$, external clock operation f = Internal operation frequency



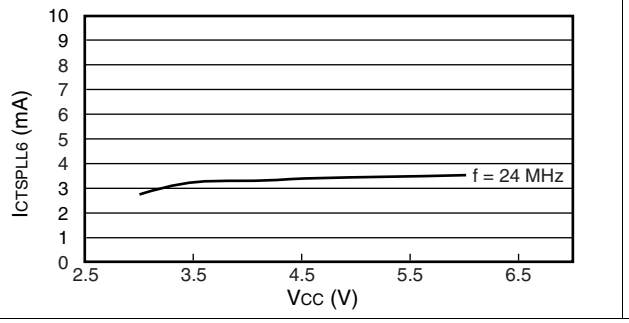
$I_{CCT} - V_{CC}$

$T_A = +25°C$, external clock operation f = Internal operation frequency



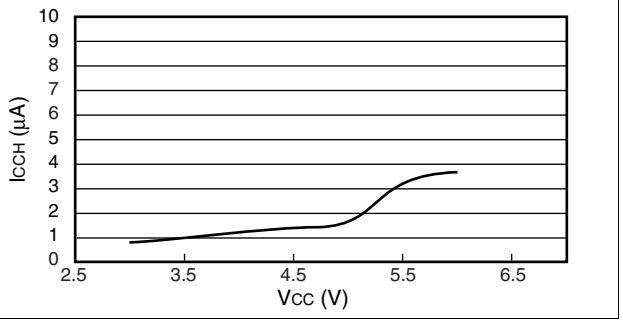
$I_{CTSPLL6} - V_{CC}$

$T_A = +25°C$, external clock operation f = Internal operation frequency



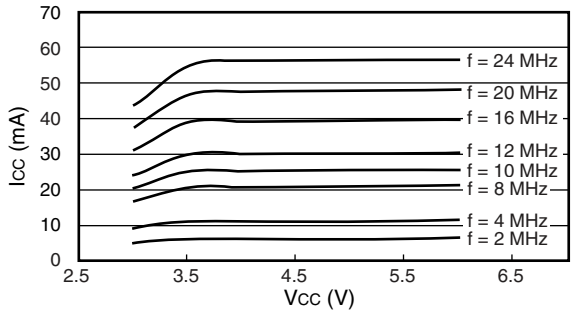
$I_{CCH} - V_{CC}$

$T_A = +25°C$, stopped

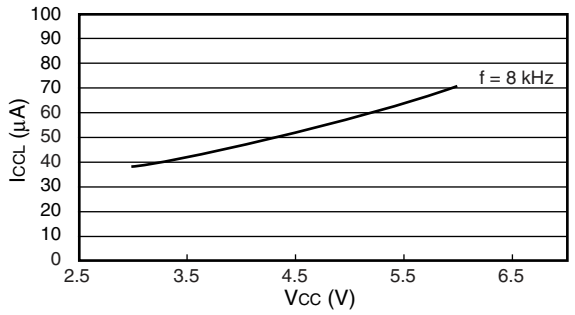


■ MB90F342E, MB90F342ES, MB90F342CE, MB90F342CES

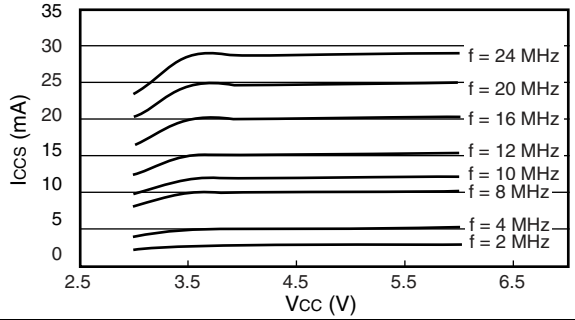
$I_{CC} - V_{CC}$
$T_A = +25°C$, external clock operation f = Internal operation frequency



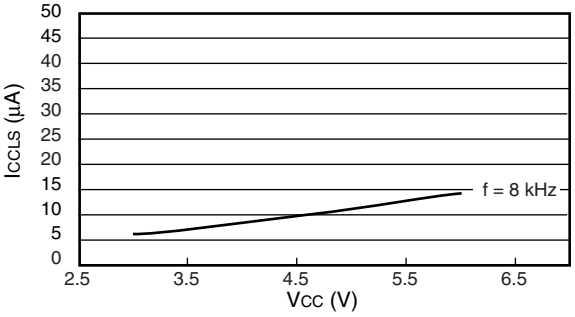
$I_{CCL} - V_{CC}$
$T_A = +25°C$, external clock operation f = Internal operation frequency



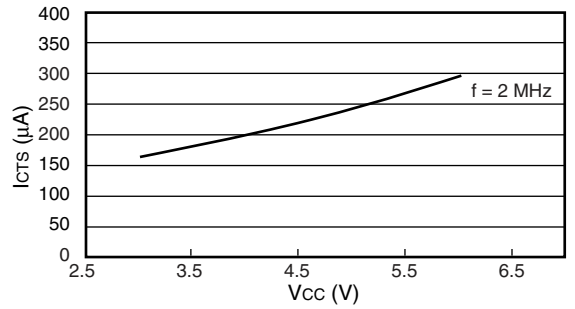
$I_{CCS} - V_{CC}$
$T_A = +25°C$, external clock operation f = Internal operation frequency



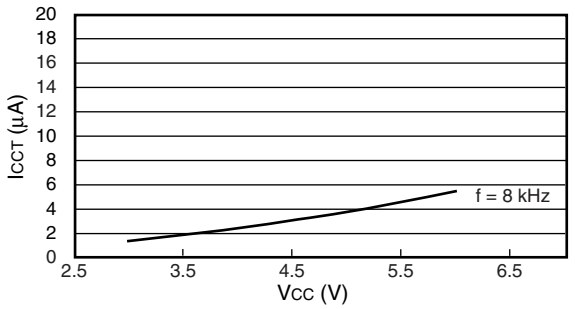
$I_{CCLS} - V_{CC}$
$T_A = +25°C$, external clock operation f = Internal operation frequency



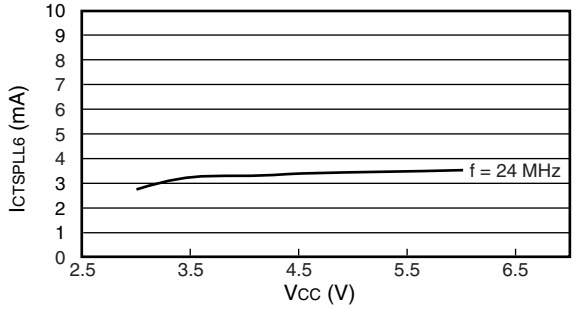
$I_{CTS} - V_{CC}$
$T_A = +25°C$, external clock operation f = Internal operation frequency



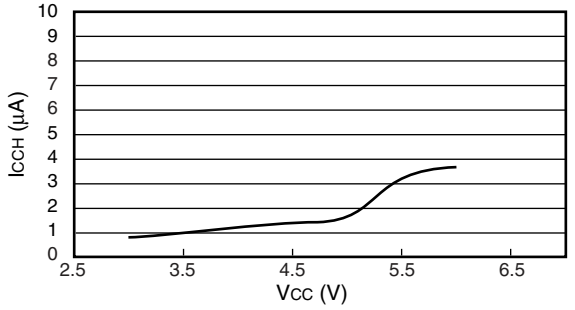
$I_{CCT} - V_{CC}$
$T_A = +25°C$, external clock operation f = Internal operation frequency



$I_{CTSPLL6} - V_{CC}$
$T_A = +25°C$, external clock operation f = Internal operation frequency

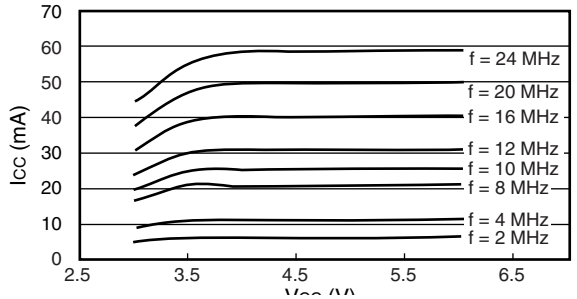


$I_{CCH} - V_{CC}$
$T_A = +25°C$, stopped

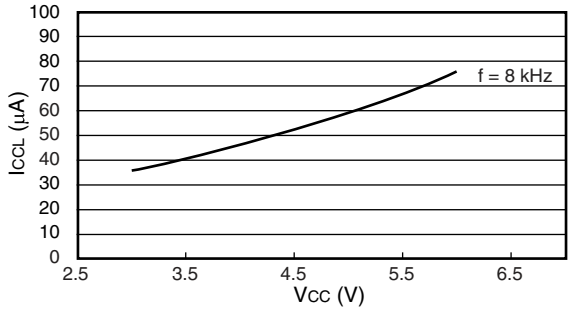


■ MB90F345E, MB90F345ES, MB90F345CE, MB90F345CES

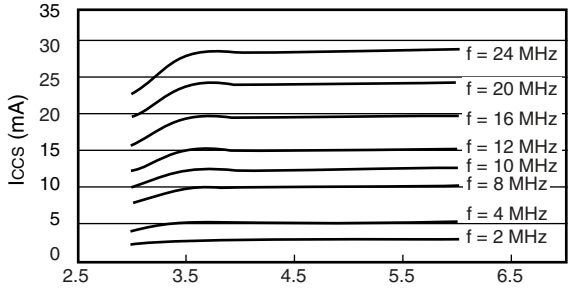
$I_{CC} - V_{CC}$
$T_A = +25°C$, external clock operation f = Internal operation frequency



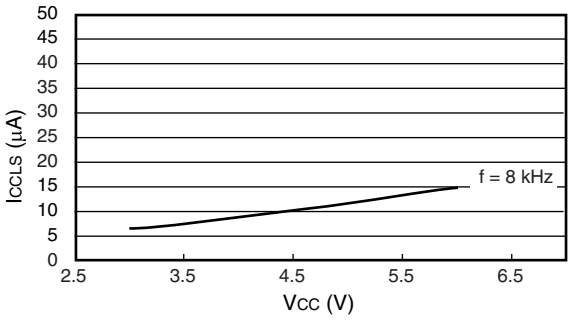
$I_{CCL} - V_{CC}$
$T_A = +25°C$, external clock operation f = Internal operation frequency



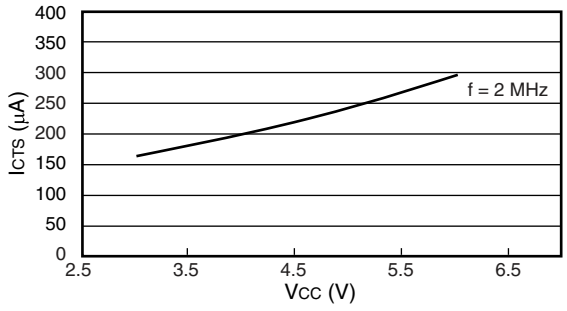
$I_{CCS} - V_{CC}$
$T_A = +25°C$, external clock operation f = Internal operation frequency



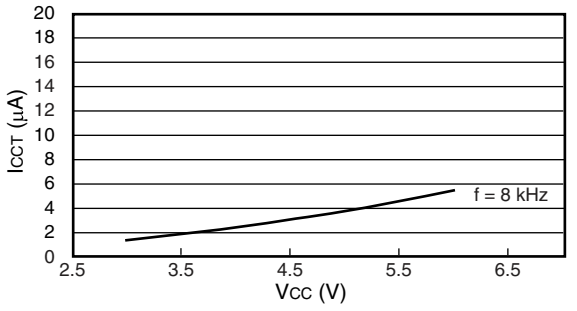
$I_{CCLS} - V_{CC}$
$T_A = +25°C$, external clock operation f = Internal operation frequency



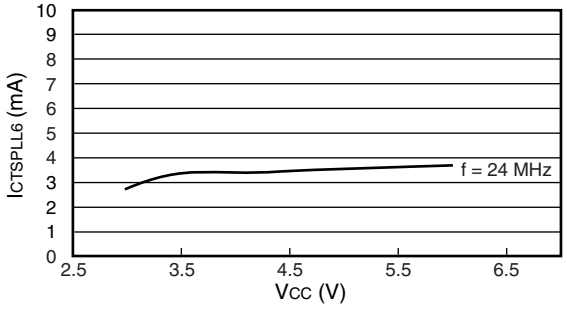
$I_{CTS} - V_{CC}$
$T_A = +25°C$, external clock operation f = Internal operation frequency



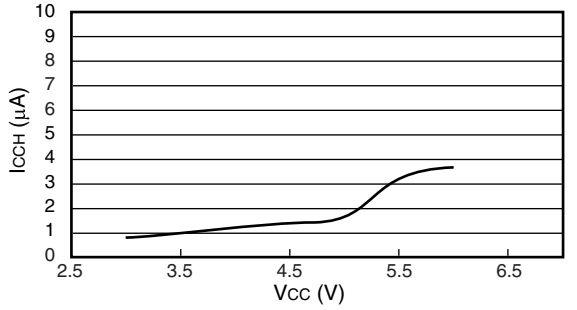
$I_{CCT} - V_{CC}$
$T_A = +25°C$, external clock operation f = Internal operation frequency



$I_{CTSPLL6} - V_{CC}$
$T_A = +25°C$, external clock operation f = Internal operation frequency

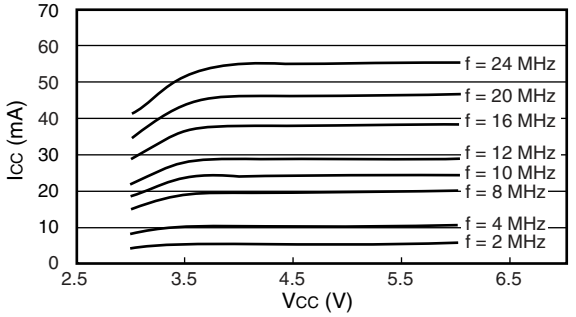


$I_{CCH} - V_{CC}$
$T_A = +25°C$, stopped

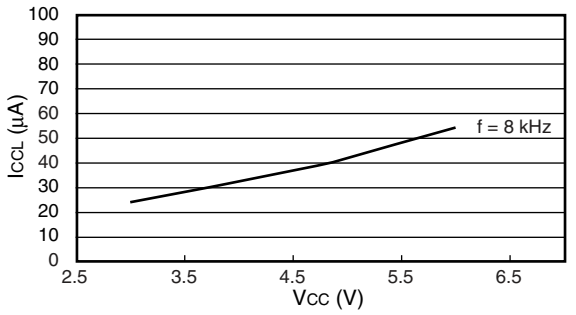


■ MB90346E, MB90346ES, MB90346CE, MB90346CES

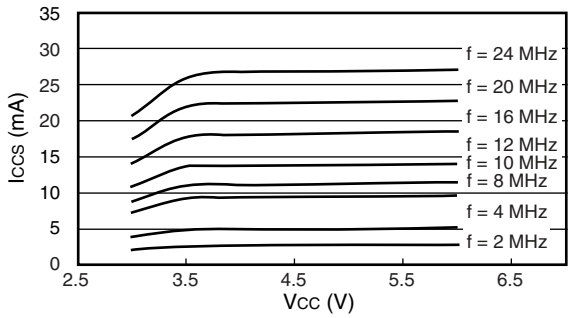
$I_{CC} - V_{CC}$
$T_A = +25°C$, external clock operation f = Internal operation frequency



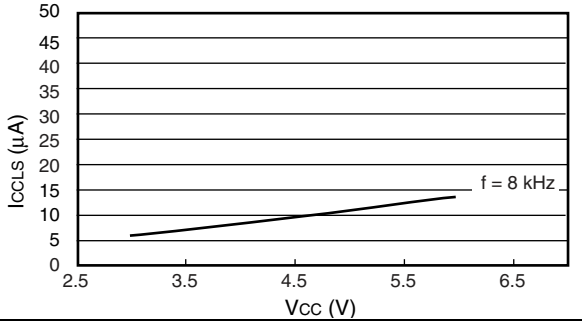
$I_{CCL} - V_{CC}$
$T_A = +25°C$, external clock operation f = Internal operation frequency



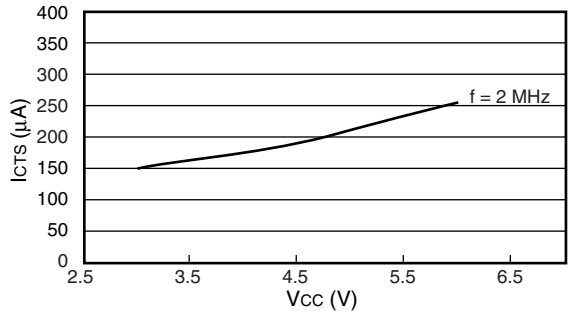
$I_{CCS} - V_{CC}$
$T_A = +25°C$, external clock operation f = Internal operation frequency



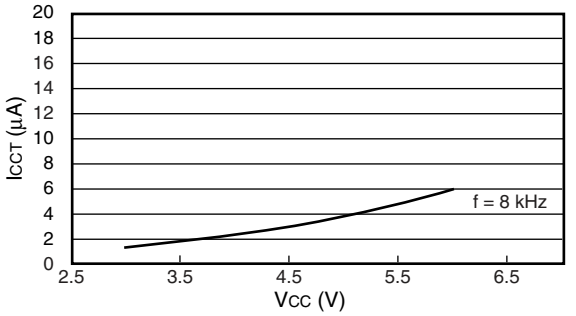
$I_{CCLS} - V_{CC}$
$T_A = +25°C$, external clock operation f = Internal operation frequency



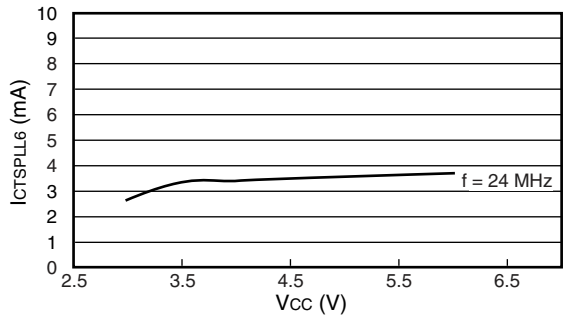
$I_{CTS} - V_{CC}$
$T_A = +25°C$, external clock operation f = Internal operation frequency



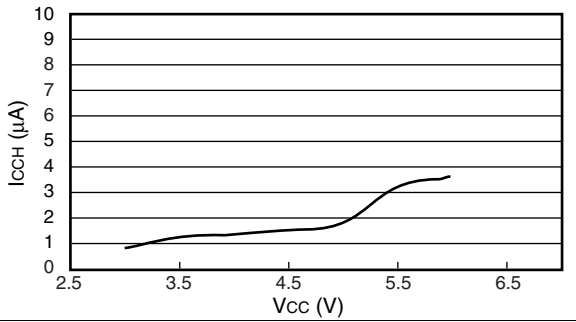
$I_{CCT} - V_{CC}$
$T_A = +25°C$, external clock operation f = Internal operation frequency



$I_{CTSPLL6} - V_{CC}$
$T_A = +25°C$, external clock operation f = Internal operation frequency

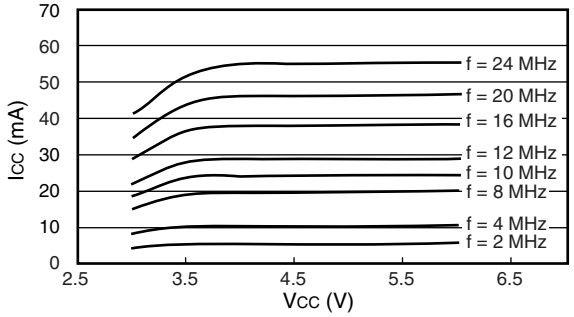


$I_{CCH} - V_{CC}$
$T_A = +25°C$, stopped

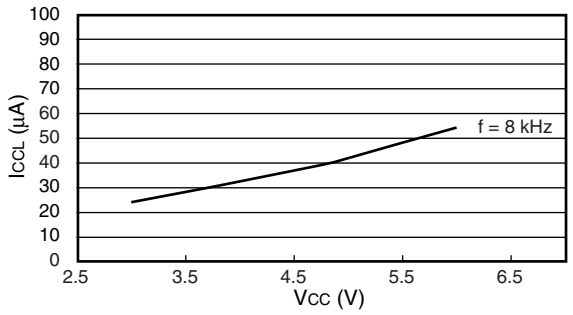


■ MB90347E, MB90347ES, MB90347CE, MB90347CES

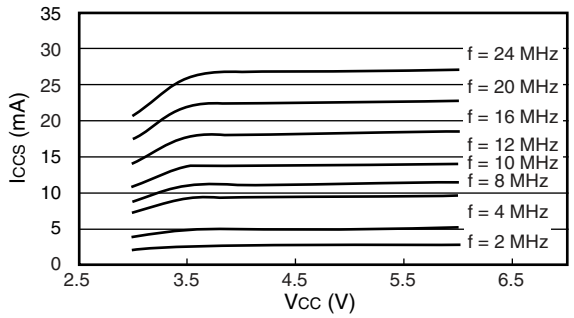
$I_{CC} - V_{CC}$
$T_A = +25°C$, external clock operation f = Internal operation frequency



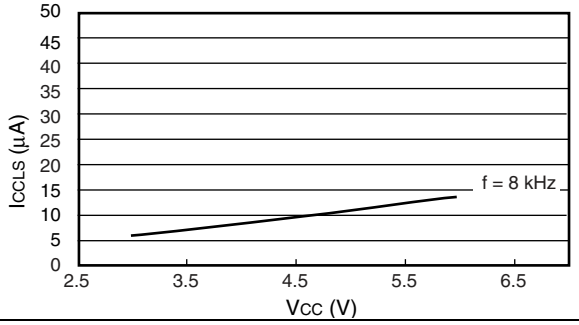
$I_{CCL} - V_{CC}$
$T_A = +25°C$, external clock operation f = Internal operation frequency



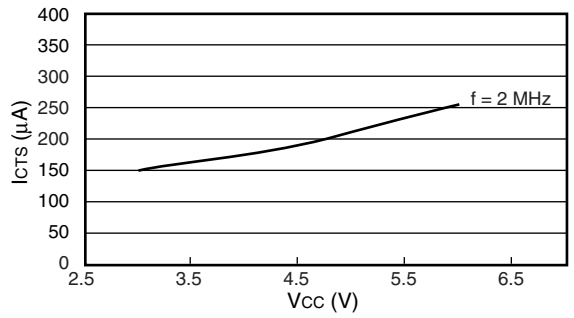
$I_{CCS} - V_{CC}$
$T_A = +25°C$, external clock operation f = Internal operation frequency



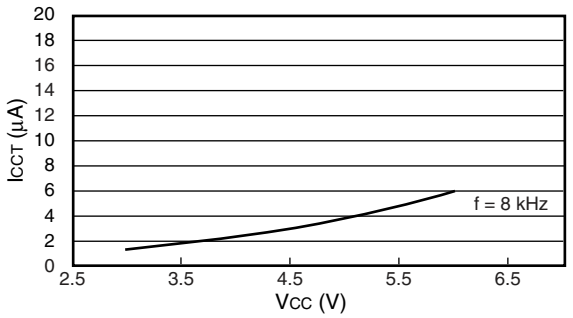
$I_{CCLS} - V_{CC}$
$T_A = +25°C$, external clock operation f = Internal operation frequency



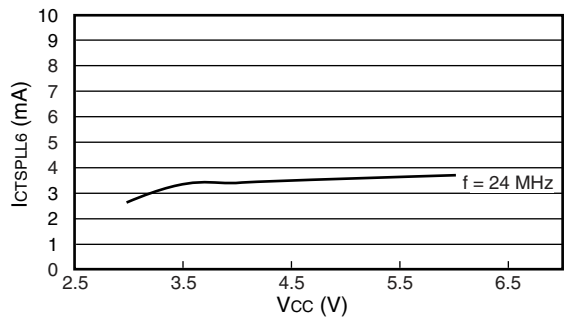
$I_{CTS} - V_{CC}$
$T_A = +25°C$, external clock operation f = Internal operation frequency



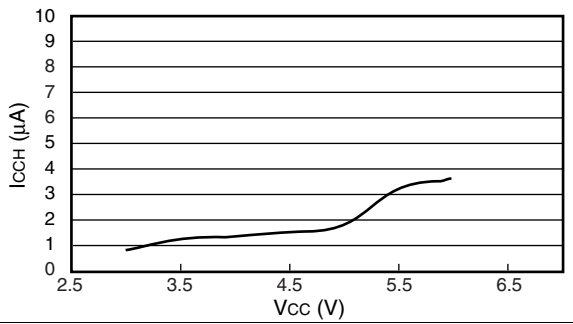
$I_{CCT} - V_{CC}$
$T_A = +25°C$, external clock operation f = Internal operation frequency



$I_{CTSPLL6} - V_{CC}$
$T_A = +25°C$, external clock operation f = Internal operation frequency

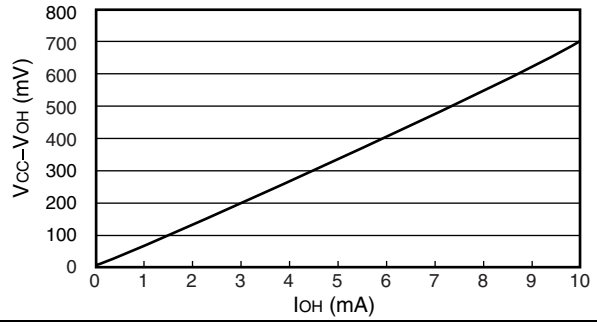


$I_{CCH} - V_{CC}$
$T_A = +25°C$, stopped

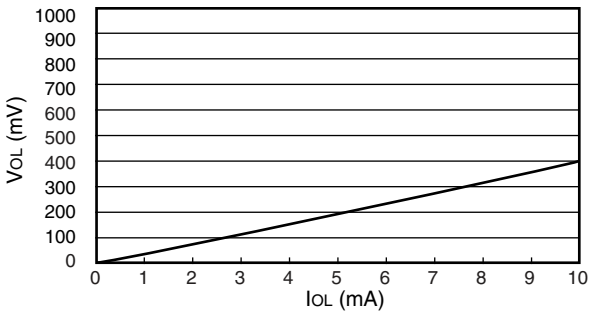


■ I/O characteristics

$(V_{CC}-V_{OH})$ – I_{OH}
T_A = +25°C, V_{CC} = 4.5 V

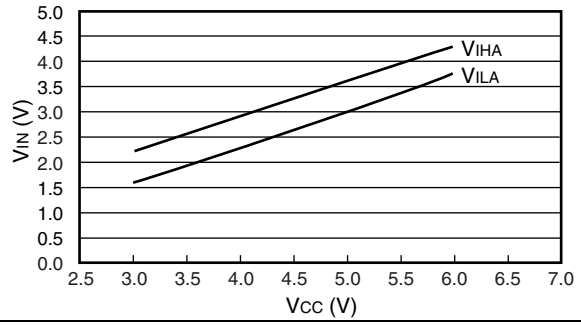


V_{OL} – I_{OL}
T_A = +25°C, V_{CC} = 4.5 V

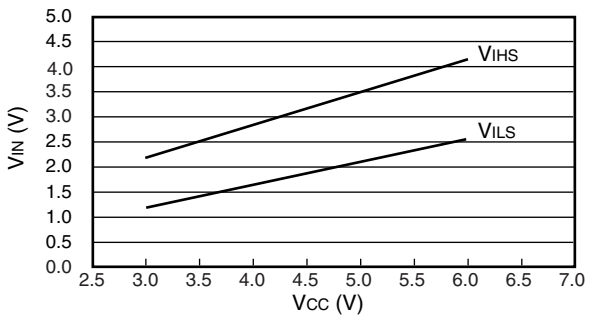


Automotive V_{IN} – V_{CC}

T_A = +25°C

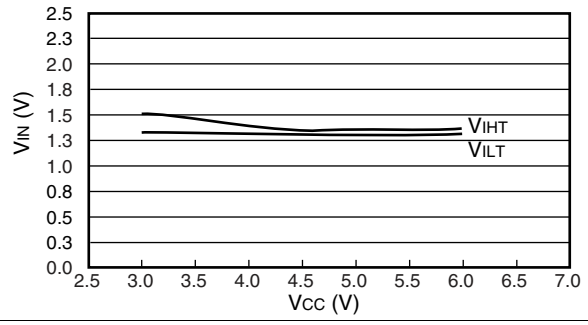


CMOS V_{IN} – V_{CC}
Other than UART-SIN pin and I^2C pin
T_A = +25°C

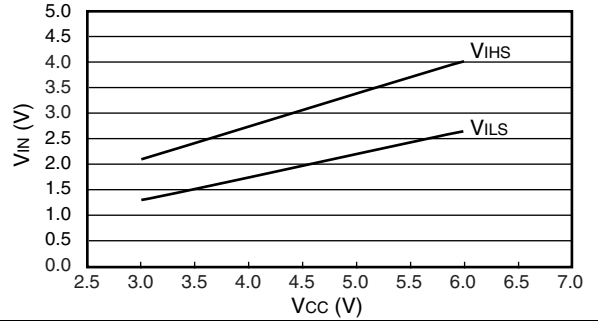


TTL V_{IN} – V_{CC}

T_A = +25°C



CMOS V_{IN} – V_{CC}
UART-SIN pin, I^2C pin
T_A = +25°C



13. Ordering Information

Part number	Package	Remarks
MB90F342EPF	100-pin plastic QFP (FPT-100P-M06)	
MB90F342ESPF		
MB90F342CEPF		
MB90F342CESPF		
MB90F342EPMC	100-pin plastic LQFP (FPT-100P-M20)	
MB90F342ESPMC		
MB90F342CEPMC		
MB90F342CESPMC		
MB90F345EPF	100-pin plastic QFP (FPT-100P-M06)	
MB90F345ESPF		
MB90F345CEPF		
MB90F345CESPF		
MB90F345EPMC	100-pin plastic LQFP (FPT-100P-M20)	
MB90F345ESPMC		
MB90F345CEPMC		
MB90F345CESPMC		
MB90F346EPF	100-pin plastic QFP (FPT-100P-M06)	
MB90F346ESPF		
MB90F346CEPF		
MB90F346CESPF		
MB90F346EPMC	100-pin plastic LQFP (FPT-100P-M20)	
MB90F346ESPMC		
MB90F346CEPMC		
MB90F346CESPMC		

(Continued)

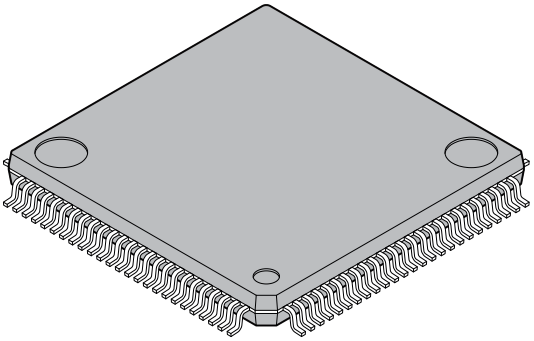
Part number	Package	Remarks
MB90F347EPF	100-pin plastic QFP (FPT-100P-M06)	
MB90F347ESPF		
MB90F347CEPF		
MB90F347CESPF		
MB90F347EPMC	100-pin plastic LQFP (FPT-100P-M20)	
MB90F347ESPMC		
MB90F347CEPMC		
MB90F347CESPMC		
MB90F349EPF	100-pin plastic QFP (FPT-100P-M06)	
MB90F349ESPF		
MB90F349CEPF		
MB90F349CESPF		
MB90F349EPMC	100-pin plastic LQFP (FPT-100P-M20)	
MB90F349ESPMC		
MB90F349CEPMC		
MB90F349CESPMC		
MB90341EPF	100-pin plastic QFP (FPT-100P-M06)	
MB90341ESPF		
MB90341CEPF		
MB90341CESPF		
MB90341EPMC	100-pin plastic LQFP (FPT-100P-M20)	
MB90341ESPMC		
MB90341CEPMC		
MB90341CESPMC		
MB90342EPF	100-pin plastic QFP (FPT-100P-M06)	
MB90342ESPF		
MB90342CEPF		
MB90342CESPF		
MB90342EPMC	100-pin plastic LQFP (FPT-100P-M20)	
MB90342ESPMC		
MB90342CEPMC		
MB90342CESPMC		

(Continued)

(Continued)

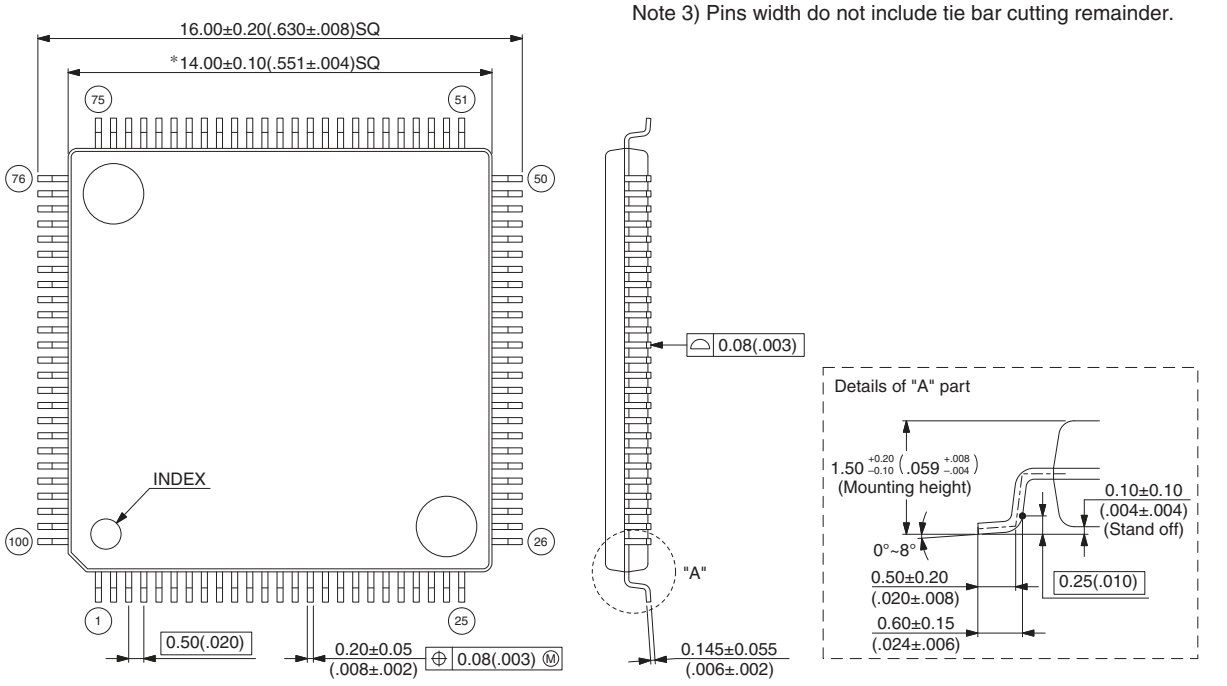
Part number	Package	Remarks
MB90346EPF	100-pin plastic QFP (FPT-100P-M06)	
MB90346ESPF		
MB90346CEPF		
MB90346CESPF		
MB90346EPMC	100-pin plastic LQFP (FPT-100P-M20)	
MB90346ESPMC		
MB90346CEPMC		
MB90346CESPMC		
MB90347EPF	100-pin plastic QFP (FPT-100P-M06)	
MB90347ESPF		
MB90347CEPF		
MB90347CESPF		
MB90347EPMC	100-pin plastic LQFP (FPT-100P-M20)	
MB90347ESPMC		
MB90347CEPMC		
MB90347CESPMC		
MB90348EPF	100-pin plastic QFP (FPT-100P-M06)	
MB90348ESPF		
MB90348CEPF		
MB90348CESPF		
MB90348EPMC	100-pin plastic LQFP (FPT-100P-M20)	
MB90348ESPMC		
MB90348CEPMC		
MB90348CESPMC		
MB90349EPF	100-pin plastic QFP (FPT-100P-M06)	
MB90349ESPF		
MB90349CEPF		
MB90349CESPF		
MB90349EPMC	100-pin plastic LQFP (FPT-100P-M20)	
MB90349ESPMC		
MB90349CEPMC		
MB90349CESPMC		
MB90V340E-101CR	299-pin ceramic PGA (PGA-299C-A01)	For evaluation
MB90V340E-102CR		

14. Package Dimensions

100-pin plastic LQFP		
	Lead pitch	0.50 mm
	Package width × package length	14.0 mm × 14.0 mm
	Lead shape	Gullwing
	Sealing method	Plastic mold
	Mounting height	1.70 mm Max
	Weight	0.65 g
(FPT-100P-M20)	Code (Reference)	P-LFQFP100-14×14-0.50

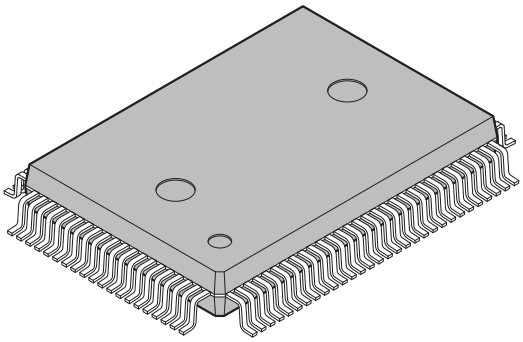
100-pin plastic LQFP
(FPT-100P-M20)

Note 1) * : These dimensions do not include resin protrusion.
Note 2) Pins width and pins thickness include plating thickness.
Note 3) Pins width do not include tie bar cutting remainder.



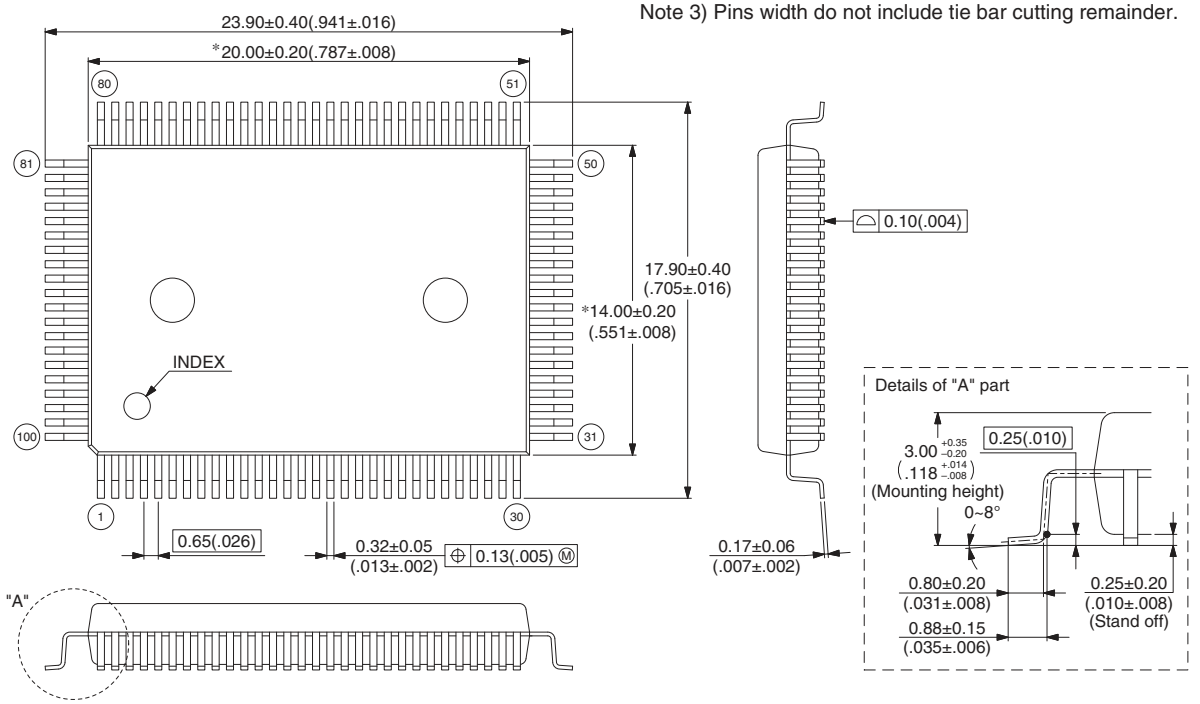
Dimensions in mm (inches).
Note: The values in parentheses are reference values

(Continued)

100-pin plastic QFP		
	Lead pitch	0.65 mm
	Package width × package length	14.00 × 20.00 mm
	Lead shape	Gullwing
	Sealing method	Plastic mold
	Mounting height	3.35 mm MAX
	Code (Reference)	P-QFP100-14×20-0.65
(FPT-100P-M06)		

100-pin plastic QFP
(FPT-100P-M06)

Note 1) * : These dimensions do not include resin protrusion.
Note 2) Pins width and pins thickness include plating thickness.
Note 3) Pins width do not include tie bar cutting remainder.



Dimensions in mm (inches).
Note: The values in parentheses are reference values.

15. Major Changes

Spansiion Publication Number: DS07-13747-4E

Page	Section	Change Results
___	___	Deleted the part numbers; MB90F343E(S), MB90F343CE(S)
51	Electrical Characteristics Absolute Maximum Ratings	Added “*6” in remark for “L" level maximum output current and “H” level maximum output current. Added “*7” in remark for “L" level average output current and “H” level average output current. Added “*8” in remark for “L"level average overall output current and “H” level average overall output current.
52		Added as follows. “*6:The maximum output current is defined as the peak value of the current of any one of the corresponding pins.” “*7:The average output current is defined as the value of the average current flowing over 100 ms at any one of the corresponding pins.” “*8:The average total output current is defined as the value of the average current flowing over 100 ms at all of the corresponding pins.”

NOTE: Please see “Document History” about later revised information.

Document History

Document Title: MB90340E Series F2MC-16LX 16-bit Microcontroller Datasheet Document Number: 002-04498				
Revision	**ECN**	**Orig. of Change**	**Submission Date**	**Description of Change**
**	—	AKIH	08/23/2010	Migrated to Cypress and assigned document number 002-04498. No change to document contents or format.
*A	5221535	AKIH	05/04/2016	Updated to Cypress template

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